



## MSP430G2x33, MSP430G2x03 Mixed-Signal Microcontrollers

### 1 Device Overview

#### 1.1 Features

- Low Supply-Voltage Range: 1.8 V to 3.6 V
- Ultra-Low Power Consumption
  - Active Mode: 230  $\mu$ A at 1 MHz, 2.2 V
  - Standby Mode: 0.5  $\mu$ A
  - Off Mode (RAM Retention): 0.1  $\mu$ A
- Five Power-Saving Modes
- Ultra-Fast Wake up From Standby Mode in Less Than 1  $\mu$ s
- 16-Bit RISC Architecture, 62.5-ns Instruction Cycle Time
- Basic Clock Module Configurations
  - Internal Frequencies up to 16 MHz With Four Calibrated Frequencies
  - Internal Very-Low-Power Low-Frequency (LF) Oscillator
  - 32-kHz Crystal
  - External Digital Clock Source
- Two 16-Bit Timer\_A With Three Capture/Compare Registers
- Up to 24 Capacitive-Touch Enabled I/O Pins
- Universal Serial Communication Interface (USCI)
  - Enhanced UART Supports Automatic Baud-Rate Detection (LIN)
  - IrDA Encoder and Decoder
  - Synchronous SPI
  - I<sup>2</sup>C
- 10-Bit 200-ksps Analog-to-Digital Converter (ADC) With Internal Reference, Sample-and-Hold, and Autoscan (See [Table 3-1](#))
- Brownout Detector
- Serial Onboard Programming, No External Programming Voltage Needed, Programmable Code Protection by Security Fuse
- On-Chip Emulation Logic With Spy-Bi-Wire Interface
- [Section 3](#) Summarizes Available Family Members
- Package Options
  - TSSOP: 20 Pin, 28 Pin
  - PDIP: 20 Pin
  - QFN: 32 Pin
- For Complete Module Descriptions, See the *MSP430x2xx Family User's Guide* ([SLAU144](#))

#### 1.2 Applications

- Power Management
- Sensor Interface
- Capacitive Touch

#### 1.3 Description

The TI MSP family of ultra-low-power microcontrollers consists of several devices that feature different sets of peripherals targeted for various applications. The architecture, combined with five low-power modes, is optimized to achieve extended battery life in portable measurement applications. The device features a powerful 16-bit RISC CPU, 16-bit registers, and constant generators that contribute to maximum code efficiency. The digitally controlled oscillator (DCO) allows the device to wake up from low-power modes to active mode in less than 1  $\mu$ s.

The MSP430G2x03 and MSP430G2x33 devices are ultra-low-power mixed-signal microcontrollers with built-in 16-bit timers, up to 24 I/O capacitive-touch enabled pins, and built-in communication capability using the USCI. In addition, the MSP430G2x33 family members have a 10-bit ADC. See [Section 3](#) for configuration details.

Typical applications include low-cost sensor systems that capture analog signals, convert them to digital values, and then process the data for display or for transmission to a host system.



### Device Information<sup>(1)</sup>

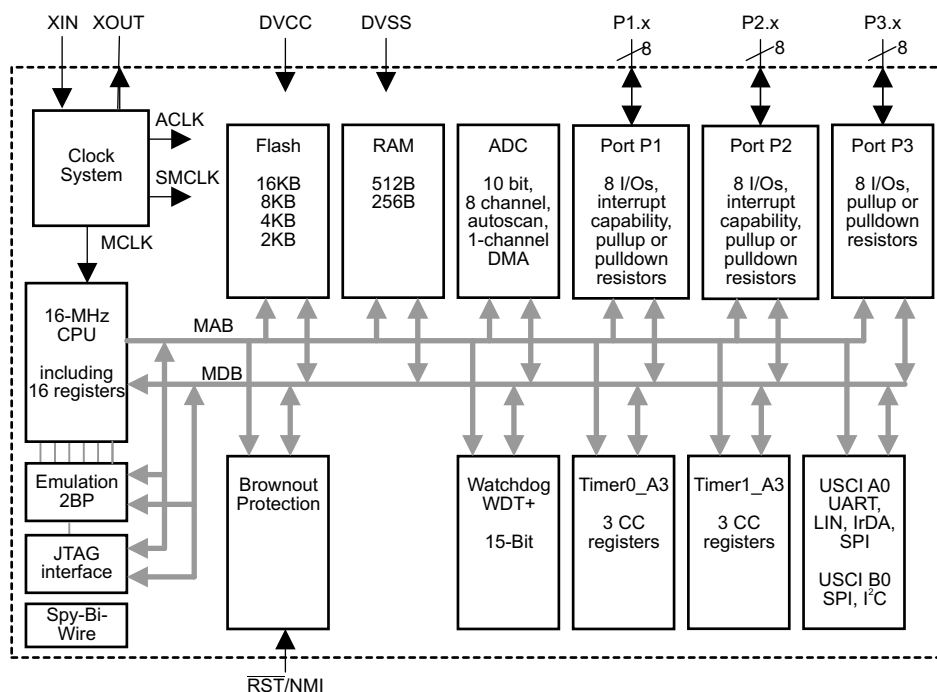
| PART NUMBER     | PACKAGE    | BODY SIZE <sup>(2)</sup> |
|-----------------|------------|--------------------------|
| MSP430G2533IRHB | VQFN (32)  | 5 mm × 5 mm              |
| MSP430G2533IPW  | TSSOP (28) | 9.7 mm × 4.4 mm          |
|                 | TSSOP (20) | 6.5 mm × 4.4 mm          |
| MSP430G2533IN   | PDIP (20)  | 24.33 mm × 6.35 mm       |

(1) For the most current part, package, and ordering information, see the *Package Option Addendum* in [Section 8](#), or see the TI website at [www.ti.com](http://www.ti.com).

(2) The sizes shown here are approximations. For the package dimensions with tolerances, see the *Mechanical Data* in [Section 8](#).

## 1.4 Functional Block Diagrams

Figure 1-1 shows the functional block diagram of the MSP430G2x33 MCUs.

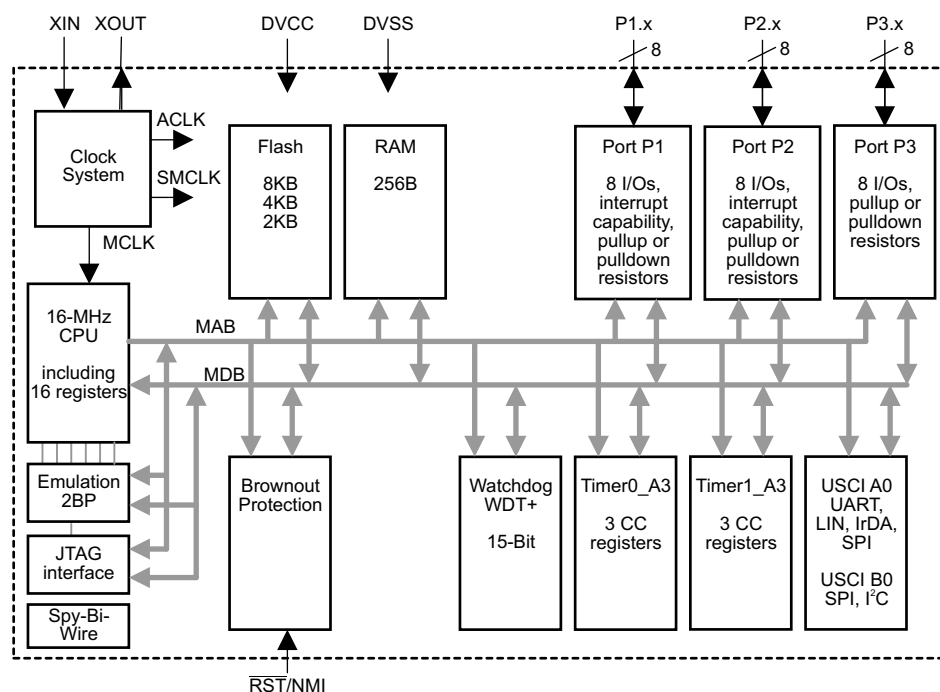


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NOTE: Port P3 is available on 28-pin and 32-pin devices only.

**Figure 1-1. Functional Block Diagram, MSP430G2x33**

Figure 1-2 shows the functional block diagram of the MSP430G2x03 MCUs.



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NOTE: Port P3 is available on 28-pin and 32-pin devices only.

**Figure 1-2. Functional Block Diagram, MSP430G2x03**

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## 2 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from May 2, 2013 to April 27, 2016                                                                                                          | Page               |
|-----------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|
| • Document format and organization changes throughout, including addition of section numbering.....                                                 | <a href="#">1</a>  |
| • Added <i>Device Information</i> table .....                                                                                                       | <a href="#">2</a>  |
| • Added <a href="#">Section 3.1</a> , <i>Related Products</i> .....                                                                                 | <a href="#">7</a>  |
| • Moved <a href="#">Section 5</a> , <i>Specifications</i> .....                                                                                     | <a href="#">13</a> |
| • Added <a href="#">Section 5.2</a> , <i>ESD Ratings</i> .....                                                                                      | <a href="#">13</a> |
| • Added <a href="#">Section 5.8</a> , <i>Thermal Resistance Characteristics</i> .....                                                               | <a href="#">18</a> |
| • Throughout document, changed all instances of "bootstrap loader" to "bootloader".....                                                             | <a href="#">39</a> |
| • Changed all instances of "INCHx = 0x1010" to "INCHx = 1010b" in <a href="#">Table 6-11</a> , <i>Labels Used by the ADC Calibration Tags</i> ..... | <a href="#">43</a> |
| • Moved and renamed <a href="#">Section 6.10</a> , <i>I/O Port Diagrams</i> .....                                                                   | <a href="#">48</a> |
| • Added notes to UCB0STE and UCA0CLK in <a href="#">Table 6-18</a> .....                                                                            | <a href="#">53</a> |
| • Added notes to UCB0CLK and UCA0STE in <a href="#">Table 6-19</a> .....                                                                            | <a href="#">55</a> |
| • Added "and PW28" to title of <a href="#">Section 6.10.8</a> .....                                                                                 | <a href="#">62</a> |
| • Added "and PW28" to title of <a href="#">Table 6-23</a> .....                                                                                     | <a href="#">63</a> |
| • Added <a href="#">Section 7</a> , <i>Device and Documentation Support</i> .....                                                                   | <a href="#">64</a> |
| • Added <a href="#">Section 8</a> , <i>Mechanical, Packaging, and Orderable Information</i> .....                                                   | <a href="#">72</a> |

### 3 Device Comparison

Table 3-1 compares the available family members.

**Table 3-1. Device Comparison<sup>(1)(2)</sup>**

| DEVICE      | BSL | EEM | FLASH<br>(KB) | RAM<br>(B) | Timer_A | ADC10<br>CHANNELS | USCI_A0,<br>USCI_B0 | CLOCK           | I/O | PACKAGE  |
|-------------|-----|-----|---------------|------------|---------|-------------------|---------------------|-----------------|-----|----------|
| MSP430G2533 | 1   | 1   | 16            | 512        | 2x TA3  | 8                 | 1                   | LF, DCO,<br>VLO | 24  | 32-QFN   |
|             |     |     |               |            |         |                   |                     |                 | 24  | 28-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-PDIP  |
| MSP430G2433 | 1   | 1   | 8             | 512        | 2x TA3  | 8                 | 1                   | LF, DCO,<br>VLO | 24  | 32-QFN   |
|             |     |     |               |            |         |                   |                     |                 | 24  | 28-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-PDIP  |
| MSP430G2333 | 1   | 1   | 4             | 256        | 2x TA3  | 8                 | 1                   | LF, DCO,<br>VLO | 24  | 32-QFN   |
|             |     |     |               |            |         |                   |                     |                 | 24  | 28-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-PDIP  |
| MSP430G2233 | 1   | 1   | 2             | 256        | 2x TA3  | 8                 | 1                   | LF, DCO,<br>VLO | 24  | 32-QFN   |
|             |     |     |               |            |         |                   |                     |                 | 24  | 28-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-PDIP  |
| MSP430G2403 | 1   | 1   | 8             | 512        | 2x TA3  | –                 | 1                   | LF, DCO,<br>VLO | 24  | 32-QFN   |
|             |     |     |               |            |         |                   |                     |                 | 24  | 28-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-PDIP  |
| MSP430G2303 | 1   | 1   | 4             | 256        | 2x TA3  | –                 | 1                   | LF, DCO,<br>VLO | 24  | 32-QFN   |
|             |     |     |               |            |         |                   |                     |                 | 24  | 28-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-PDIP  |
| MSP430G2203 | 1   | 1   | 2             | 256        | 2x TA3  | –                 | 1                   | LF, DCO,<br>VLO | 24  | 32-QFN   |
|             |     |     |               |            |         |                   |                     |                 | 24  | 28-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-TSSOP |
|             |     |     |               |            |         |                   |                     |                 | 16  | 20-PDIP  |

(1) For the most current device, package, and ordering information, see the *Package Option Addendum* in [Section 8](#), or see the TI website at [www.ti.com](http://www.ti.com).

(2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).

### 3.1 Related Products

For information about other devices in this family of products or related products, see the following links.

**Products for MSP 16-Bit and 32-Bit MCUs** Low-power mixed-signal processors with smart analog and digital peripherals for a wide range of industrial and consumer applications.

**Products for Ultra-low Power MCUs** MSP Ultra-Low-Power microcontrollers (MCUs) from Texas Instruments (TI) offer the lowest power consumption and the perfect mix of integrated peripherals for a wide range of low-power and portable applications.

**Products for MSP430G2x/i2x Low-Cost Industrial MCUs** MSP430G2x microcontrollers (MCUs) from the MSP ultra-low-power MCU series, offers the low power and performance of 16-bit MSP microcontrollers with a feature set targeted at cost sensitive applications.

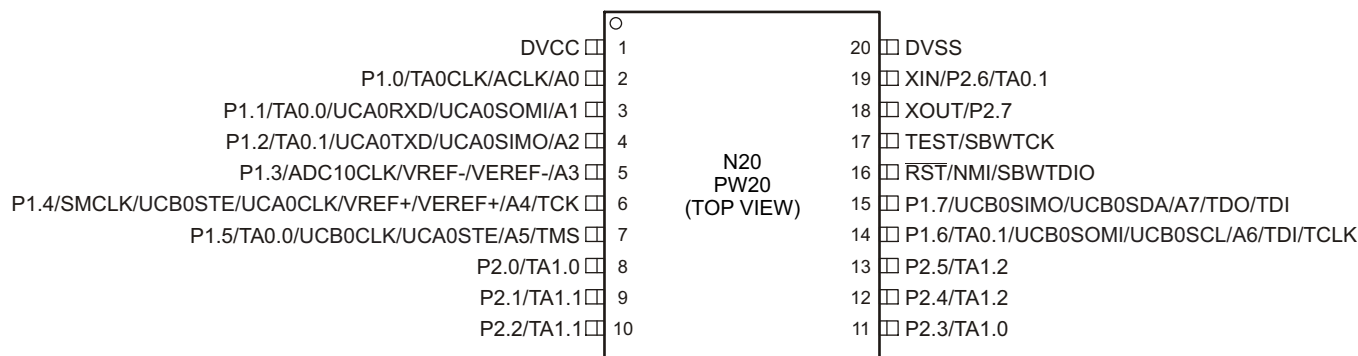
**Companion Products for MSP430G2533** Review products that are frequently purchased or used in conjunction with this product.

**Reference Designs for MSP430G2533** TI Designs Reference Design Library is a robust reference design library that spans analog, embedded processor, and connectivity. Created by TI experts to help you jump start your system design, all TI Designs include schematic or block diagrams, BOMs, and design files to speed your time to market. Search and download designs at [ti.com/tidesigns](http://ti.com/tidesigns).

## 4 Terminal Configuration and Functions

### 4.1 Pin Diagrams

Figure 4-1 shows the pinout for the MSP430G2x03 and MSP430G2x33 devices in the 20-pin N or PW package.

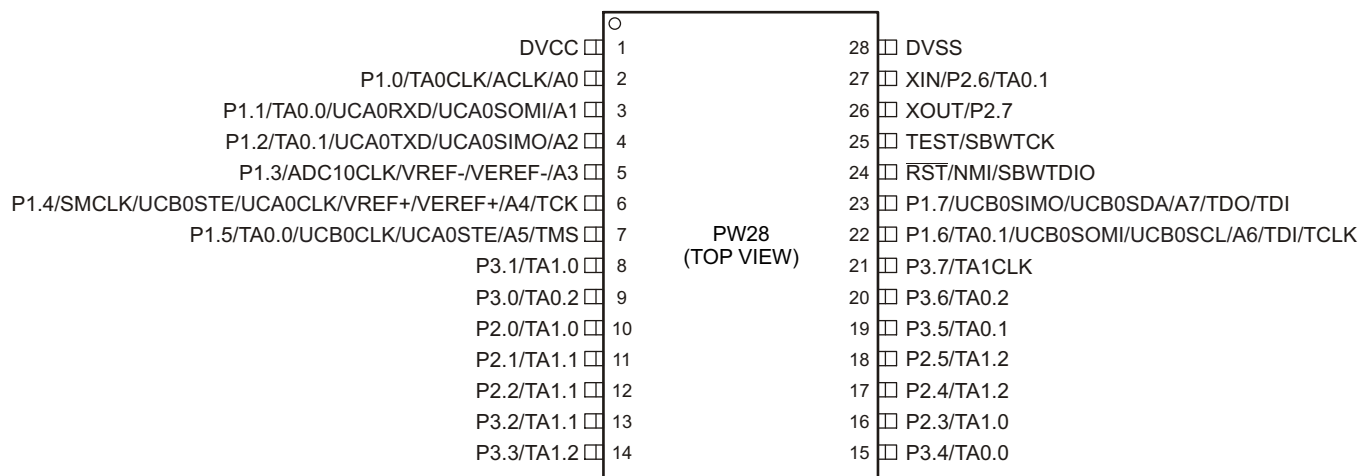


NOTE: ADC10 is available on MSP430G2x33 devices only.

NOTE: The pulldown resistors of port P3 should be enabled by setting P3REN.x = 1.

**Figure 4-1. 20-Pin N or PW Package (Top View), MSP430G2x03 and MSP430G2x33**

Figure 4-2 shows the pinout for the MSP430G2x03 and MSP430G2x33 devices in the 28-pin PW package.

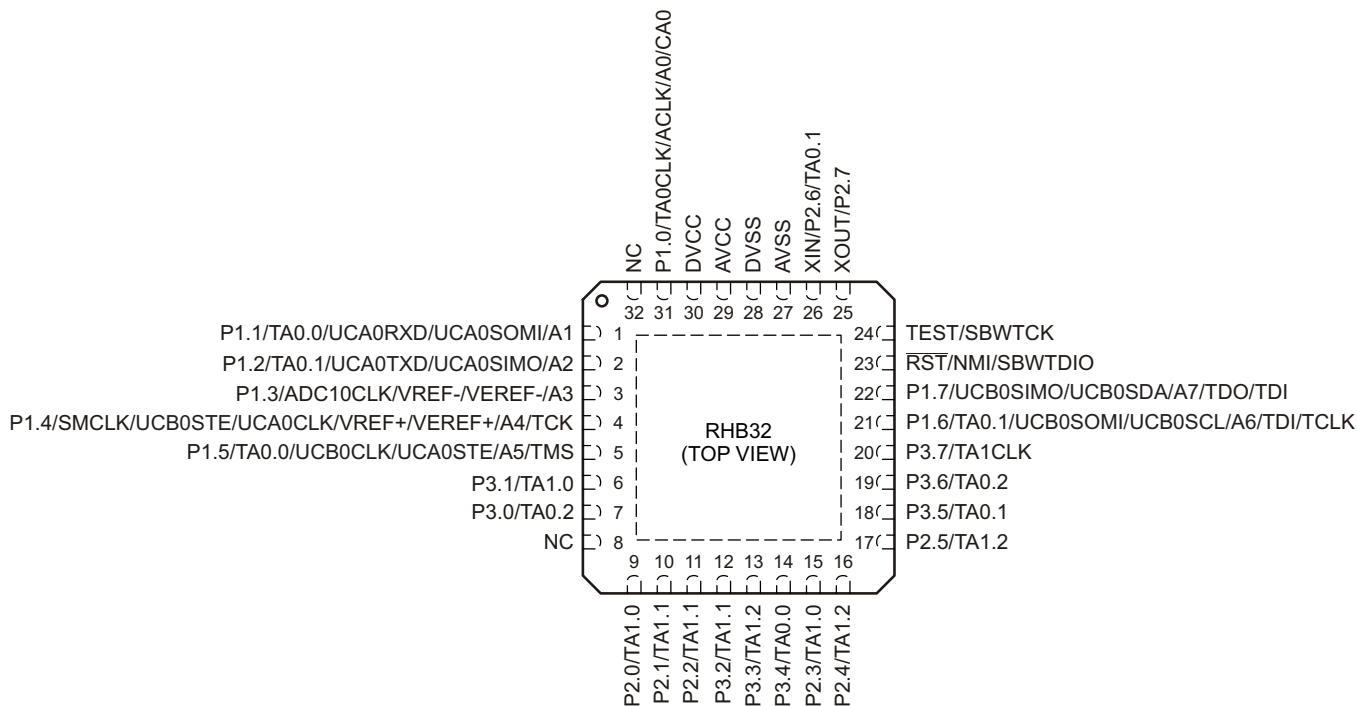


NOTE: ADC10 is available on MSP430G2x33 devices only.

**Figure 4-2. 28-Pin PW Package (Top View), MSP430G2x03 and MSP430G2x33**



Figure 4-3 shows the pinout for the MSP430G2x03 and MSP430G2x33 devices in the 32-pin RHB package.



NOTE: ADC10 is available on MSP430G2x33 devices only.

**Figure 4-3. 32-Pin RHB Package (Top View), MSP430G2x03 and MSP430G2x33**

## 4.2 Signal Descriptions

Table 4-1 describes the signals.

**Table 4-1. Terminal Functions**

| NAME                                                                  | TERMINAL NO. |      |       | I/O | DESCRIPTION                                                                                                                                                                                                                                                                               |
|-----------------------------------------------------------------------|--------------|------|-------|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                                       | PW20,<br>N20 | PW28 | RHB32 |     |                                                                                                                                                                                                                                                                                           |
| P1.0/<br>TA0CLK/<br>ACLK/<br>A0                                       | 2            | 2    | 31    | I/O | General-purpose digital I/O pin<br>Timer0_A, clock signal TACLK input<br>ACLK signal output<br>ADC10 analog input A0 <sup>(1)</sup>                                                                                                                                                       |
| P1.1/<br>TA0.0/<br>UCA0RXD/<br>UCA0SOMI/<br>A1                        | 3            | 3    | 1     | I/O | General-purpose digital I/O pin<br>Timer0_A, capture: CCI0A input, compare: Out0 output / BSL transmit<br>USCI_A0 receive data input in UART mode<br>USCI_A0 slave data out/master in SPI mode<br>ADC10 analog input A1 <sup>(1)</sup>                                                    |
| P1.2/<br>TA0.1/<br>UCA0TXD/<br>UCA0SIMO/<br>A2                        | 4            | 4    | 2     | I/O | General-purpose digital I/O pin<br>Timer0_A, capture: CCI1A input, compare: Out1 output<br>USCI_A0 transmit data output in UART mode<br>USCI_A0 slave data in/master out in SPI mode<br>ADC10 analog input A2 <sup>(1)</sup>                                                              |
| P1.3/<br>ADC10CLK/<br>A3/<br>VREF-/VEREF-                             | 5            | 5    | 3     | I/O | General-purpose digital I/O pin<br>ADC10, conversion clock output <sup>(1)</sup><br>ADC10 analog input A3 <sup>(1)</sup><br>ADC10 negative reference voltage <sup>(1)</sup>                                                                                                               |
| P1.4/<br>SMCLK/<br>UCB0STE/<br>UCA0CLK/<br>A4/<br>VREF+/VEREF+<br>TCK | 6            | 6    | 4     | I/O | General-purpose digital I/O pin<br>SMCLK signal output<br>USCI_B0 slave transmit enable<br>USCI_A0 clock input/output<br>ADC10 analog input A4 <sup>(1)</sup><br>ADC10 positive reference voltage <sup>(1)</sup><br>JTAG test clock, input terminal for device programming and test       |
| P1.5/<br>TA0.0/<br>UCB0CLK/<br>UCA0STE/<br>A5/<br>TMS                 | 7            | 7    | 5     | I/O | General-purpose digital I/O pin<br>Timer0_A, compare: Out0 output / BSL receive<br>USCI_B0 clock input/output<br>USCI_A0 slave transmit enable<br>ADC10 analog input A5 <sup>(1)</sup><br>JTAG test mode select, input terminal for device programming and test                           |
| P1.6/<br>TA0.1/<br>A6/<br>UCB0SOMI/<br>UCB0SCL/<br>TDI/TCLK           | 14           | 22   | 21    | I/O | General-purpose digital I/O pin<br>Timer0_A, compare: Out1 output<br>ADC10 analog input A6 <sup>(1)</sup><br>USCI_B0 slave out/master in SPI mode,<br>USCI_B0 SCL I <sup>2</sup> C clock in I <sup>2</sup> C mode<br>JTAG test data input or test clock input during programming and test |

(1) MSP430G2x33 devices only

**Table 4-1. Terminal Functions (continued)**

| TERMINAL                                         |              |      |       | I/O | DESCRIPTION                                                                                                                                                                                                                                                                      |
|--------------------------------------------------|--------------|------|-------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                             | NO.          |      |       |     |                                                                                                                                                                                                                                                                                  |
|                                                  | PW20,<br>N20 | PW28 | RHB32 |     |                                                                                                                                                                                                                                                                                  |
| P1.7/<br>A7/<br>UCB0SIMO/<br>UCB0SDA/<br>TDO/TDI | 15           | 23   | 22    | I/O | General-purpose digital I/O pin<br>ADC10 analog input A7 <sup>(1)</sup><br>USCI_B0 slave in/master out in SPI mode<br>USCI_B0 SDA I <sup>2</sup> C data in I <sup>2</sup> C mode<br>JTAG test data output terminal or test data input during programming and test <sup>(2)</sup> |
| P2.0/<br>TA1.0                                   | 8            | 10   | 9     | I/O | General-purpose digital I/O pin<br>Timer1_A, capture: CCI0A input, compare: Out0 output                                                                                                                                                                                          |
| P2.1/<br>TA1.1                                   | 9            | 11   | 10    | I/O | General-purpose digital I/O pin<br>Timer1_A, capture: CCI1A input, compare: Out1 output                                                                                                                                                                                          |
| P2.2/<br>TA1.1                                   | 10           | 12   | 11    | I/O | General-purpose digital I/O pin<br>Timer1_A, capture: CCI1B input, compare: Out1 output                                                                                                                                                                                          |
| P2.3/<br>TA1.0                                   | 11           | 16   | 15    | I/O | General-purpose digital I/O pin<br>Timer1_A, capture: CCI0B input, compare: Out0 output                                                                                                                                                                                          |
| P2.4/<br>TA1.2                                   | 12           | 17   | 16    | I/O | General-purpose digital I/O pin<br>Timer1_A, capture: CCI2A input, compare: Out2 output                                                                                                                                                                                          |
| P2.5/<br>TA1.2                                   | 13           | 18   | 17    | I/O | General-purpose digital I/O pin<br>Timer1_A, capture: CCI2B input, compare: Out2 output                                                                                                                                                                                          |
| XIN/<br>P2.6/<br>TA0.1                           | 19           | 27   | 26    | I/O | Input terminal of crystal oscillator<br>General-purpose digital I/O pin<br>Timer0_A, compare: Out1 output                                                                                                                                                                        |
| XOUT/<br>P2.7                                    | 18           | 26   | 25    | I/O | Output terminal of crystal oscillator <sup>(3)</sup><br>General-purpose digital I/O pin                                                                                                                                                                                          |
| P3.0/<br>TA0.2                                   | -            | 9    | 7     | I/O | General-purpose digital I/O pin<br>Timer0_A, capture: CCI2A input, compare: Out2 output                                                                                                                                                                                          |
| P3.1/<br>TA1.0                                   | -            | 8    | 6     | I/O | General-purpose digital I/O pin<br>Timer1_A, compare: Out0 output                                                                                                                                                                                                                |
| P3.2/<br>TA1.1                                   | -            | 13   | 12    | I/O | General-purpose digital I/O pin<br>Timer1_A, compare: Out1 output                                                                                                                                                                                                                |
| P3.3/<br>TA1.2                                   | -            | 14   | 13    | I/O | General-purpose digital I/O<br>Timer1_A, compare: Out2 output                                                                                                                                                                                                                    |
| P3.4/<br>TA0.0                                   | -            | 15   | 14    | I/O | General-purpose digital I/O<br>Timer0_A, compare: Out0 output                                                                                                                                                                                                                    |
| P3.5/<br>TA0.1                                   | -            | 19   | 18    | I/O | General-purpose digital I/O<br>Timer0_A, compare: Out1 output                                                                                                                                                                                                                    |
| P3.6/<br>TA0.2                                   | -            | 20   | 19    | I/O | General-purpose digital I/O<br>Timer0_A, compare: Out2 output                                                                                                                                                                                                                    |
| P3.7/<br>TA1CLK                                  | -            | 21   | 20    | I/O | General-purpose digital I/O<br>Timer1_A, clock signal TACLK input                                                                                                                                                                                                                |
| RST/<br>NMI/<br>SBWTDIO                          | 16           | 24   | 23    | I   | Reset<br>Nonmaskable interrupt input<br>Spy-Bi-Wire test data input/output during programming and test                                                                                                                                                                           |

(2) TDO or TDI is selected by JTAG instruction.

(3) If XOUT/P2.7 is used as an input, excess current flows until P2SEL.7 is cleared. This is due to the oscillator output driver connection to this pad after reset.

**Table 4-1. Terminal Functions (continued)**

| NAME            | TERMINAL<br>NO. |      |        | I/O | DESCRIPTION                                                                                                                                             |
|-----------------|-----------------|------|--------|-----|---------------------------------------------------------------------------------------------------------------------------------------------------------|
|                 | PW20,<br>N20    | PW28 | RHB32  |     |                                                                                                                                                         |
| TEST/<br>SBWTCK | 17              | 25   | 24     | I   | Selects test mode for JTAG pins on Port 1. The device protection fuse is connected to TEST.<br>Spy-Bi-Wire test clock input during programming and test |
| AVCC            | NA              | NA   | 29     | NA  | Analog supply voltage                                                                                                                                   |
| DVCC            | 1               | 1    | 30     | NA  | Digital supply voltage                                                                                                                                  |
| DVSS            | 20              | 28   | 27, 28 | NA  | Ground reference                                                                                                                                        |
| NC              | NA              | NA   | 8, 32  | NA  | Not connected                                                                                                                                           |
| QFN Pad         | NA              | NA   | Pad    | NA  | QFN package pad connection to VSS recommended.                                                                                                          |

## 5 Specifications

### 5.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                                               |                     | MIN  | MAX            | UNIT |
|-----------------------------------------------|---------------------|------|----------------|------|
| Voltage applied at $V_{CC}$ to $V_{SS}$       |                     | –0.3 | 4.1            | V    |
| Voltage applied to any pin <sup>(2)</sup>     |                     | –0.3 | $V_{CC} + 0.3$ | V    |
| Diode current at any device pin               |                     |      | ±2             | mA   |
| Storage temperature, $T_{stg}$ <sup>(3)</sup> | Unprogrammed device | –55  | 150            | °C   |
|                                               | Programmed device   | –55  | 150            |      |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages referenced to  $V_{SS}$ . The JTAG fuse-blow voltage,  $V_{FB}$ , is allowed to exceed the absolute maximum rating. The voltage is applied to the TEST pin when blowing the JTAG fuse.
- (3) Higher temperature may be applied during board soldering according to the current JEDEC J-STD-020 specification with peak reflow temperatures not higher than classified on the device label on the shipping boxes or reels.

### 5.2 ESD Ratings

|                                     |                                                                                | VALUE | UNIT |
|-------------------------------------|--------------------------------------------------------------------------------|-------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 | V    |
|                                     | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±250  |      |

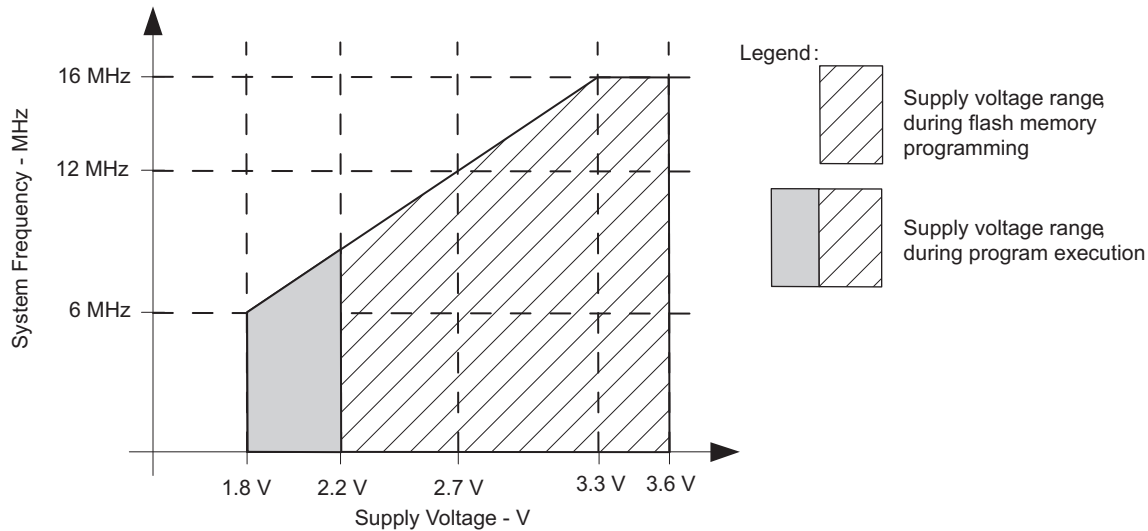
- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Pins listed as ±1000 V may actually have higher performance.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Pins listed as ±250 V may actually have higher performance.

### 5.3 Recommended Operating Conditions

Typical values are specified at  $V_{CC} = 3.3$  V and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

|                                                                                                    |                                            | MIN | NOM | MAX | UNIT |
|----------------------------------------------------------------------------------------------------|--------------------------------------------|-----|-----|-----|------|
| $V_{CC}$ Supply voltage                                                                            | During program execution                   | 1.8 |     | 3.6 | V    |
|                                                                                                    | During flash programming or erase          | 2.2 |     | 3.6 |      |
| $V_{SS}$ Supply voltage                                                                            |                                            |     | 0   |     | V    |
| $T_A$ Operating free-air temperature                                                               |                                            | –40 |     | 85  | °C   |
| $f_{SYSTEM}$ Processor frequency (maximum MCLK frequency using the USART module) <sup>(1)(2)</sup> | $V_{CC} = 1.8$ V,<br>Duty cycle = 50% ±10% | DC  |     | 6   | MHz  |
|                                                                                                    | $V_{CC} = 2.7$ V,<br>Duty cycle = 50% ±10% | DC  |     | 12  |      |
|                                                                                                    | $V_{CC} = 3.3$ V,<br>Duty cycle = 50% ±10% | DC  |     | 16  |      |

- (1) The MSP430 CPU is clocked directly with MCLK. Both the high and low phases of MCLK must not exceed the pulse duration of the specified maximum frequency.
- (2) Modules might have a different maximum input clock specification. See the specification of the respective module in this data sheet.



Note: Minimum processor frequency is defined by system clock. Flash program or erase operations require a minimum  $V_{CC}$  of 2.2 V.

**Figure 5-1. Safe Operating Area**

## 5.4 Active Mode Supply Current Into $V_{CC}$ Excluding External Current

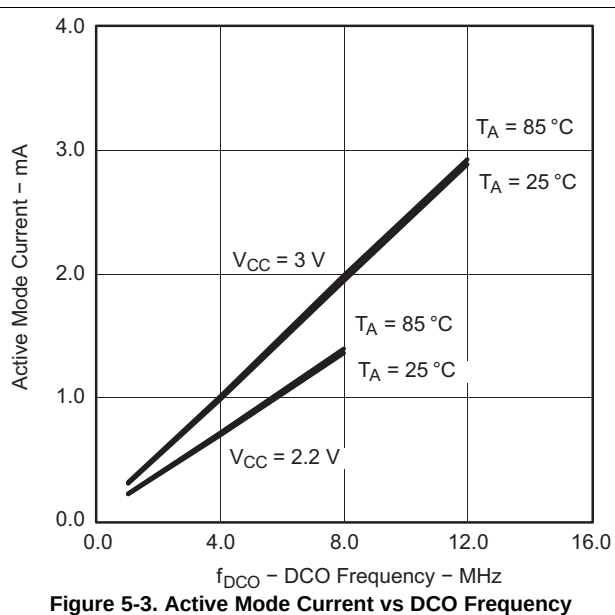
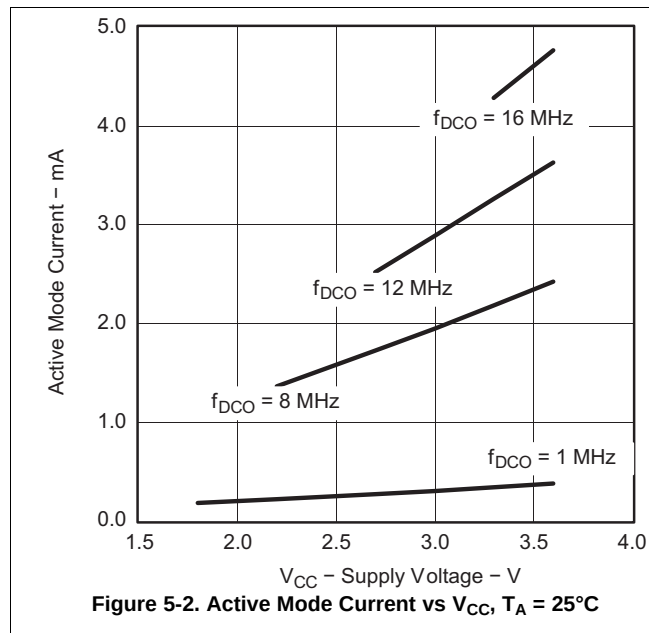
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)(2)</sup>

| PARAMETER                                       | TEST CONDITIONS                                                                                                                                                                                   | $V_{CC}$ | MIN | TYP | MAX | UNIT    |
|-------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----|-----|-----|---------|
| $I_{AM,1MHz}$ Active mode (AM) current at 1 MHz | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 1$ MHz,<br>$f_{ACLK} = 0$ Hz,<br>Program executes in flash,<br>BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>CPUOFF = 0, SCG0 = 0, SCG1 = 0,<br>OSCOFF = 0 | 2.2 V    |     | 230 |     | $\mu A$ |
|                                                 |                                                                                                                                                                                                   | 3 V      |     | 330 | 420 |         |

(1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.

(2) The currents are characterized with a Micro Crystal CC4V-T1A SMD crystal with a load capacitance of 9 pF. The internal and external load capacitance is chosen to closely match the required 9 pF.

## 5.5 Typical Characteristics, Active Mode Supply Current (Into $V_{CC}$ )



## 5.6 Low-Power Mode Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER                                                      | TEST CONDITIONS                                                                                                                                                                     | $T_A$ | $V_{CC}$ | MIN | TYP | MAX | UNIT    |
|----------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------|-----|-----|-----|---------|
| $I_{LPM0,1MHz}$ Low-power mode 0 (LPM0) current <sup>(3)</sup> | $f_{MCLK} = 0$ MHz,<br>$f_{SMCLK} = f_{DCO} = 1$ MHz,<br>$f_{ACLK} = 32768$ Hz,<br>BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>CPUOFF = 1, SCG0 = 0, SCG1 = 0,<br>OSCOFF = 0 | 25°C  | 2.2 V    |     | 56  |     | $\mu A$ |
| $I_{LPM2}$ Low-power mode 2 (LPM2) current <sup>(4)</sup>      | $f_{MCLK} = f_{SMCLK} = 0$ MHz,<br>$f_{DCO} = 1$ MHz,<br>$f_{ACLK} = 32768$ Hz,<br>BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>CPUOFF = 1, SCG0 = 0, SCG1 = 1,<br>OSCOFF = 0 | 25°C  | 2.2 V    |     | 22  |     | $\mu A$ |
| $I_{LPM3,LFX1}$ Low-power mode 3 (LPM3) current <sup>(4)</sup> | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 0$ MHz,<br>$f_{ACLK} = 32768$ Hz,<br>CPUOFF = 1, SCG0 = 1, SCG1 = 1,<br>OSCOFF = 0                                                                | 25°C  | 2.2 V    |     | 0.7 | 1.5 | $\mu A$ |
| $I_{LPM3,VLO}$ Low-power mode 3 current, (LPM3) <sup>(4)</sup> | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 0$ MHz,<br>$f_{ACLK}$ from internal LF oscillator (VLO),<br>CPUOFF = 1, SCG0 = 1, SCG1 = 1,<br>OSCOFF = 0                                         | 25°C  | 2.2 V    |     | 0.5 | 0.7 | $\mu A$ |
| $I_{LPM4}$ Low-power mode 4 (LPM4) current <sup>(5)</sup>      | $f_{DCO} = f_{MCLK} = f_{SMCLK} = 0$ MHz,<br>$f_{ACLK} = 0$ Hz,<br>CPUOFF = 1, SCG0 = 1, SCG1 = 1,<br>OSCOFF = 1                                                                    | 25°C  | 2.2 V    |     | 0.1 | 0.5 | $\mu A$ |
|                                                                |                                                                                                                                                                                     | 85°C  |          |     | 0.8 | 1.7 |         |

(1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.

(2) The currents are characterized with a Micro Crystal CC4V-T1A SMD crystal with a load capacitance of 9 pF. The internal and external load capacitance is chosen to closely match the required 9 pF.

(3) Current for brownout and WDT clocked by SMCLK included.

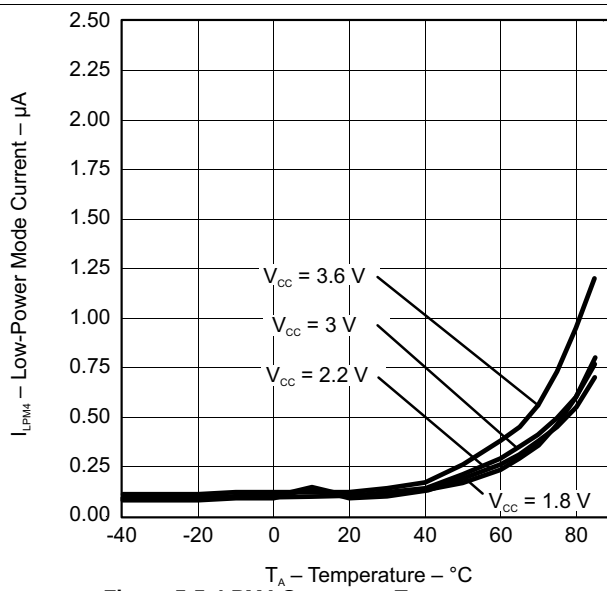
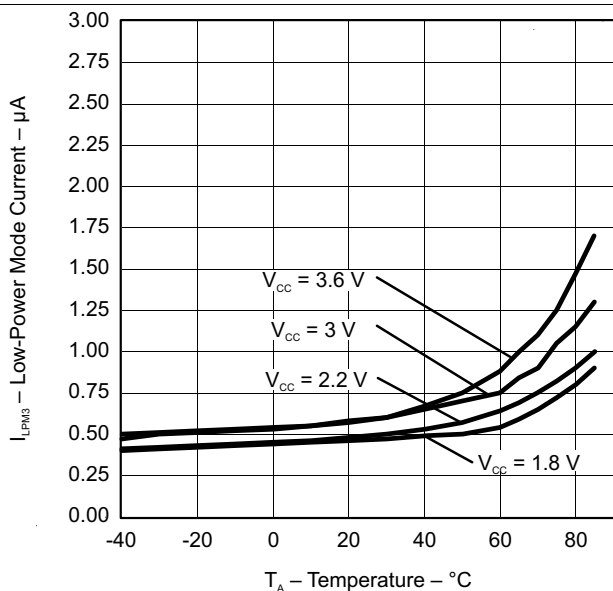
(4) Current for brownout and WDT clocked by ACLK included.

(5) Current for brownout included.



## 5.7 Typical Characteristics, Low-Power Mode Supply Currents

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



## 5.8 Thermal Resistance Characteristics

| PARAMETER              |                                                                  | VALUE <sup>(1)</sup> | UNIT |
|------------------------|------------------------------------------------------------------|----------------------|------|
| $R\theta_{JA}$         | Junction-to-ambient thermal resistance, still air <sup>(2)</sup> | VQFN (RHB-32)        | 32.1 |
|                        |                                                                  | TSSOP (PW-28)        | 72.2 |
|                        |                                                                  | TSSOP (PW-20)        | 86.5 |
|                        |                                                                  | PDIP (N-20)          | 49.3 |
| $R\theta_{JC(TOP)}$    | Junction-to-case (top) thermal resistance <sup>(3)</sup>         | VQFN (RHB-32)        | 22.3 |
|                        |                                                                  | TSSOP (PW-28)        | 18.3 |
|                        |                                                                  | TSSOP (PW-20)        | 20.8 |
|                        |                                                                  | PDIP (N-20)          | 41   |
| $R\theta_{JC(BOTTOM)}$ | Junction-to-case (bottom) thermal resistance                     | VQFN (RHB-32)        | 1.4  |
|                        |                                                                  | TSSOP (PW-28)        | N/A  |
|                        |                                                                  | TSSOP (PW-20)        | N/A  |
|                        |                                                                  | PDIP (N-20)          | N/A  |
| $\theta_{JB}$          | Junction-to-board thermal resistance <sup>(4)</sup>              | VQFN (RHB-32)        | 6.1  |
|                        |                                                                  | TSSOP (PW-28)        | 30.4 |
|                        |                                                                  | TSSOP (PW-20)        | 39   |
|                        |                                                                  | PDIP (N-20)          | 30.2 |
| $\Psi_{JT}$            | Junction-to-package-top characterization parameter               | VQFN (RHB-32)        | 0.3  |
|                        |                                                                  | TSSOP (PW-28)        | 0.7  |
|                        |                                                                  | TSSOP (PW-20)        | 0.8  |
|                        |                                                                  | PDIP (N-20)          | 18.1 |
| $\Psi_{JB}$            | Junction-to-board characterization parameter                     | VQFN (RHB-32)        | 6.1  |
|                        |                                                                  | TSSOP (PW-28)        | 29.9 |
|                        |                                                                  | TSSOP (PW-20)        | 38.1 |
|                        |                                                                  | PDIP (N-20)          | 30.1 |

- (1) These values are based on a JEDEC-defined 2S2P system (with the exception of the Theta JC ( $R\theta_{JC}$ ) value, which is based on a JEDEC-defined 1S0P system) and will change based on environment and application. For more information, see these EIA/JEDEC standards:
- JESD51-2, *Integrated Circuits Thermal Test Method Environmental Conditions - Natural Convection (Still Air)*
  - JESD51-3, *Low Effective Thermal Conductivity Test Board for Leaded Surface Mount Packages*
  - JESD51-7, *High Effective Thermal Conductivity Test Board for Leaded Surface Mount Packages*
  - JESD51-9, *Test Boards for Area Array Surface Mount Package Thermal Measurements*
- (2) The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, High-K board, as specified in JESD51-7, in an environment described in JESD51-2a.
- (3) The junction-to-case (top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDEC-standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.
- (4) The junction-to-board thermal resistance is obtained by simulating in an environment with a ring cold plate fixture to control the PCB temperature, as described in JESD51-8.

## 5.9 Schmitt-Trigger Inputs, Ports Px

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                        | TEST CONDITIONS                                                                                  | V <sub>CC</sub> | MIN                  | TYP | MAX                  | UNIT |
|----------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------|-----------------|----------------------|-----|----------------------|------|
| V <sub>IT+</sub> Positive-going input threshold voltage                          |                                                                                                  |                 | 0.45 V <sub>CC</sub> |     | 0.75 V <sub>CC</sub> | V    |
|                                                                                  |                                                                                                  | 3 V             | 1.35                 |     | 2.25                 |      |
| V <sub>IT–</sub> Negative-going input threshold voltage                          |                                                                                                  |                 | 0.25 V <sub>CC</sub> |     | 0.55 V <sub>CC</sub> | V    |
|                                                                                  |                                                                                                  | 3 V             | 0.75                 |     | 1.65                 |      |
| V <sub>hys</sub> Input voltage hysteresis (V <sub>IT+</sub> – V <sub>IT–</sub> ) |                                                                                                  | 3 V             | 0.3                  |     | 1                    | V    |
| R <sub>Pull</sub> Pullup or pulldown resistor                                    | For pullup: V <sub>IN</sub> = V <sub>SS</sub><br>For pulldown: V <sub>IN</sub> = V <sub>CC</sub> | 3 V             | 20                   | 35  | 50                   | kΩ   |
| C <sub>I</sub> Input capacitance                                                 | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                             |                 |                      | 5   |                      | pF   |

## 5.10 Leakage Current, Ports Px

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                             | TEST CONDITIONS                   | V <sub>CC</sub> | MIN | MAX | UNIT |
|-------------------------------------------------------|-----------------------------------|-----------------|-----|-----|------|
| I <sub>lkg(Px.y)</sub> High-impedance leakage current | See <sup>(1)</sup> <sup>(2)</sup> | 3 V             |     | ±50 | nA   |

- (1) The leakage current is measured with V<sub>SS</sub> or V<sub>CC</sub> applied to the corresponding pins, unless otherwise noted.  
(2) The leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup/pulldown resistor is disabled.

## 5.11 Outputs, Ports Px

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                 | TEST CONDITIONS                             | V <sub>CC</sub> | MIN | TYP                   | MAX | UNIT |
|-------------------------------------------|---------------------------------------------|-----------------|-----|-----------------------|-----|------|
| V <sub>OH</sub> High-level output voltage | I <sub>(OHmax)</sub> = –6 mA <sup>(1)</sup> | 3 V             |     | V <sub>CC</sub> – 0.3 |     | V    |
| V <sub>OL</sub> Low-level output voltage  | I <sub>(OLmax)</sub> = 6 mA <sup>(1)</sup>  | 3 V             |     | V <sub>SS</sub> + 0.3 |     | V    |

- (1) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±48 mA to hold the maximum voltage drop specified.

## 5.12 Output Frequency, Ports Px

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                           | TEST CONDITIONS                                                                   | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------------------------------------|-----------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| f <sub>Px.y</sub> Port output frequency (with load) | Px.y, C <sub>L</sub> = 20 pF, R <sub>L</sub> = 1 kΩ <sup>(1)</sup> <sup>(2)</sup> | 3 V             |     | 12  |     | MHz  |
| f <sub>Port_CLK</sub> Clock output frequency        | Px.y, C <sub>L</sub> = 20 pF <sup>(2)</sup>                                       | 3 V             |     | 16  |     | MHz  |

- (1) A resistive divider with two 50-kΩ resistors between V<sub>CC</sub> and V<sub>SS</sub> is used as load. The output is connected to the center tap of the divider.  
(2) The output voltage reaches at least 10% and 90% V<sub>CC</sub> at the specified toggle frequency.

## 5.13 Typical Characteristics – Outputs

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

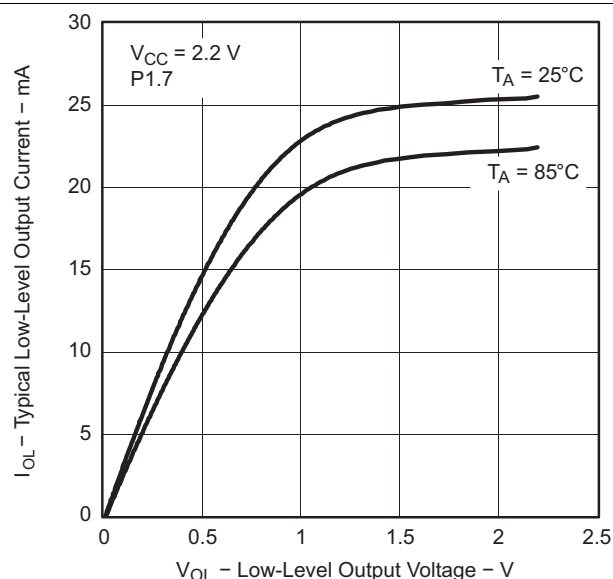


Figure 5-6. Typical Low-Level Output Current vs Low-Level Output Voltage

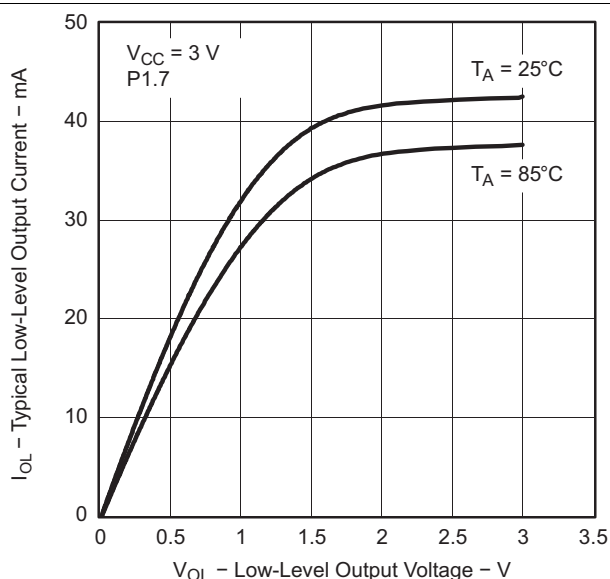


Figure 5-7. Typical Low-Level Output Current vs Low-Level Output Voltage

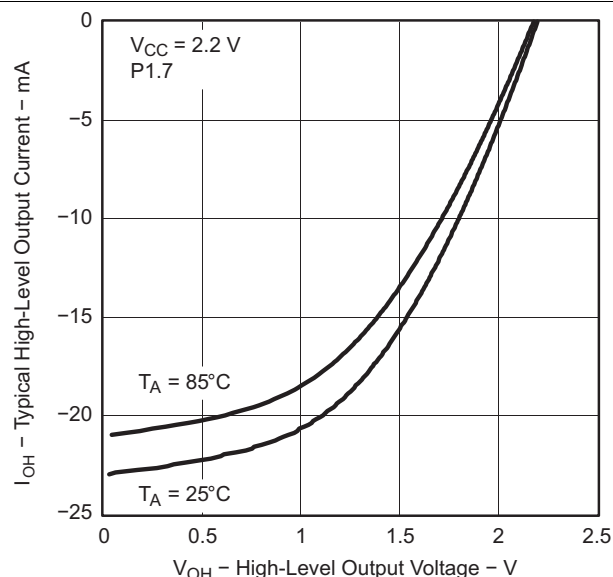


Figure 5-8. Typical High-Level Output Current vs High-Level Output Voltage

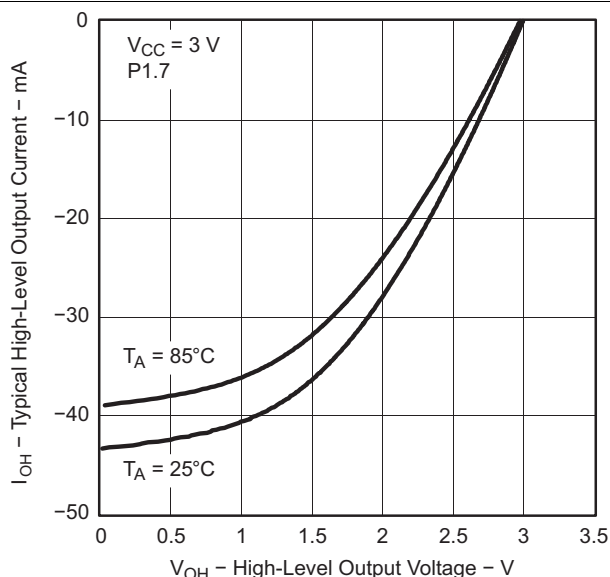


Figure 5-9. Typical High-Level Output Current vs High-Level Output Voltage

## 5.14 Pin-Oscillator Frequency – Ports Px

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                              | TEST CONDITIONS                                                                  | V <sub>CC</sub> | MIN | TYP  | MAX | UNIT |
|--------------------------------------------------------|----------------------------------------------------------------------------------|-----------------|-----|------|-----|------|
| f <sub>oP1.x</sub> Port output oscillation frequency   | P1.y, C <sub>L</sub> = 10 pF, R <sub>L</sub> = 100 kΩ <sup>(1)(2)</sup>          | 3 V             |     | 1400 |     | kHz  |
|                                                        | P1.y, C <sub>L</sub> = 20 pF, R <sub>L</sub> = 100 kΩ <sup>(1)(2)</sup>          |                 |     | 900  |     |      |
| f <sub>oP2.x</sub> Port output oscillation frequency   | P2.0 to P2.5, C <sub>L</sub> = 10 pF, R <sub>L</sub> = 100 kΩ <sup>(1)(2)</sup>  | 3 V             |     | 1800 |     | kHz  |
|                                                        | P2.0 to P2.5, C <sub>L</sub> = 20 pF, R <sub>L</sub> = 100 kΩ <sup>(1)(2)</sup>  |                 |     | 1000 |     |      |
| f <sub>oP2.6/7</sub> Port output oscillation frequency | P2.6 and P2.7, C <sub>L</sub> = 20 pF, R <sub>L</sub> = 100 kΩ <sup>(1)(2)</sup> | 3 V             |     | 700  |     | kHz  |
| f <sub>oP3.x</sub> Port output oscillation frequency   | P3.y, C <sub>L</sub> = 10 pF, R <sub>L</sub> = 100 kΩ <sup>(1)(2)</sup>          | 3 V             |     | 1800 |     | kHz  |
|                                                        | P3.y, C <sub>L</sub> = 20 pF, R <sub>L</sub> = 100 kΩ <sup>(1)(2)</sup>          |                 |     | 1000 |     |      |

- (1) A resistive divider with two 50-kΩ resistors between V<sub>CC</sub> and V<sub>SS</sub> is used as load. The output is connected to the center tap of the divider.
- (2) The output voltage reaches at least 10% and 90% V<sub>CC</sub> at the specified toggle frequency.

## 5.15 Typical Characteristics – Pin-Oscillator Frequency

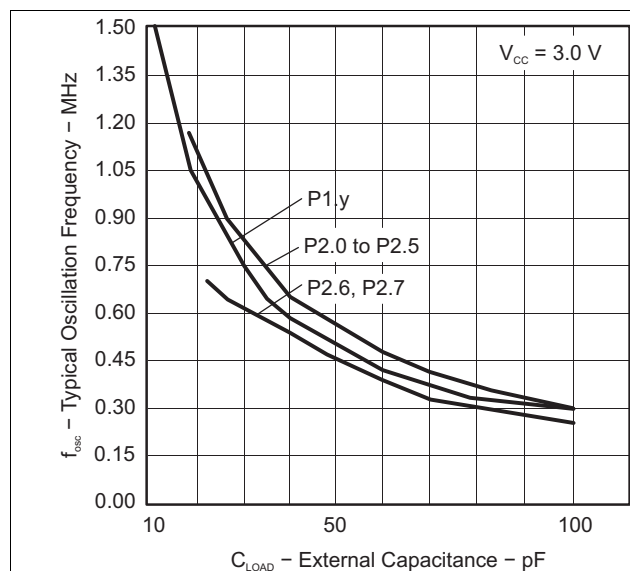


Figure 5-10. Typical Oscillating Frequency vs Load Capacitance

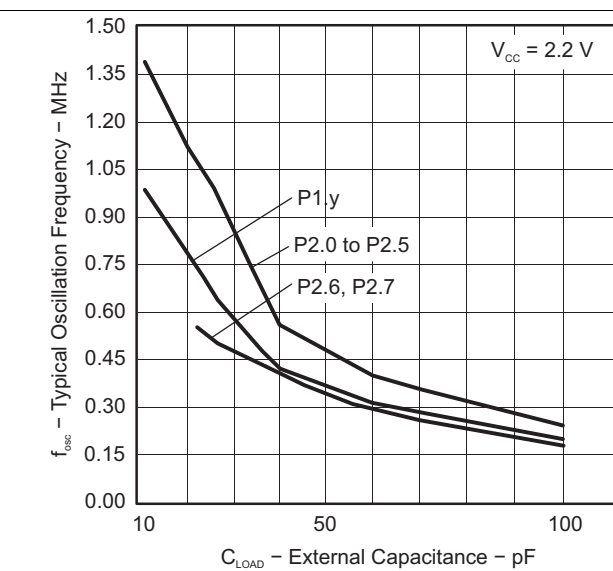


Figure 5-11. Typical Oscillating Frequency vs Load Capacitance

## 5.16 POR, BOR<sup>(1)(2)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER               | TEST CONDITIONS                                                                       | V <sub>CC</sub>              | MIN | TYP                      | MAX | UNIT |
|-------------------------|---------------------------------------------------------------------------------------|------------------------------|-----|--------------------------|-----|------|
| V <sub>CC(start)</sub>  | See Figure 5-12                                                                       | dV <sub>CC</sub> /dt ≤ 3 V/s |     | 0.7 V <sub>(B_IT-)</sub> |     | V    |
| V <sub>(B_IT-)</sub>    | See Figure 5-12 through Figure 5-14                                                   | dV <sub>CC</sub> /dt ≤ 3 V/s |     | 1.35                     |     | V    |
| V <sub>hys(B_IT-)</sub> | See Figure 5-12                                                                       | dV <sub>CC</sub> /dt ≤ 3 V/s |     | 140                      |     | mV   |
| t <sub>d(BOR)</sub>     | See Figure 5-12                                                                       |                              |     | 2000                     |     | μs   |
| t <sub>(reset)</sub>    | Pulse duration needed at $\overline{\text{RST/NMI}}$ pin to accepted reset internally | 2.2 V                        | 2   |                          |     | μs   |

- (1) The current consumption of the brownout module is already included in the I<sub>CC</sub> current consumption data. The voltage level V<sub>(B\_IT-)</sub> + V<sub>hys(B\_IT-)</sub> is ≤ 1.8 V.
- (2) During power up, the CPU begins code execution following a period of t<sub>d(BOR)</sub> after V<sub>CC</sub> = V<sub>(B\_IT-)</sub> + V<sub>hys(B\_IT-)</sub>. The default DCO settings must not be changed until V<sub>CC</sub> ≥ V<sub>CC(min)</sub>, where V<sub>CC(min)</sub> is the minimum supply voltage for the desired operating frequency.

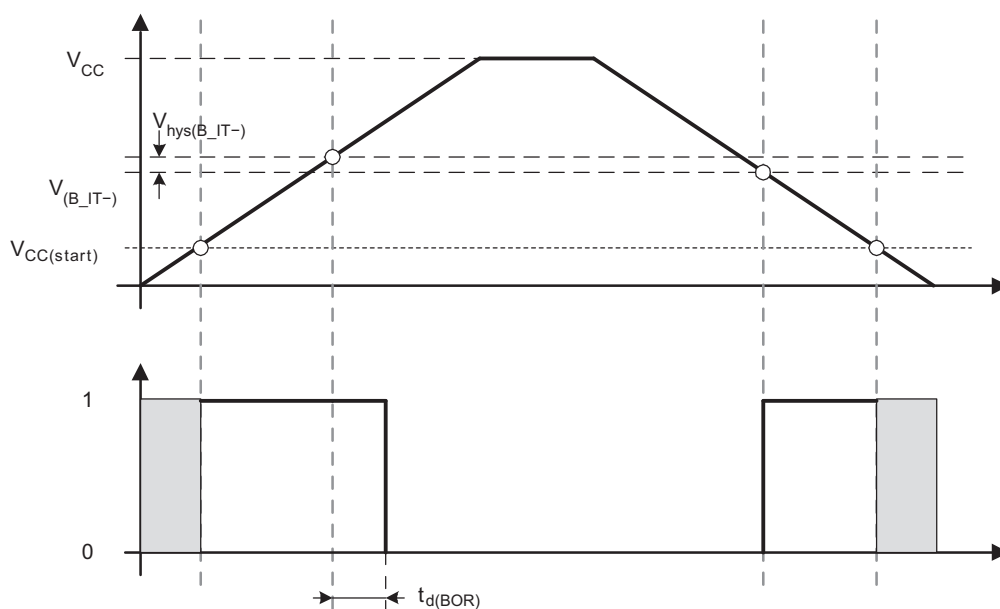


Figure 5-12. POR and BOR vs Supply Voltage

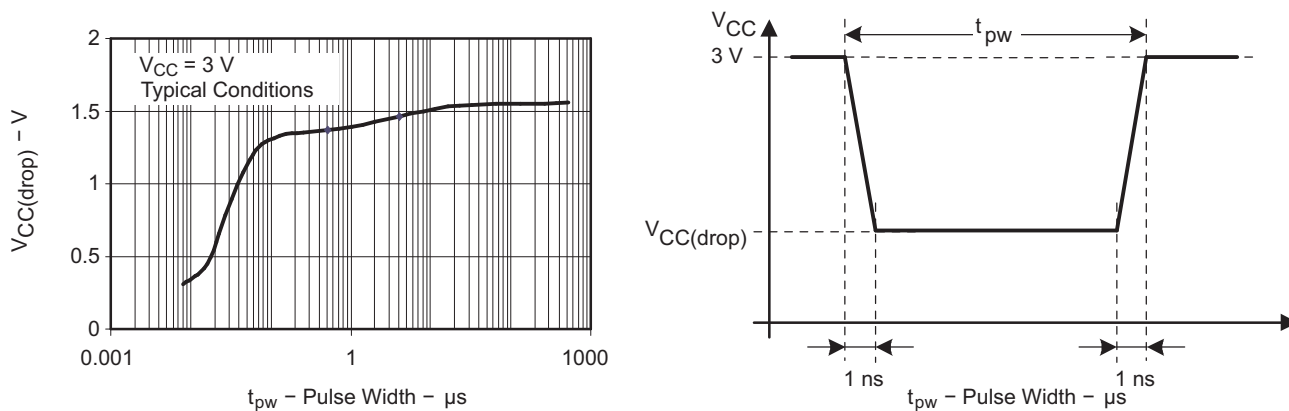
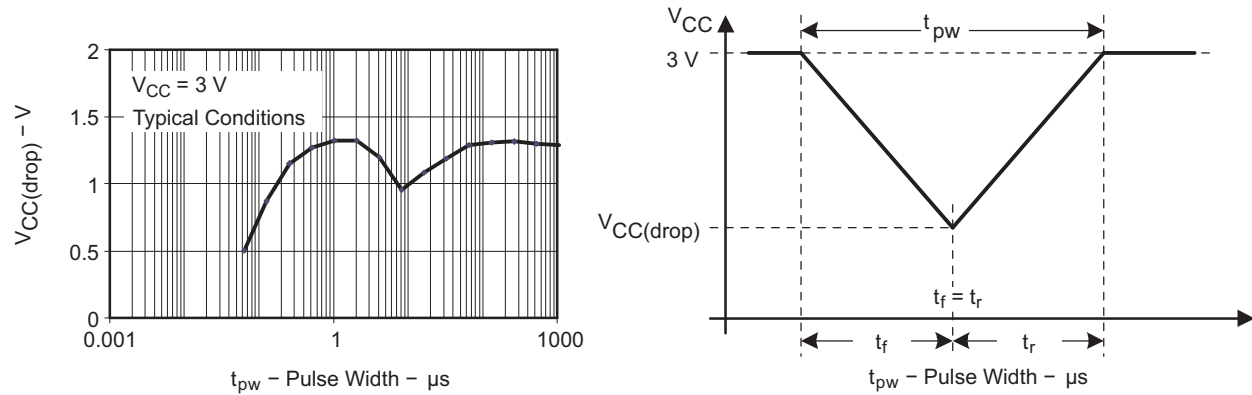


Figure 5-13. V<sub>CC(drop)</sub> Level With a Square Voltage Drop to Generate a POR or BOR Signal



**Figure 5-14.  $V_{CC(drop)}$  Level With a Triangle Voltage Drop to Generate a POR or BOR Signal**

## 5.17 Main DCO Characteristics

- All ranges selected by RSELx overlap with RSELx + 1: RSELx = 0 overlaps RSELx = 1, ... RSELx = 14 overlaps RSELx = 15.
- DCO control bits DCOx have a step size as defined by parameter S<sub>DCO</sub>.
- Modulation control bits MODx select how often f<sub>DCO(RSEL,DCO+1)</sub> is used within the period of 32 DCOCLK cycles. The frequency f<sub>DCO(RSEL,DCO)</sub> is used for the remaining cycles. The frequency is an average equal to:

$$f_{\text{average}} = \frac{32 \times f_{\text{DCO(RSEL,DCO)}} \times f_{\text{DCO(RSEL,DCO+1)}}}{\text{MOD} \times f_{\text{DCO(RSEL,DCO)}} + (32 - \text{MOD}) \times f_{\text{DCO(RSEL,DCO+1)}}}$$

## 5.18 DCO Frequency

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                      | TEST CONDITIONS                                                              | V <sub>CC</sub> | MIN  | TYP  | MAX  | UNIT  |
|----------------------------------------------------------------|------------------------------------------------------------------------------|-----------------|------|------|------|-------|
| V <sub>CC</sub> Supply voltage                                 | RSELx < 14                                                                   |                 | 1.8  |      | 3.6  | V     |
|                                                                | RSELx = 14                                                                   |                 | 2.2  |      | 3.6  |       |
|                                                                | RSELx = 15                                                                   |                 | 3    |      | 3.6  |       |
| f <sub>DCO(0,0)</sub> DCO frequency (0, 0)                     | RSELx = 0, DCOx = 0, MODx = 0                                                | 3 V             | 0.06 |      | 0.14 | MHz   |
| f <sub>DCO(0,3)</sub> DCO frequency (0, 3)                     | RSELx = 0, DCOx = 3, MODx = 0                                                | 3 V             | 0.07 |      | 0.17 | MHz   |
| f <sub>DCO(1,3)</sub> DCO frequency (1, 3)                     | RSELx = 1, DCOx = 3, MODx = 0                                                | 3 V             |      | 0.15 |      | MHz   |
| f <sub>DCO(2,3)</sub> DCO frequency (2, 3)                     | RSELx = 2, DCOx = 3, MODx = 0                                                | 3 V             |      | 0.21 |      | MHz   |
| f <sub>DCO(3,3)</sub> DCO frequency (3, 3)                     | RSELx = 3, DCOx = 3, MODx = 0                                                | 3 V             |      | 0.30 |      | MHz   |
| f <sub>DCO(4,3)</sub> DCO frequency (4, 3)                     | RSELx = 4, DCOx = 3, MODx = 0                                                | 3 V             |      | 0.41 |      | MHz   |
| f <sub>DCO(5,3)</sub> DCO frequency (5, 3)                     | RSELx = 5, DCOx = 3, MODx = 0                                                | 3 V             |      | 0.58 |      | MHz   |
| f <sub>DCO(6,3)</sub> DCO frequency (6, 3)                     | RSELx = 6, DCOx = 3, MODx = 0                                                | 3 V             | 0.54 |      | 1.06 | MHz   |
| f <sub>DCO(7,3)</sub> DCO frequency (7, 3)                     | RSELx = 7, DCOx = 3, MODx = 0                                                | 3 V             | 0.80 |      | 1.50 | MHz   |
| f <sub>DCO(8,3)</sub> DCO frequency (8, 3)                     | RSELx = 8, DCOx = 3, MODx = 0                                                | 3 V             |      | 1.6  |      | MHz   |
| f <sub>DCO(9,3)</sub> DCO frequency (9, 3)                     | RSELx = 9, DCOx = 3, MODx = 0                                                | 3 V             |      | 2.3  |      | MHz   |
| f <sub>DCO(10,3)</sub> DCO frequency (10, 3)                   | RSELx = 10, DCOx = 3, MODx = 0                                               | 3 V             |      | 3.4  |      | MHz   |
| f <sub>DCO(11,3)</sub> DCO frequency (11, 3)                   | RSELx = 11, DCOx = 3, MODx = 0                                               | 3 V             |      | 4.25 |      | MHz   |
| f <sub>DCO(12,3)</sub> DCO frequency (12, 3)                   | RSELx = 12, DCOx = 3, MODx = 0                                               | 3 V             | 4.30 |      | 7.30 | MHz   |
| f <sub>DCO(13,3)</sub> DCO frequency (13, 3)                   | RSELx = 13, DCOx = 3, MODx = 0                                               | 3 V             | 6.00 |      | 9.60 | MHz   |
| f <sub>DCO(14,3)</sub> DCO frequency (14, 3)                   | RSELx = 14, DCOx = 3, MODx = 0                                               | 3 V             | 8.60 |      | 13.9 | MHz   |
| f <sub>DCO(15,3)</sub> DCO frequency (15, 3)                   | RSELx = 15, DCOx = 3, MODx = 0                                               | 3 V             | 12.0 |      | 18.5 | MHz   |
| f <sub>DCO(15,7)</sub> DCO frequency (15, 7)                   | RSELx = 15, DCOx = 7, MODx = 0                                               | 3 V             | 16.0 |      | 26.0 | MHz   |
| S <sub>RSEL</sub> Frequency step between range RSEL and RSEL+1 | S <sub>RSEL</sub> = f <sub>DCO(RSEL+1,DCO)</sub> /f <sub>DCO(RSEL,DCO)</sub> | 3 V             |      | 1.35 |      | ratio |
| S <sub>DCO</sub> Frequency step between tap DCO and DCO+1      | S <sub>DCO</sub> = f <sub>DCO(RSEL,DCO+1)</sub> /f <sub>DCO(RSEL,DCO)</sub>  | 3 V             |      | 1.08 |      | ratio |
| Duty cycle                                                     | Measured at SMCLK output                                                     | 3 V             |      | 50%  |      |       |



## 5.19 Calibrated DCO Frequencies, Tolerance

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                        | TEST CONDITIONS                                                                 | T <sub>A</sub> | V <sub>CC</sub> | MIN | TYP   | MAX | UNIT |
|--------------------------------------------------|---------------------------------------------------------------------------------|----------------|-----------------|-----|-------|-----|------|
| 1-MHz tolerance over temperature <sup>(1)</sup>  | BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>calibrated at 30°C and 3 V   | 0°C to 85°C    | 3 V             | –3% | ±0.5% | +3% |      |
| 1-MHz tolerance over V <sub>CC</sub>             | BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>calibrated at 30°C and 3 V   | 30°C           | 1.8 V to 3.6 V  | –3% | ±2%   | +3% |      |
| 1-MHz tolerance overall                          | BCSCTL1 = CALBC1_1MHZ,<br>DCOCTL = CALDCO_1MHZ,<br>calibrated at 30°C and 3 V   | –40°C to 85°C  | 1.8 V to 3.6 V  | –6% | ±3%   | +6% |      |
| 8-MHz tolerance over temperature <sup>(1)</sup>  | BCSCTL1 = CALBC1_8MHZ,<br>DCOCTL = CALDCO_8MHZ,<br>calibrated at 30°C and 3 V   | 0°C to 85°C    | 3 V             | –3% | ±0.5% | +3% |      |
| 8-MHz tolerance over V <sub>CC</sub>             | BCSCTL1 = CALBC1_8MHZ,<br>DCOCTL = CALDCO_8MHZ,<br>calibrated at 30°C and 3 V   | 30°C           | 2.2 V to 3.6 V  | –3% | ±2%   | +3% |      |
| 8-MHz tolerance overall                          | BCSCTL1 = CALBC1_8MHZ,<br>DCOCTL = CALDCO_8MHZ,<br>calibrated at 30°C and 3 V   | –40°C to 85°C  | 2.2 V to 3.6 V  | –6% | ±3%   | +6% |      |
| 12-MHz tolerance over temperature <sup>(1)</sup> | BCSCTL1 = CALBC1_12MHZ,<br>DCOCTL = CALDCO_12MHZ,<br>calibrated at 30°C and 3 V | 0°C to 85°C    | 3 V             | –3% | ±0.5% | +3% |      |
| 12-MHz tolerance over V <sub>CC</sub>            | BCSCTL1 = CALBC1_12MHZ,<br>DCOCTL = CALDCO_12MHZ,<br>calibrated at 30°C and 3 V | 30°C           | 2.7 V to 3.6 V  | –3% | ±2%   | +3% |      |
| 12-MHz tolerance overall                         | BCSCTL1 = CALBC1_12MHZ,<br>DCOCTL = CALDCO_12MHZ,<br>calibrated at 30°C and 3 V | –40°C to 85°C  | 2.7 V to 3.6 V  | –6% | ±3%   | +6% |      |
| 16-MHz tolerance over temperature <sup>(1)</sup> | BCSCTL1 = CALBC1_16MHZ,<br>DCOCTL = CALDCO_16MHZ,<br>calibrated at 30°C and 3 V | 0°C to 85°C    | 3 V             | –3% | ±0.5% | +3% |      |
| 16-MHz tolerance over V <sub>CC</sub>            | BCSCTL1 = CALBC1_16MHZ,<br>DCOCTL = CALDCO_16MHZ,<br>calibrated at 30°C and 3 V | 30°C           | 3.3 V to 3.6 V  | –3% | ±2%   | +3% |      |
| 16-MHz tolerance overall                         | BCSCTL1 = CALBC1_16MHZ,<br>DCOCTL = CALDCO_16MHZ,<br>calibrated at 30°C and 3 V | –40°C to 85°C  | 3.3 V to 3.6 V  | –6% | ±3%   | +6% |      |

(1) This is the frequency change from the measured frequency at 30°C over temperature.

## 5.20 Wake-up Times From Lower-Power Modes (LPM3, LPM4)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                       | TEST CONDITIONS                                | V <sub>CC</sub> | MIN | TYP                                                | MAX | UNIT |
|---------------------------------------------------------------------------------|------------------------------------------------|-----------------|-----|----------------------------------------------------|-----|------|
| t <sub>DCO,LPM3/4</sub> DCO clock wake-up time from LPM3 or LPM4 <sup>(1)</sup> | BCSCTL1 = CALBC1_1MHz,<br>DCOCTL = CALDCO_1MHz | 3 V             |     | 1.5                                                |     | μs   |
| t <sub>CPU,LPM3/4</sub> CPU wake-up time from LPM3 or LPM4 <sup>(2)</sup>       |                                                |                 |     | 1/f <sub>MCLK</sub> +<br>t <sub>Clock,LPM3/4</sub> |     |      |

(1) The DCO clock wake-up time is measured from the edge of an external wake-up signal (for example, port interrupt) to the first clock edge observable externally on a clock pin (MCLK or SMCLK).

(2) Parameter applicable only if DCOCLK is used for MCLK.

## 5.21 Typical Characteristics, DCO Clock Wake-up Time From LPM3 or LPM4

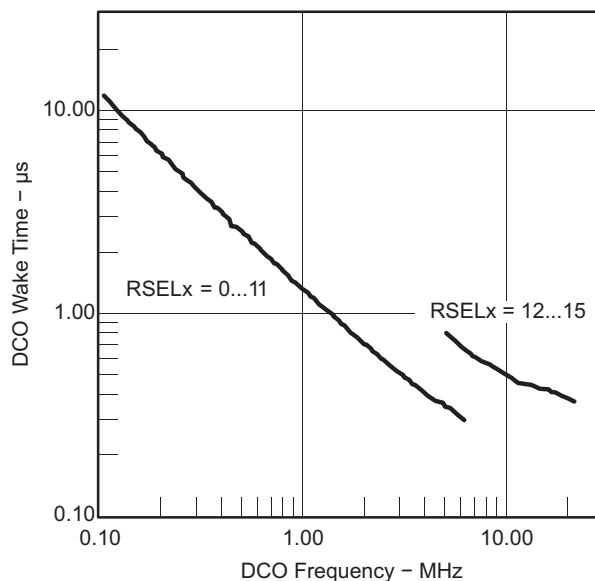


Figure 5-15. DCO Wake-up Time From LPM3 vs DCO Frequency

## 5.22 Crystal Oscillator, XT1, Low-Frequency Mode<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                   |                                                                   | TEST CONDITIONS                                                                    | V <sub>CC</sub> | MIN   | TYP   | MAX   | UNIT |
|-----------------------------|-------------------------------------------------------------------|------------------------------------------------------------------------------------|-----------------|-------|-------|-------|------|
| f <sub>LFXT1,LF</sub>       | LFXT1 oscillator crystal frequency, LF mode 0, 1                  | XTS = 0, LFXT1Sx = 0 or 1                                                          | 1.8 V to 3.6 V  | 32768 |       |       | Hz   |
| f <sub>LFXT1,LF,logic</sub> | LFXT1 oscillator logic level square-wave input frequency, LF mode | XTS = 0, XCAPx = 0, LFXT1Sx = 3                                                    | 1.8 V to 3.6 V  | 10000 | 32768 | 50000 | Hz   |
| OA <sub>LF</sub>            | Oscillation allowance for LF crystals                             | XTS = 0, LFXT1Sx = 0, f <sub>LFXT1,LF</sub> = 32768 Hz, C <sub>L,eff</sub> = 6 pF  |                 | 500   |       |       | kΩ   |
|                             |                                                                   | XTS = 0, LFXT1Sx = 0, f <sub>LFXT1,LF</sub> = 32768 Hz, C <sub>L,eff</sub> = 12 pF |                 | 200   |       |       |      |
| C <sub>L,eff</sub>          | Integrated effective load capacitance, LF mode <sup>(2)</sup>     | XTS = 0, XCAPx = 0                                                                 |                 | 1     |       |       | pF   |
|                             |                                                                   | XTS = 0, XCAPx = 1                                                                 |                 | 5.5   |       |       |      |
|                             |                                                                   | XTS = 0, XCAPx = 2                                                                 |                 | 8.5   |       |       |      |
|                             |                                                                   | XTS = 0, XCAPx = 3                                                                 |                 | 11    |       |       |      |
| Duty cycle, LF mode         |                                                                   | XTS = 0, Measured at P2.0/ACLK, f <sub>LFXT1,LF</sub> = 32768 Hz                   | 2.2 V           | 30%   | 50%   | 70%   |      |
| f <sub>Fault,LF</sub>       | Oscillator fault frequency, LF mode <sup>(3)</sup>                | XTS = 0, XCAPx = 0, LFXT1Sx = 3 <sup>(4)</sup>                                     | 2.2 V           | 10    | 10000 |       | Hz   |

- (1) To improve EMI on the XT1 oscillator, the following guidelines should be observed.
  - Keep the trace between the device and the crystal as short as possible.
  - Design a good ground plane around the oscillator pins.
  - Prevent crosstalk from other clock or data lines into oscillator pins XIN and XOUT.
  - Avoid running PCB traces underneath or adjacent to the XIN and XOUT pins.
  - Use assembly materials and processes that avoid any parasitic load on the oscillator XIN and XOUT pins.
  - If conformal coating is used, make sure that it does not induce capacitive or resistive leakage between the oscillator pins.
  - Do not route the XOUT line to the JTAG header to support the serial programming adapter as shown in other documentation. This signal is no longer required for the serial programming adapter.
- (2) Includes parasitic bond and package capacitance (approximately 2 pF per pin). Because the PCB adds additional capacitance, verify the correct load by measuring the ACLK frequency. For a correct setup, the effective load capacitance should always match the specification of the used crystal.
- (3) Frequencies below the MIN specification set the fault flag. Frequencies above the MAX specification do not set the fault flag. Frequencies in between might set the flag.
- (4) Measured with logic-level input frequency but also applies to operation with crystals.

## 5.23 Internal Very-Low-Power Low-Frequency Oscillator (VLO)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                           |                                    | T <sub>A</sub> | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-------------------------------------|------------------------------------|----------------|-----------------|-----|-----|-----|------|
| f <sub>VLO</sub>                    | VLO frequency                      | –40°C to 85°C  | 3 V             | 4   | 12  | 20  | kHz  |
| df <sub>VLO</sub> /dT               | VLO frequency temperature drift    | –40°C to 85°C  | 3 V             |     | 0.5 |     | %/°C |
| df <sub>VLO</sub> /dV <sub>CC</sub> | VLO frequency supply voltage drift | 25°C           | 1.8 V to 3.6 V  |     | 4   |     | %/V  |

## 5.24 Timer\_A

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER           |                               | TEST CONDITIONS              | V <sub>CC</sub> | MIN                 | TYP | MAX | UNIT |
|---------------------|-------------------------------|------------------------------|-----------------|---------------------|-----|-----|------|
| f <sub>TA</sub>     | Timer_A input clock frequency | SMCLK, duty cycle = 50% ±10% |                 | f <sub>SYSTEM</sub> |     |     | MHz  |
| t <sub>TA,cap</sub> | Timer_A capture timing        | TA0, TA1                     | 3 V             | 20                  |     |     | ns   |

## 5.25 USCI (UART Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER               | TEST CONDITIONS                                                           | V <sub>CC</sub> | MIN | TYP                 | MAX | UNIT |
|-------------------------|---------------------------------------------------------------------------|-----------------|-----|---------------------|-----|------|
| f <sub>USCI</sub>       | USCI input clock frequency                                                |                 |     | f <sub>SYSTEM</sub> |     | MHz  |
| f <sub>max,BITCLK</sub> | Maximum BITCLK clock frequency (equals baud rate in MBaud) <sup>(1)</sup> | 3 V             | 2   |                     |     | MHz  |
| t <sub>r</sub>          | UART receive deglitch time <sup>(2)</sup>                                 | 3 V             | 50  | 100                 | 600 | ns   |

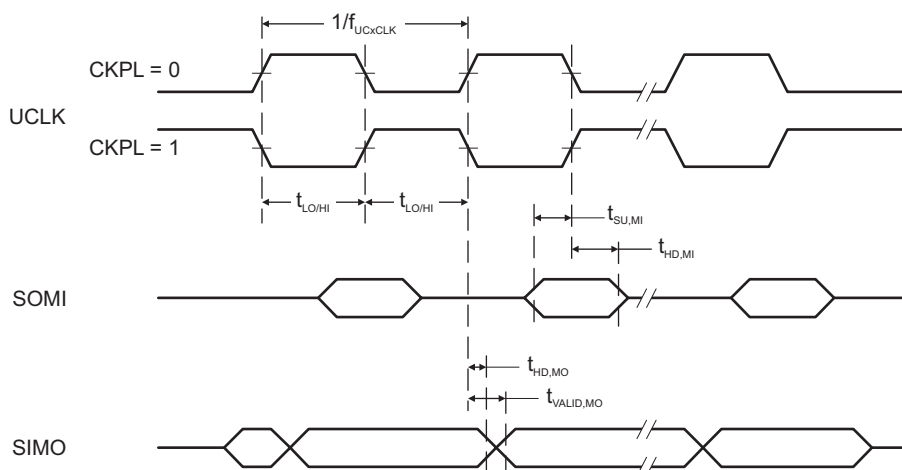
(1) The DCO wake-up time must be considered in LPM3 and LPM4 for baud rates above 1 MHz.

(2) Pulses on the UART receive input (UCxRX) shorter than the UART receive deglitch time are suppressed. To ensure that pulses are correctly recognized, their duration should exceed the maximum specification of the deglitch time.

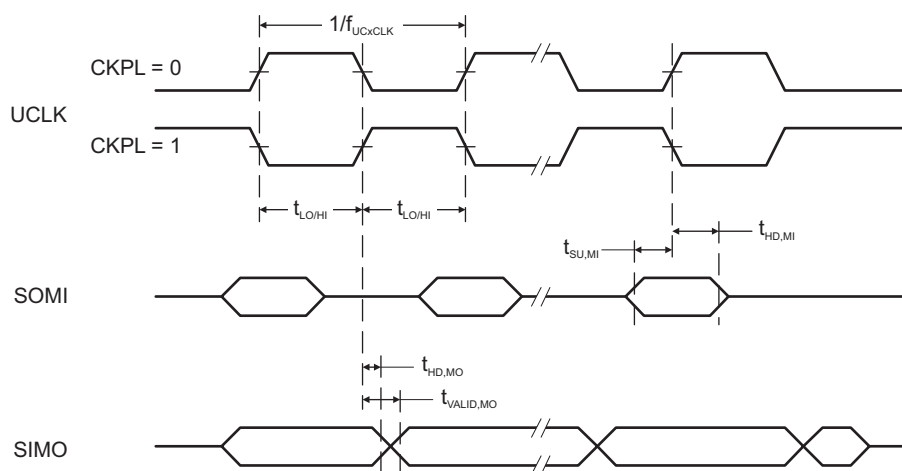
## 5.26 USCI (SPI Master Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-16](#) and [Figure 5-17](#))

| PARAMETER             | TEST CONDITIONS             | V <sub>CC</sub> | MIN | MAX                 | UNIT |
|-----------------------|-----------------------------|-----------------|-----|---------------------|------|
| f <sub>USCI</sub>     | USCI input clock frequency  |                 |     | f <sub>SYSTEM</sub> | MHz  |
| t <sub>SU,MI</sub>    | SOMI input data setup time  | 3 V             | 75  |                     | ns   |
| t <sub>HD,MI</sub>    | SOMI input data hold time   | 3 V             | 0   |                     | ns   |
| t <sub>VALID,MO</sub> | SIMO output data valid time | 3 V             |     | 20                  | ns   |



**Figure 5-16. SPI Master Mode, CKPH = 0**

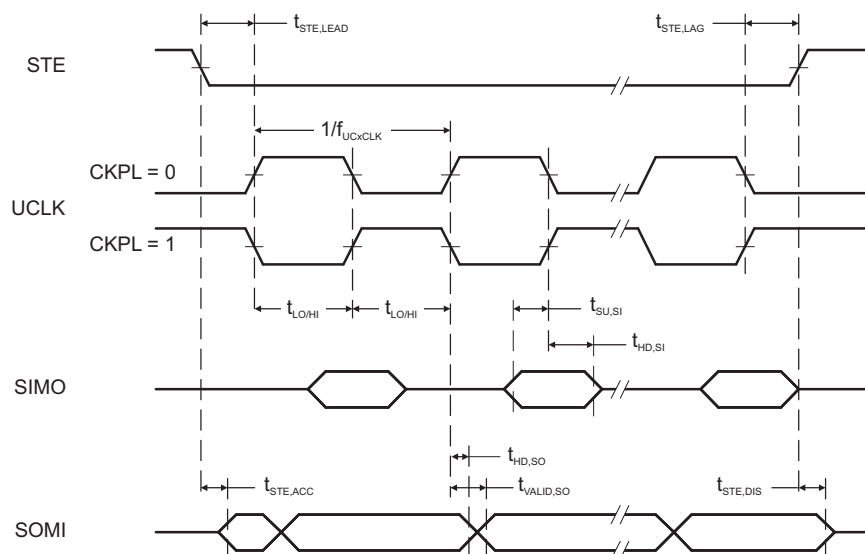


**Figure 5-17. SPI Master Mode, CKPH = 1**

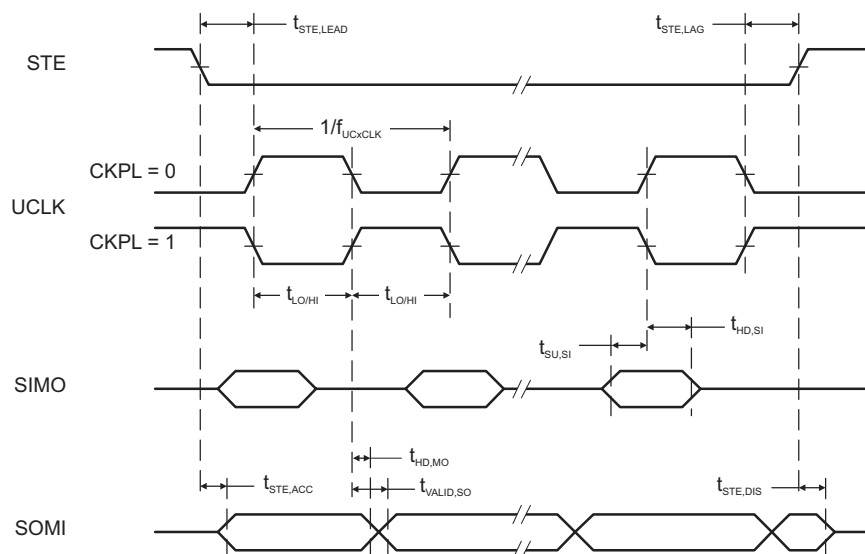
## 5.27 USCI (SPI Slave Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-18](#) and [Figure 5-19](#))

| PARAMETER             | TEST CONDITIONS                                   | V <sub>CC</sub>                                 | MIN | TYP | MAX | UNIT |
|-----------------------|---------------------------------------------------|-------------------------------------------------|-----|-----|-----|------|
| t <sub>STE,LEAD</sub> | STE lead time, STE low to clock                   | 3 V                                             |     | 50  |     | ns   |
| t <sub>STE,LAG</sub>  | STE lag time, Last clock to STE high              | 3 V                                             | 10  |     |     | ns   |
| t <sub>STE,ACC</sub>  | STE access time, STE low to SOMI data out         | 3 V                                             |     | 50  |     | ns   |
| t <sub>STE,DIS</sub>  | STE disable time, STE high to SOMI high impedance | 3 V                                             |     | 50  |     | ns   |
| t <sub>SU,SI</sub>    | SIMO input data setup time                        | 3 V                                             | 15  |     |     | ns   |
| t <sub>HD,SI</sub>    | SIMO input data hold time                         | 3 V                                             | 10  |     |     | ns   |
| t <sub>VALID,SO</sub> | SOMI output data valid time                       | UCLK edge to SOMI valid, C <sub>L</sub> = 20 pF |     | 50  | 75  | ns   |



**Figure 5-18. SPI Slave Mode, CKPH = 0**

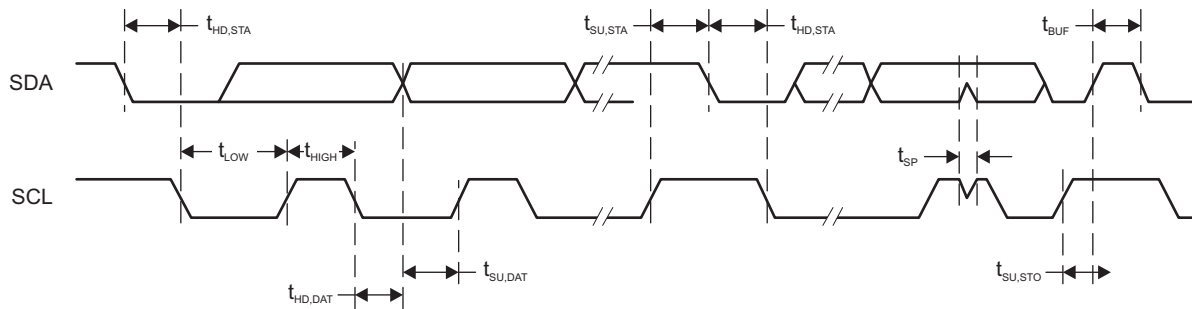


**Figure 5-19. SPI Slave Mode, CKPH = 1**

## 5.28 USCI (I<sup>2</sup>C Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-20](#))

| PARAMETER           |                                                     | TEST CONDITIONS              | V <sub>CC</sub> | MIN                 | TYP | MAX | UNIT |
|---------------------|-----------------------------------------------------|------------------------------|-----------------|---------------------|-----|-----|------|
| f <sub>USCI</sub>   | USCI input clock frequency                          | SMCLK, duty cycle = 50% ±10% |                 | f <sub>SYSTEM</sub> |     |     | MHz  |
| f <sub>SCL</sub>    | SCL clock frequency                                 |                              | 3 V             | 0                   |     | 400 | kHz  |
| t <sub>HD,STA</sub> | Hold time (repeated) START                          | f <sub>SCL</sub> ≤ 100 kHz   | 3 V             | 4.0                 |     |     | μs   |
|                     |                                                     | f <sub>SCL</sub> > 100 kHz   |                 | 0.6                 |     |     |      |
| t <sub>SU,STA</sub> | Setup time for a repeated START                     | f <sub>SCL</sub> ≤ 100 kHz   | 3 V             | 4.7                 |     |     | μs   |
|                     |                                                     | f <sub>SCL</sub> > 100 kHz   |                 | 0.6                 |     |     |      |
| t <sub>HD,DAT</sub> | Data hold time                                      |                              | 3 V             | 0                   |     |     | ns   |
| t <sub>SU,DAT</sub> | Data setup time                                     |                              | 3 V             | 250                 |     |     | ns   |
| t <sub>SU,STO</sub> | Setup time for STOP                                 |                              | 3 V             | 4.0                 |     |     | μs   |
| t <sub>SP</sub>     | Pulse duration of spikes suppressed by input filter |                              | 3 V             | 50                  | 100 | 600 | ns   |



**Figure 5-20. I<sup>2</sup>C Mode Timing**

## 5.29 10-Bit ADC, Power Supply and Input Range Conditions (MSP430G2x33 Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER           |                                                                       | TEST CONDITIONS                                                                                              | T <sub>A</sub> | V <sub>CC</sub> | MIN | TYP  | MAX             | UNIT |
|---------------------|-----------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------|----------------|-----------------|-----|------|-----------------|------|
| V <sub>CC</sub>     | Analog supply voltage                                                 | V <sub>SS</sub> = 0 V                                                                                        |                |                 | 2.2 |      | 3.6             | V    |
| V <sub>AX</sub>     | Analog input voltage <sup>(2)</sup>                                   | All Ax terminals, Analog inputs selected in ADC10AE register                                                 |                | 3 V             | 0   |      | V <sub>CC</sub> | V    |
| I <sub>ADC10</sub>  | ADC10 supply current <sup>(3)</sup>                                   | f <sub>ADC10CLK</sub> = 5.0 MHz,<br>ADC10ON = 1, REFON = 0,<br>ADC10SHT0 = 1, ADC10SHT1 = 0,<br>ADC10DIV = 0 | 25°C           | 3 V             |     | 0.6  |                 | mA   |
| I <sub>REF+</sub>   | Reference supply current,<br>reference buffer disabled <sup>(4)</sup> | f <sub>ADC10CLK</sub> = 5.0 MHz,<br>ADC10ON = 0, REF2_5V = 0,<br>REFON = 1, REFOUT = 0                       | 25°C           | 3 V             |     | 0.25 |                 | mA   |
|                     |                                                                       | f <sub>ADC10CLK</sub> = 5.0 MHz,<br>ADC10ON = 0, REF2_5V = 1,<br>REFON = 1, REFOUT = 0                       |                |                 |     | 0.25 |                 |      |
| I <sub>REFB,0</sub> | Reference buffer supply current<br>with ADC10SR = 0 <sup>(4)</sup>    | f <sub>ADC10CLK</sub> = 5.0 MHz,<br>ADC10ON = 0, REFON = 1,<br>REF2_5V = 0, REFOUT = 1,<br>ADC10SR = 0       | 25°C           | 3 V             |     | 1.1  |                 | mA   |
| I <sub>REFB,1</sub> | Reference buffer supply current<br>with ADC10SR = 1 <sup>(4)</sup>    | f <sub>ADC10CLK</sub> = 5.0 MHz,<br>ADC10ON = 0, REFON = 1,<br>REF2_5V = 0, REFOUT = 1,<br>ADC10SR = 1       | 25°C           | 3 V             |     | 0.5  |                 | mA   |
| C <sub>I</sub>      | Input capacitance                                                     | Only one terminal Ax can be selected<br>at one time                                                          | 25°C           | 3 V             |     |      | 27              | pF   |
| R <sub>I</sub>      | Input MUX ON resistance                                               | 0 V ≤ V <sub>AX</sub> ≤ V <sub>CC</sub>                                                                      | 25°C           | 3 V             |     | 1000 |                 | Ω    |

(1) The leakage current is defined in the leakage current table with Px.y/Ax parameter.

(2) The analog input voltage range must be within the selected reference voltage range V<sub>R+</sub> to V<sub>R-</sub> for valid conversion results.

(3) The internal reference supply current is not included in current consumption parameter I<sub>ADC10</sub>.

(4) The internal reference current is supplied through terminal V<sub>CC</sub>. Consumption is independent of the ADC10ON control bit, unless a conversion is active. The REFON bit enables the built-in reference to settle before starting an A/D conversion.

### 5.30 10-Bit ADC, Built-In Voltage Reference (MSP430G2x33 Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                                           | TEST CONDITIONS                                                                                                      | V <sub>CC</sub> | MIN  | TYP | MAX  | UNIT   |
|-----------------------|-----------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|-----------------|------|-----|------|--------|
| V <sub>CC,REF+</sub>  | Positive built-in reference analog supply voltage range   | I <sub>VREF+</sub> ≤ 1 mA, REF2_5V = 0                                                                               |                 | 2.2  |     |      | V      |
|                       |                                                           | I <sub>VREF+</sub> ≤ 1 mA, REF2_5V = 1                                                                               |                 | 2.9  |     |      |        |
| V <sub>REF+</sub>     | Positive built-in reference voltage                       | I <sub>VREF+</sub> ≤ I <sub>VREF+</sub> max, REF2_5V = 0                                                             | 3 V             | 1.41 | 1.5 | 1.59 | V      |
|                       |                                                           | I <sub>VREF+</sub> ≤ I <sub>VREF+</sub> max, REF2_5V = 1                                                             |                 | 2.35 | 2.5 | 2.65 |        |
| I <sub>LD,VREF+</sub> | Maximum VREF+ load current                                |                                                                                                                      | 3 V             | ±1   |     |      | mA     |
|                       | VREF+ load regulation                                     | I <sub>VREF+</sub> = 500 μA ±100 μA, Analog input voltage V <sub>AX</sub> ≈ 0.75 V, REF2_5V = 0                      | 3 V             | ±2   |     |      | LSB    |
|                       |                                                           | I <sub>VREF+</sub> = 500 μA ±100 μA, Analog input voltage V <sub>AX</sub> ≈ 1.25 V, REF2_5V = 1                      |                 | ±2   |     |      |        |
|                       | V <sub>REF+</sub> load regulation response time           | I <sub>VREF+</sub> = 100 μA → 900 μA, V <sub>AX</sub> ≈ 0.5 × VREF+, Error of conversion result ≤ 1 LSB, ADC10SR = 0 | 3 V             | 400  |     |      | ns     |
| C <sub>VREF+</sub>    | Maximum capacitance at pin VREF+                          | I <sub>VREF+</sub> ≤ ±1 mA, REFON = 1, REFOUT = 1                                                                    | 3 V             | 100  |     |      | pF     |
| TC <sub>REF+</sub>    | Temperature coefficient                                   | I <sub>VREF+</sub> = const with 0 mA ≤ I <sub>VREF+</sub> ≤ 1 mA                                                     | 3 V             | ±100 |     |      | ppm/°C |
| t <sub>REFON</sub>    | Settling time of internal reference voltage to 99.9% VREF | I <sub>VREF+</sub> = 0.5 mA, REF2_5V = 0, REFON = 0 → 1                                                              | 3.6 V           | 30   |     |      | μs     |
| t <sub>REFBURST</sub> | Settling time of reference buffer to 99.9% VREF           | I <sub>VREF+</sub> = 0.5 mA, REF2_5V = 1, REFON = 1, REFBURST = 1, ADC10SR = 0                                       | 3 V             | 2    |     |      | μs     |



### 5.31 10-Bit ADC, External Reference<sup>(1)</sup> (MSP430G2x33 Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                          | TEST CONDITIONS                                                                   | V <sub>CC</sub> | MIN | TYP | MAX             | UNIT |
|------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------|-----------------|-----|-----|-----------------|------|
| VEREF+ Positive external reference input voltage range <sup>(2)</sup>              | VEREF+ > VREF–, SREF1 = 1, SREF0 = 0                                              |                 | 1.4 |     | V <sub>CC</sub> | V    |
|                                                                                    | VEREF– ≤ VREF+ ≤ V <sub>CC</sub> – 0.15 V, SREF1 = 1, SREF0 = 1 <sup>(3)</sup>    |                 | 1.4 |     | 3               |      |
| VEREF– Negative external reference input voltage range <sup>(4)</sup>              | VEREF+ > VREF–                                                                    |                 | 0   |     | 1.2             | V    |
| ΔVEREF Differential external reference input voltage range, ΔVEREF = VREF+ – VREF– | VEREF+ > VREF– <sup>(5)</sup>                                                     |                 | 1.4 |     | V <sub>CC</sub> | V    |
| I <sub>VEREF+</sub> Static input current into VREF+                                | 0 V ≤ VREF+ ≤ V <sub>CC</sub> , SREF1 = 1, SREF0 = 0                              | 3 V             |     | ±1  |                 | μA   |
|                                                                                    | 0 V ≤ VREF+ ≤ V <sub>CC</sub> – 0.15 V ≤ 3 V, SREF1 = 1, SREF0 = 1 <sup>(3)</sup> | 3 V             |     | 0   |                 |      |
| I <sub>VEREF–</sub> Static input current into VREF–                                | 0 V ≤ VREF– ≤ V <sub>CC</sub>                                                     | 3 V             |     | ±1  |                 | μA   |

- (1) The external reference is used during conversion to charge and discharge the capacitance array. The input capacitance, C<sub>i</sub>, is also the dynamic load for an external reference during conversion. The dynamic impedance of the reference supply should follow the recommendations on analog-source impedance to allow the charge to settle for 10-bit accuracy.
- (2) The accuracy limits the minimum positive external reference voltage. Lower reference voltage levels may be applied with reduced accuracy requirements.
- (3) Under this condition, the external reference is internally buffered. The reference buffer is active and requires the reference buffer supply current I<sub>REFB</sub>. The current consumption can be limited to the sample and conversion period with REBURST = 1.
- (4) The accuracy limits the maximum negative external reference voltage. Higher reference voltage levels may be applied with reduced accuracy requirements.
- (5) The accuracy limits the minimum external differential reference voltage. Lower differential reference voltage levels may be applied with reduced accuracy requirements.

### 5.32 10-Bit ADC, Timing Parameters (MSP430G2x33 Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                 | TEST CONDITIONS                                                                             | V <sub>CC</sub> | MIN  | TYP                                             | MAX        | UNIT |
|-----------------------------------------------------------|---------------------------------------------------------------------------------------------|-----------------|------|-------------------------------------------------|------------|------|
| f <sub>ADC10CLK</sub> ADC10 input clock frequency         | For specified performance of ADC10 linearity parameters<br>ADC10SR = 0<br>ADC10SR = 1       | 3 V             | 0.45 |                                                 | 6.3<br>1.5 | MHz  |
| f <sub>ADC10OSC</sub> ADC10 built-in oscillator frequency | ADC10DIVx = 0, ADC10SSELx = 0,<br>f <sub>ADC10CLK</sub> = f <sub>ADC10OSC</sub>             | 3 V             | 3.7  |                                                 | 6.3        |      |
| t <sub>CONVERT</sub> Conversion time                      | ADC10 built-in oscillator, ADC10SSELx = 0,<br>f <sub>ADC10CLK</sub> = f <sub>ADC10OSC</sub> | 3 V             | 2.06 |                                                 | 3.51       | μs   |
|                                                           | f <sub>ADC10CLK</sub> from ACLK, MCLK, or SMCLK:<br>ADC10SSELx ≠ 0                          |                 |      | 13 ×<br>ADC10DIV ×<br>1 / f <sub>ADC10CLK</sub> |            |      |
| t <sub>ADC10ON</sub> Turnon settling time of the ADC      | (1)                                                                                         |                 |      |                                                 | 100        | ns   |

- (1) The condition is that the error in a conversion started after t<sub>ADC10ON</sub> is less than ±0.5 LSB. The reference and input signal are already settled.

### 5.33 10-Bit ADC, Linearity Parameters (MSP430G2x33 Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                   | TEST CONDITIONS                         | V <sub>CC</sub> | MIN | TYP  | MAX | UNIT |
|---------------------------------------------|-----------------------------------------|-----------------|-----|------|-----|------|
| E <sub>I</sub> Integral linearity error     |                                         | 3 V             |     |      | ±1  | LSB  |
| E <sub>D</sub> Differential linearity error |                                         | 3 V             |     |      | ±1  | LSB  |
| E <sub>O</sub> Offset error                 | Source impedance R <sub>S</sub> < 100 Ω | 3 V             |     |      | ±1  | LSB  |
| E <sub>G</sub> Gain error                   |                                         | 3 V             |     | ±1.1 | ±2  | LSB  |
| E <sub>T</sub> Total unadjusted error       |                                         | 3 V             |     | ±2   | ±5  | LSB  |

### 5.34 10-Bit ADC, Temperature Sensor and Built-In $V_{MID}$ (MSP430G2x33 Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                          | TEST CONDITIONS                                                   | $V_{CC}$ | MIN  | TYP  | MAX            | UNIT                 |
|------------------------------------------------------------------------------------|-------------------------------------------------------------------|----------|------|------|----------------|----------------------|
| $I_{SENSOR}$ Temperature sensor supply current <sup>(1)</sup>                      | REFON = 0, INCHx = 0Ah, $T_A = 25^\circ\text{C}$                  | 3 V      |      | 60   |                | $\mu\text{A}$        |
| $TC_{SENSOR}$                                                                      | ADC10ON = 1, INCHx = 0Ah <sup>(2)</sup>                           | 3 V      |      | 3.55 |                | mV/ $^\circ\text{C}$ |
| $t_{Sensor(sample)}$ Sample time required if channel 10 is selected <sup>(3)</sup> | ADC10ON = 1, INCHx = 0Ah, Error of conversion result $\leq 1$ LSB | 3 V      | 30   |      |                | $\mu\text{s}$        |
| $I_{VMID}$ Current into divider at channel 11                                      | ADC10ON = 1, INCHx = 0Bh                                          | 3 V      |      |      | <sup>(4)</sup> | $\mu\text{A}$        |
| $V_{MID}$ $V_{CC}$ divider at channel 11                                           | ADC10ON = 1, INCHx = 0Bh, $V_{MID} \approx 0.5 \times V_{CC}$     | 3 V      |      | 1.5  |                | V                    |
| $t_{VMID(sample)}$ Sample time required if channel 11 is selected <sup>(5)</sup>   | ADC10ON = 1, INCHx = 0Bh, Error of conversion result $\leq 1$ LSB | 3 V      | 1220 |      |                | ns                   |

- (1) The sensor current  $I_{SENSOR}$  is consumed if (ADC10ON = 1 and REFON = 1) or (ADC10ON = 1 and INCH = 0Ah and sample signal is high). When REFON = 1,  $I_{SENSOR}$  is included in  $I_{REF+}$ . When REFON = 0,  $I_{SENSOR}$  applies during conversion of the temperature sensor input (INCH = 0Ah).
- (2) The following formula can be used to calculate the temperature sensor output voltage:  
 $V_{Sensor,typ} = TC_{Sensor} (273 + T [^\circ\text{C}]) + V_{Offset,sensor} [\text{mV}]$  or  
 $V_{Sensor,typ} = TC_{Sensor} T [^\circ\text{C}] + V_{Sensor}(T_A = 0^\circ\text{C}) [\text{mV}]$
- (3) The typical equivalent impedance of the sensor is 51 k $\Omega$ . The sample time required includes the sensor-on time  $t_{SENSOR(on)}$ .
- (4) No additional current is needed. The  $V_{MID}$  is used during sampling.
- (5) The on-time  $t_{VMID(on)}$  is included in the sampling time  $t_{VMID(sample)}$ ; no additional on time is needed.

### 5.35 Flash Memory

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                             | TEST CONDITIONS          | $V_{CC}$     | MIN    | TYP    | MAX | UNIT      |
|-----------------------------------------------------------------------|--------------------------|--------------|--------|--------|-----|-----------|
| $V_{CC(PGM/ERASE)}$ Program and erase supply voltage                  |                          |              | 2.2    |        | 3.6 | V         |
| $f_{FTG}$ Flash timing generator frequency                            |                          |              | 257    |        | 476 | kHz       |
| $I_{PGM}$ Supply current from $V_{CC}$ during program                 |                          | 2.2 V, 3.6 V |        | 1      | 5   | mA        |
| $I_{ERASE}$ Supply current from $V_{CC}$ during erase                 |                          | 2.2 V, 3.6 V |        | 1      | 7   | mA        |
| $t_{CPT}$ Cumulative program time <sup>(1)</sup>                      |                          | 2.2 V, 3.6 V |        |        | 10  | ms        |
| $t_{CMErase}$ Cumulative mass erase time                              |                          | 2.2 V, 3.6 V | 20     |        |     | ms        |
| Program and erase endurance                                           |                          |              | $10^4$ | $10^5$ |     | cycles    |
| $t_{Retention}$ Data retention duration                               | $T_J = 25^\circ\text{C}$ |              | 100    |        |     | years     |
| $t_{Word}$ Word or byte program time                                  | See <sup>(2)</sup>       |              |        | 30     |     | $t_{FTG}$ |
| $t_{Block, 0}$ Block program time for first byte or word              | See <sup>(2)</sup>       |              |        | 25     |     | $t_{FTG}$ |
| $t_{Block, 1-63}$ Block program time for each additional byte or word | See <sup>(2)</sup>       |              |        | 18     |     | $t_{FTG}$ |
| $t_{Block, End}$ Block program end-sequence wait time                 | See <sup>(2)</sup>       |              |        | 6      |     | $t_{FTG}$ |
| $t_{Mass Erase}$ Mass erase time                                      | See <sup>(2)</sup>       |              |        | 10593  |     | $t_{FTG}$ |
| $t_{Seg Erase}$ Segment erase time                                    | See <sup>(2)</sup>       |              |        | 4819   |     | $t_{FTG}$ |

- (1) Do not exceed the cumulative program time when writing to a 64-byte flash block. This parameter applies to all programming methods: individual word or byte write and block write modes.
- (2) These values are hardwired into the state machine of the flash controller ( $t_{FTG} = 1/f_{FTG}$ ).

### 5.36 RAM

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                | TEST CONDITIONS | MIN | MAX | UNIT |
|----------------------------------------------------------|-----------------|-----|-----|------|
| $V_{(RAMh)}$ RAM retention supply voltage <sup>(1)</sup> | CPU halted      | 1.6 |     | V    |

- (1) This parameter defines the minimum supply voltage  $V_{CC}$  when the data in RAM remains unchanged. No program execution should happen during this supply voltage condition.

### 5.37 JTAG and Spy-Bi-Wire Interface

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                                             | $V_{CC}$ | MIN   | TYP | MAX | UNIT       |
|-------------------------------------------------------------------------------------------------------|----------|-------|-----|-----|------------|
| $f_{SBW}$ Spy-Bi-Wire input frequency                                                                 | 2.2 V    | 0     |     | 20  | MHz        |
| $t_{SBW,Low}$ Spy-Bi-Wire low clock pulse duration                                                    | 2.2 V    | 0.025 |     | 15  | $\mu$ s    |
| $t_{SBW,En}$ Spy-Bi-Wire enable time<br>(TEST high to acceptance of first clock edge <sup>(1)</sup> ) | 2.2 V    |       |     | 1   | $\mu$ s    |
| $t_{SBW,Ret}$ Spy-Bi-Wire return to normal operation time                                             | 2.2 V    | 15    |     | 100 | $\mu$ s    |
| $f_{TCK}$ TCK input frequency <sup>(2)</sup>                                                          | 2.2 V    | 0     |     | 5   | MHz        |
| $R_{Internal}$ Internal pulldown resistance on TEST                                                   | 2.2 V    | 25    | 60  | 90  | k $\Omega$ |

- (1) Tools that access the Spy-Bi-Wire interface must wait for the maximum  $t_{SBW,En}$  time after pulling the TEST/SBWCLK pin high before applying the first SBWCLK clock edge.
- (2)  $f_{TCK}$  may be restricted to meet the timing requirements of the module selected.

### 5.38 JTAG Fuse <sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                              | TEST CONDITIONS          | MIN | MAX | UNIT |
|--------------------------------------------------------|--------------------------|-----|-----|------|
| $V_{CC(FB)}$ Supply voltage during fuse-blow condition | $T_A = 25^\circ\text{C}$ | 2.5 |     | V    |
| $V_{FB}$ Voltage level on TEST for fuse blow           |                          | 6   | 7   | V    |
| $I_{FB}$ Supply current into TEST during fuse blow     |                          |     | 100 | mA   |
| $t_{FB}$ Time to blow fuse                             |                          |     | 1   | ms   |

- (1) After the fuse is blown, no further access to the JTAG/Test, Spy-Bi-Wire, and emulation features is possible, and JTAG is switched to bypass mode.

## 6 Detailed Description

### 6.1 CPU

The MSP430 CPU has a 16-bit RISC architecture that is highly transparent to the application. All operations, other than program-flow instructions, are performed as register operations in conjunction with seven addressing modes for source operand and four addressing modes for destination operand.

The CPU is integrated with 16 registers that provide reduced instruction execution time. The register-to-register operation execution time is one cycle of the CPU clock. Four of the registers, R0 to R3, are dedicated as program counter, stack pointer, status register, and constant generator, respectively. The remaining registers are general-purpose registers (see [Figure 6-1](#)).

Peripherals are connected to the CPU using data, address, and control buses, and can be handled with all instructions.

The instruction set consists of the original 51 instructions with three formats and seven address modes and additional instructions for the expanded address range. Each instruction can operate on word and byte data.

|                          |           |
|--------------------------|-----------|
| Program Counter          | PC/R0     |
| Stack Pointer            | SP/R1     |
| Status Register          | SR/CG1/R2 |
| Constant Generator       | CG2/R3    |
| General-Purpose Register | R4        |
| General-Purpose Register | R5        |
| General-Purpose Register | R6        |
| General-Purpose Register | R7        |
| General-Purpose Register | R8        |
| General-Purpose Register | R9        |
| General-Purpose Register | R10       |
| General-Purpose Register | R11       |
| General-Purpose Register | R12       |
| General-Purpose Register | R13       |
| General-Purpose Register | R14       |
| General-Purpose Register | R15       |

**Figure 6-1. Integrated CPU Registers**

## 6.2 Instruction Set

The instruction set consists of 51 instructions with three formats and seven address modes. Each instruction can operate on word and byte data. [Table 6-1](#) lists examples of the three types of instruction formats. [Table 6-2](#) lists the address modes.

**Table 6-1. Instruction Word Formats**

| INSTRUCTION FORMAT                          | EXAMPLE   | OPERATION                                 |
|---------------------------------------------|-----------|-------------------------------------------|
| Dual operands, source-destination           | ADD R4,R5 | $R4 + R5 \rightarrow R5$                  |
| Single operands, destination only           | CALL R8   | $PC \rightarrow (TOS), R8 \rightarrow PC$ |
| Relative jump, unconditional or conditional | JNE       | Jump-on-equal bit = 0                     |

**Table 6-2. Address Mode Descriptions**

| ADDRESS MODE           | S <sup>(1)</sup> | D | SYNTAX          | EXAMPLE          | OPERATION                                             |
|------------------------|------------------|---|-----------------|------------------|-------------------------------------------------------|
| Register               | ✓                | ✓ | MOV Rs,Rd       | MOV R10,R11      | $R10 \rightarrow R11$                                 |
| Indexed                | ✓                | ✓ | MOV X(Rn),Y(Rm) | MOV 2(R5),6(R6)  | $M(2+R5) \rightarrow M(6+R6)$                         |
| Symbolic (PC relative) | ✓                | ✓ | MOV EDE,TONI    |                  | $M(EDE) \rightarrow M(TONI)$                          |
| Absolute               | ✓                | ✓ | MOV &MEM,&TCDAT |                  | $M(MEM) \rightarrow M(TCDAT)$                         |
| Indirect               | ✓                |   | MOV @Rn,Y(Rm)   | MOV @R10,Tab(R6) | $M(R10) \rightarrow M(Tab+R6)$                        |
| Indirect autoincrement | ✓                |   | MOV @Rn+,Rm     | MOV @R10+,R11    | $M(R10) \rightarrow R11$<br>$R10 + 2 \rightarrow R10$ |
| Immediate              | ✓                |   | MOV #X,TONI     | MOV #45,TONI     | $\#45 \rightarrow M(TONI)$                            |

(1) S = source, D = destination

## 6.3 Operating Modes

These microcontrollers have one active mode and five software-selectable low-power modes of operation. An interrupt event can wake the device from any of the low-power modes, service the request, and restore back to the low-power mode on return from the interrupt program.

Software can configure the following operating modes:

- Active mode (AM)
  - All clocks are active
- Low-power mode 0 (LPM0)
  - CPU is disabled
  - ACLK and SMCLK remain active, MCLK is disabled
- Low-power mode 1 (LPM1)
  - CPU is disabled
  - ACLK and SMCLK remain active, MCLK is disabled
  - DC generator of the DCO is disabled if DCO not used in active mode
- Low-power mode 2 (LPM2)
  - CPU is disabled
  - MCLK and SMCLK are disabled
  - DC generator of the DCO remains enabled
  - ACLK remains active
- Low-power mode 3 (LPM3)
  - CPU is disabled
  - MCLK and SMCLK are disabled
  - DC generator of the DCO is disabled
  - ACLK remains active
- Low-power mode 4 (LPM4)
  - CPU is disabled
  - ACLK is disabled
  - MCLK and SMCLK are disabled
  - DC generator of the DCO is disabled
  - Crystal oscillator is stopped

## 6.4 Interrupt Vector Addresses

The interrupt vectors and the power-up starting address are in the address range 0FFFFh to 0FFC0h (see [Table 6-3](#)). The vector contains the 16-bit address of the appropriate interrupt handler instruction sequence.

If the reset vector (at address 0FFFEh) contains 0FFFFh (for example, if the flash is not programmed), the CPU goes into LPM4 immediately after power-up.

**Table 6-3. Interrupt Sources, Flags, and Vectors**

| INTERRUPT SOURCE                                                                                       | INTERRUPT FLAG                                    | SYSTEM INTERRUPT                                                  | WORD ADDRESS     | PRIORITY        |
|--------------------------------------------------------------------------------------------------------|---------------------------------------------------|-------------------------------------------------------------------|------------------|-----------------|
| Power up<br>External reset<br>Watchdog Timer+<br>Flash key violation<br>PC out of range <sup>(1)</sup> | PORIFG<br>RSTIFG<br>WDTIFG<br>KEYV <sup>(2)</sup> | Reset                                                             | 0FFFEh           | 31, highest     |
| NMI<br>Oscillator fault<br>Flash memory access violation                                               | NMIIFG<br>OFIFG<br>ACCVIFG <sup>(2)</sup>         | (non)-maskable <sup>(3)</sup><br>(non)-maskable<br>(non)-maskable | 0FFFCh           | 30              |
| Timer1_A3                                                                                              | TACCR0 CCIFG <sup>(4)</sup>                       | maskable                                                          | 0FFFAh           | 29              |
| Timer1_A3                                                                                              | TACCR2 TACCR1 CCIFG, TAIFG <sup>(2)(4)</sup>      | maskable                                                          | 0FFF8h           | 28              |
|                                                                                                        |                                                   |                                                                   | 0FFF6h           | 27              |
| Watchdog Timer+                                                                                        | WDTIFG                                            | maskable                                                          | 0FFF4h           | 26              |
| Timer0_A3                                                                                              | TACCR0 CCIFG <sup>(4)</sup>                       | maskable                                                          | 0FFF2h           | 25              |
| Timer0_A3                                                                                              | TACCR2 TACCR1 CCIFG, TAIFG <sup>(5)(4)</sup>      | maskable                                                          | 0FFF0h           | 24              |
| USCI_A0, USCI_B0 receive<br>USCI_B0 I <sup>2</sup> C status                                            | UCA0RXIFG, UCB0RXIFG <sup>(2)(5)</sup>            | maskable                                                          | 0FFEEh           | 23              |
| USCI_A0, USCI_B0 transmit<br>USCI_B0 I <sup>2</sup> C receive or transmit                              | UCA0TXIFG, UCB0TXIFG <sup>(2)(6)</sup>            | maskable                                                          | 0FFECh           | 22              |
| ADC10<br>(MSP430G2x33 only)                                                                            | ADC10IFG <sup>(4)</sup>                           | maskable                                                          | 0FFEAh           | 21              |
|                                                                                                        |                                                   |                                                                   | 0FFE8h           | 20              |
| I/O Port P2 (up to eight flags)                                                                        | P2IFG.0 to P2IFG.7 <sup>(2)(4)</sup>              | maskable                                                          | 0FFE6h           | 19              |
| I/O Port P1 (up to eight flags)                                                                        | P1IFG.0 to P1IFG.7 <sup>(2)(4)</sup>              | maskable                                                          | 0FFE4h           | 18              |
|                                                                                                        |                                                   |                                                                   | 0FFE2h           | 17              |
|                                                                                                        |                                                   |                                                                   | 0FFE0h           | 16              |
| See <sup>(7)</sup>                                                                                     |                                                   |                                                                   | 0FFDEh           | 15              |
| See <sup>(8)</sup>                                                                                     |                                                   |                                                                   | 0FFDEh to 0FFC0h | 14 to 0, lowest |

(1) A reset is generated if the CPU tries to fetch instructions from within the module register memory address range (0h to 01FFh) or from within unused address ranges.

(2) Multiple source flags

(3) (non)-maskable: the individual interrupt-enable bit can disable an interrupt event, but the general interrupt enable cannot.

(4) Interrupt flags are in the module.

(5) In SPI mode: UCB0RXIFG. In I<sup>2</sup>C mode: UCA0IFG, UCNACKIFG, ICSTTIFG, UCSTPIFG.

(6) In UART or SPI mode: UCB0TXIFG. In I<sup>2</sup>C mode: UCB0RXIFG, UCB0TXIFG.

(7) This location is used as bootloader security key (BSLSKEY). A 0xAA55 at this location disables the BSL completely. A zero (0h) disables the erasure of the flash if an invalid password is supplied.

(8) The interrupt vectors at addresses 0FFDEh to 0FFC0h are not used in this device and can be used for regular program code if necessary.

## 6.5 Special Function Registers (SFRs)

Most interrupt and module enable bits are collected into the lowest address space. Special function register bits not allocated to a functional purpose are not physically present in the device. Simple software access is provided with this arrangement.

### Legend

|                                                                                   |                                                         |
|-----------------------------------------------------------------------------------|---------------------------------------------------------|
| rw                                                                                | Bit can be read and written.                            |
| rw-0, rw-1                                                                        | Bit can be read and written. It is reset or set by PUC. |
| rw-(0), rw-(1)                                                                    | Bit can be read and written. It is reset or set by POR. |
|  | SFR bit is not present in device.                       |

**Figure 6-2. Interrupt Enable Register 1 (Address = 00h)**

| 7 | 6 | 5      | 4     | 3 | 2 | 1    | 0     |
|---|---|--------|-------|---|---|------|-------|
|   |   | ACCVIE | NMIIE |   |   | OFIE | WDTIE |
|   |   | rw-0   | rw-0  |   |   | rw-0 | rw-0  |

**Table 6-4. Interrupt Enable Register 1 Description**

| Bit | Field  | Type | Reset | Description                                                                                                                            |
|-----|--------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------|
| 5   | ACCVIE | RW   | 0h    | Flash access violation interrupt enable                                                                                                |
| 4   | NMIIE  | RW   | 0h    | (Non)maskable interrupt enable                                                                                                         |
| 1   | OFIE   | RW   | 0h    | Oscillator fault interrupt enable                                                                                                      |
| 0   | WDTIE  | RW   | 0h    | Watchdog Timer interrupt enable. Inactive if watchdog mode is selected. Active if Watchdog Timer is configured in interval timer mode. |

**Figure 6-3. Interrupt Enable Register 2 (Address = 01h)**

| 7 | 6 | 5 | 4 | 3        | 2        | 1        | 0        |
|---|---|---|---|----------|----------|----------|----------|
|   |   |   |   | UCB0TXIE | UCB0RXIE | UCA0TXIE | UCA0RXIE |
|   |   |   |   | rw-0     | rw-0     | rw-0     | rw-0     |

**Table 6-5. Interrupt Enable Register 2 Description**

| Bit | Field    | Type | Reset | Description                       |
|-----|----------|------|-------|-----------------------------------|
| 3   | UCB0TXIE | RW   | 0h    | USCI_B0 transmit interrupt enable |
| 2   | UCB0RXIE | RW   | 0h    | USCI_B0 receive interrupt enable  |
| 1   | UCA0TXIE | RW   | 0h    | USCI_A0 transmit interrupt enable |
| 0   | UCA0RXIE | RW   | 0h    | USCI_A0 receive interrupt enable  |

**Figure 6-4. Interrupt Flag Register 1 (Address = 02h)**

| 7 | 6 | 5 | 4      | 3      | 2      | 1     | 0      |
|---|---|---|--------|--------|--------|-------|--------|
|   |   |   | NMIIFG | RSTIFG | PORIFG | OFIFG | WDTIFG |
|   |   |   | rw-0   | rw-(0) | rw-(1) | rw-1  | rw-(0) |

**Table 6-6. Interrupt Flag Register 1 Description**

| Bit | Field  | Type | Reset | Description                                                                                                                                                                         |
|-----|--------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4   | NMIIFG | RW   | 0h    | Set by the $\overline{\text{RST}}$ /NMI pin                                                                                                                                         |
| 3   | RSTIFG | RW   | 0h    | External reset interrupt flag. Set on a reset condition at $\overline{\text{RST}}$ /NMI pin in reset mode. Reset on $V_{CC}$ power-up.                                              |
| 2   | PORIFG | RW   | 1h    | Power-On Reset interrupt flag. Set on $V_{CC}$ power-up.                                                                                                                            |
| 1   | OFIFG  | RW   | 1h    | Flag set on oscillator fault.                                                                                                                                                       |
| 0   | WDTIFG | RW   | 0h    | Set on watchdog timer overflow (in watchdog mode) or security key violation. Reset on $V_{CC}$ power-on or a reset condition at the $\overline{\text{RST}}$ /NMI pin in reset mode. |



**Figure 6-5. Interrupt Flag Register 2 (Address = 03h)**

| 7 | 6 | 5 | 4 | 3         | 2         | 1         | 0         |
|---|---|---|---|-----------|-----------|-----------|-----------|
|   |   |   |   | UCB0TXIFG | UCB0RXIFG | UCA0TXIFG | UCA0RXIFG |
|   |   |   |   | rw-1      | rw-0      | rw-1      | rw-0      |

**Table 6-7. Interrupt Flag Register 2 Description**

| Bit | Field     | Type | Reset | Description                     |
|-----|-----------|------|-------|---------------------------------|
| 3   | UCB0TXIFG | RW   | 0h    | USCI_B0 transmit interrupt flag |
| 2   | UCB0RXIFG | RW   | 1h    | USCI_B0 receive interrupt flag  |
| 1   | UCA0TXIFG | RW   | 1h    | USCI_A0 transmit interrupt flag |
| 0   | UCA0RXIFG | RW   | 0h    | USCI_A0 receive interrupt flag  |

## 6.6 Memory Organization

Table 6-8 summarizes the memory map.

**Table 6-8. Memory Organization**

|                        |           | MSP430G2233<br>MSP430G2203 | MSP430G2333<br>MSP430G2303 | MSP430G2433<br>MSP430G2403 | MSP430G2533      |
|------------------------|-----------|----------------------------|----------------------------|----------------------------|------------------|
| Memory                 | Size      | 2KB                        | 4KB                        | 8KB                        | 16KB             |
| Main: interrupt vector | Flash     | FFFFh to FFC0h             | FFFFh to FFC0h             | FFFFh to FFC0h             | FFFFh to FFC0h   |
| Main: code memory      | Flash     | FFFFh to F800h             | FFFFh to F000h             | FFFFh to E000h             | FFFFh to C000h   |
| Information memory     | Size      | 256 byte                   | 256 byte                   | 256 byte                   | 256 byte         |
|                        | Flash     | 010FFh to 01000h           | 010FFh to 01000h           | 010FFh to 01000h           | 010FFh to 01000h |
| RAM                    | Size      | 256 byte                   | 256 byte                   | 512 byte                   | 512 byte         |
|                        |           | 02FFh to 0200h             | 02FFh to 0200h             | 03FFh to 0200h             | 03FFh to 0200h   |
| Peripherals            | 16-bit    | 01FFh to 0100h             | 01FFh to 0100h             | 01FFh to 0100h             | 01FFh to 0100h   |
|                        | 8-bit     | 0FFh to 010h               | 0FFh to 010h               | 0FFh to 010h               | 0FFh to 010h     |
|                        | 8-bit SFR | 0Fh to 00h                 | 0Fh to 00h                 | 0Fh to 00h                 | 0Fh to 00h       |

## 6.7 Bootloader (BSL)

The MSP430 BSL enables users to program the flash memory or RAM using a UART serial interface. Access to the MSP430 memory through the BSL is protected by user-defined password. For complete description of the features of the BSL and its implementation, see the *MSP430 Programming With the Bootloader User's Guide* (SLAU319). Table 6-9 lists the BSL function pins.

**Table 6-9. BSL Function Pins**

| BSL FUNCTION  | 20-PIN PW PACKAGE<br>20-PIN N PACKAGE | 28-PIN PW PACKAGE | 32-PIN RHB PACKAGE |
|---------------|---------------------------------------|-------------------|--------------------|
| Data transmit | 3 - P1.1                              | 3 - P1.1          | 1 - P1.1           |
| Data receive  | 7 - P1.5                              | 7 - P1.5          | 5 - P1.5           |

## 6.8 Flash Memory

The flash memory can be programmed through the Spy-Bi-Wire/JTAG port or in-system by the CPU. The CPU can perform single-byte and single-word writes to the flash memory. Features of the flash memory include:

- Flash memory has  $n$  segments of main memory and four segments of information memory (A to D) of 64 bytes each. Each segment in main memory is 512 bytes in size.
- Segments 0 to  $n$  may be erased in one step, or each segment may be individually erased.
- Segments A to D can be erased individually or as a group with segments 0 to  $n$ . Segments A to D are also called *information memory*.
- Segment A contains calibration data. After reset segment A is protected against programming and erasing. It can be unlocked but care should be taken not to erase this segment if the device-specific calibration data is required.

## 6.9 Peripherals

Peripherals are connected to the CPU through data, address, and control buses. The peripherals can be managed using all instructions. For complete module descriptions, see the *MSP430x2xx Family User's Guide* ([SLAU144](#)).

### 6.9.1 Oscillator and System Clock

The clock system is supported by the basic clock module that includes support for a 32768-Hz watch crystal oscillator, an internal very-low-power low-frequency oscillator and an internal digitally controlled oscillator (DCO). The basic clock module is designed to meet the requirements of both low system cost and low power consumption. The internal DCO provides a fast turnon clock source and stabilizes in less than 1  $\mu$ s. The basic clock module provides the following clock signals:

- Auxiliary clock (ACLK), sourced either from a 32768-Hz watch crystal or the internal LF oscillator.
- Main clock (MCLK), the system clock used by the CPU.
- Sub-Main clock (SMCLK), the subsystem clock used by the peripheral modules.

The DCO settings to calibrate the DCO output frequency are stored in the information memory segment A.

### 6.9.2 Calibration Data Stored in Information Memory Segment A

Calibration data is stored for both the DCO and for ADC10 organized in a tag-length-value structure (see [Table 6-10](#) and [Table 6-11](#)).

**Table 6-10. Tags Used by the ADC Calibration Tags**

| NAME        | ADDRESS | VALUE | DESCRIPTION                                                                     |
|-------------|---------|-------|---------------------------------------------------------------------------------|
| TAG_DCO_30  | 0x10F6  | 0x01  | DCO frequency calibration at $V_{CC} = 3\text{ V}$ and $T_A = 30^\circ\text{C}$ |
| TAG_ADC10_1 | 0x10DA  | 0x10  | ADC10_1 calibration tag                                                         |
| TAG_EMPTY   | –       | 0xFE  | Identifier for empty memory areas                                               |

**Table 6-11. Labels Used by the ADC Calibration Tags**

| LABEL                 | ADDRESS OFFSET | SIZE | CONDITION AT CALIBRATION                                           |
|-----------------------|----------------|------|--------------------------------------------------------------------|
| CAL_ADC_25T85         | 0x0010         | word | INCHx = 1010b, REF2_5 = 1, $T_A = 85^\circ\text{C}$                |
| CAL_ADC_25T30         | 0x000E         | word | INCHx = 1010b, REF2_5 = 1, $T_A = 30^\circ\text{C}$                |
| CAL_ADC_25VREF_FACTOR | 0x000C         | word | REF2_5 = 1, $T_A = 30^\circ\text{C}$ , $I_{VREF+} = 1\text{ mA}$   |
| CAL_ADC_15T85         | 0x000A         | word | INCHx = 1010b, REF2_5 = 0, $T_A = 85^\circ\text{C}$                |
| CAL_ADC_15T30         | 0x0008         | word | INCHx = 1010b, REF2_5 = 0, $T_A = 30^\circ\text{C}$                |
| CAL_ADC_15VREF_FACTOR | 0x0006         | word | REF2_5 = 0, $T_A = 30^\circ\text{C}$ , $I_{VREF+} = 0.5\text{ mA}$ |
| CAL_ADC_OFFSET        | 0x0004         | word | External VREF = 1.5 V, $f_{ADC10CLK} = 5\text{ MHz}$               |
| CAL_ADC_GAIN_FACTOR   | 0x0002         | word | External VREF = 1.5 V, $f_{ADC10CLK} = 5\text{ MHz}$               |
| CAL_BC1_1MHZ          | 0x0009         | byte | –                                                                  |
| CAL_DCO_1MHZ          | 0x0008         | byte | –                                                                  |
| CAL_BC1_8MHZ          | 0x0007         | byte | –                                                                  |
| CAL_DCO_8MHZ          | 0x0006         | byte | –                                                                  |
| CAL_BC1_12MHZ         | 0x0005         | byte | –                                                                  |
| CAL_DCO_12MHZ         | 0x0004         | byte | –                                                                  |
| CAL_BC1_16MHZ         | 0x0003         | byte | –                                                                  |
| CAL_DCO_16MHZ         | 0x0002         | byte | –                                                                  |

### 6.9.3 Brownout

The brownout circuit is implemented to provide the proper internal reset signal to the device during power on and power off.

### 6.9.4 Digital I/O

Up to three 8-bit I/O ports are implemented:

- All individual I/O bits are independently programmable.
- Any combination of input, output, and interrupt condition (port P1 and port P2 only) is possible.
- Edge-selectable interrupt input capability for all bits of port P1 and port P2 (if available).
- Read/write access to port-control registers is supported by all instructions.
- Each I/O has an individually programmable pullup or pulldown resistor.
- Each I/O has an individually programmable pin oscillator enable bit to enable low-cost capacitive touch detection.

## 6.9.5 WDT+ Watchdog Timer

The primary function of the watchdog timer (WDT+) module is to perform a controlled system restart after a software problem occurs. If the selected time interval expires, a system reset is generated. If the watchdog function is not needed in an application, the module can be disabled or configured as an interval timer and can generate interrupts at selected time intervals.

## 6.9.6 Timer\_A3 (TA0, TA1)

Timer0\_A3 and Timer1\_A3 are 16-bit timers/counters with three capture/compare registers. Timer\_A3 can support multiple capture/compares, PWM outputs, and interval timing (see [Table 6-12](#) and [Table 6-13](#)). Timer\_A3 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-12. Timer0\_A3 Signal Connections**

| INPUT PIN NUMBER |        |         | DEVICE<br>INPUT<br>SIGNAL | MODULE<br>INPUT<br>NAME | MODULE<br>BLOCK | MODULE<br>OUTPUT<br>SIGNAL | OUTPUT PIN NUMBER |         |         |
|------------------|--------|---------|---------------------------|-------------------------|-----------------|----------------------------|-------------------|---------|---------|
| PW20, N20        | PW28   | RHB32   |                           |                         |                 |                            | PW20, N20         | PW28    | RHB32   |
| P1.0-2           | P1.0-2 | P1.0-31 | TACLK                     | TACLK                   | Timer           | NA                         |                   |         |         |
|                  |        |         | ACLK                      | ACLK                    |                 |                            |                   |         |         |
|                  |        |         | SMCLK                     | SMCLK                   |                 |                            |                   |         |         |
| PinOsc           | PinOsc | PinOsc  | TACLK                     | INCLK                   |                 |                            |                   |         |         |
| P1.1-3           | P1.1-3 | P1.1-1  | TA0.0                     | CCI0A                   | CCR0            | TA0                        | P1.1-3            | P1.1-3  | P1.1-1  |
|                  |        |         | ACLK                      | CCI0B                   |                 |                            | P1.5-7            | P1.5-7  | P1.5-5  |
|                  |        |         | V <sub>SS</sub>           | GND                     |                 |                            | –                 | P3.4-15 | P3.4-14 |
|                  |        |         | V <sub>CC</sub>           | V <sub>CC</sub>         |                 |                            |                   |         |         |
| P1.2-4           | P1.2-4 | P1.2-2  | TA0.1                     | CCI1A                   | CCR1            | TA1                        | P1.2-4            | P1.2-4  | P1.2-2  |
|                  |        |         | CAOUT                     | CCI1B                   |                 |                            | P1.6-14           | P1.6-22 | P1.6-21 |
|                  |        |         | V <sub>SS</sub>           | GND                     |                 |                            | P2.6-19           | P2.6-27 | P2.6-26 |
|                  |        |         | V <sub>CC</sub>           | V <sub>CC</sub>         |                 |                            | –                 | P3.5-19 | P3.5-18 |
| –                | P3.0-9 | P3.0-7  | TA0.2                     | CCI2A                   | CCR2            | TA2                        | –                 | P3.0-9  | P3.0-7  |
| PinOsc           | PinOsc | PinOsc  | TA0.2                     | CCI2B                   |                 |                            | –                 | P3.6-20 | P3.6-19 |
|                  |        |         | V <sub>SS</sub>           | GND                     |                 |                            |                   |         |         |
|                  |        |         | V <sub>CC</sub>           | V <sub>CC</sub>         |                 |                            |                   |         |         |

**Table 6-13. Timer1\_A3 Signal Connections**

| INPUT PIN NUMBER |         |         | DEVICE<br>INPUT<br>SIGNAL | MODULE<br>INPUT<br>NAME | MODULE<br>BLOCK | MODULE<br>OUTPUT<br>SIGNAL | OUTPUT PIN NUMBER |         |         |
|------------------|---------|---------|---------------------------|-------------------------|-----------------|----------------------------|-------------------|---------|---------|
| PW20, N20        | PW28    | RHB32   |                           |                         |                 |                            | PW20, N20         | PW28    | RHB32   |
| –                | P3.7-21 | P3.7-20 | TACLK                     | TACLK                   | Timer           | NA                         |                   |         |         |
|                  |         |         | ACLK                      | ACLK                    |                 |                            |                   |         |         |
|                  |         |         | SMCLK                     | SMCLK                   |                 |                            |                   |         |         |
| –                | P3.7-21 | P3.7-20 | TACLK                     | INCLK                   |                 |                            |                   |         |         |
| P2.0-8           | P2.0-10 | P2.0-9  | TA1.0                     | CCI0A                   | CCR0            | TA0                        | P2.0-8            | P2.0-10 | P2.0-9  |
| P2.3-11          | P2.3-16 | P2.3-12 | TA1.0                     | CCI0B                   |                 |                            | P2.3-11           | P2.3-16 | P2.3-15 |
|                  |         |         | V <sub>SS</sub>           | GND                     |                 |                            |                   | P3.1-8  | P3.1-6  |
|                  |         |         | V <sub>CC</sub>           | V <sub>CC</sub>         |                 |                            |                   |         |         |
| P2.1-9           | P2.1-11 | P2.1-10 | TA1.1                     | CCI1A                   | CCR1            | TA1                        | P2.1-9            | P2.1-11 | P2.1-10 |
| P2.2-10          | P2.2-12 | P2.2-11 | TA1.1                     | CCI1B                   |                 |                            | P2.2-10           | P2.2-12 | P2.2-11 |
|                  |         |         | V <sub>SS</sub>           | GND                     |                 |                            |                   | P3.2-13 | P3.2-12 |
|                  |         |         | V <sub>CC</sub>           | V <sub>CC</sub>         |                 |                            |                   |         |         |
| P2.4-12          | P2.4-17 | P2.4-16 | TA1.2                     | CCI2A                   | CCR2            | TA2                        | P2.4-12           | P2.4-17 | P2.4-16 |
| P2.5-13          | P2.5-18 | P2.5-17 | TA1.2                     | CCI2B                   |                 |                            | P2.5-13           | P2.5-18 | P2.5-17 |
|                  |         |         | V <sub>SS</sub>           | GND                     |                 |                            |                   | P3.3-14 | P3.3-13 |
|                  |         |         | V <sub>CC</sub>           | V <sub>CC</sub>         |                 |                            |                   |         |         |

### 6.9.7 Universal Serial Communications Interface (USCI)

The USCI module is used for serial data communication. The USCI module supports synchronous communication protocols such as SPI (3-pin or 4-pin) and I<sup>2</sup>C, and asynchronous communication protocols such as UART, enhanced UART with automatic baud rate detection (LIN), and IrDA. Not all packages support the USCI functionality.

USCI\_A0 provides support for SPI (3-pin or 4-pin), UART, enhanced UART, and IrDA.

USCI\_B0 provides support for SPI (3-pin or 4-pin) and I<sup>2</sup>C.

### 6.9.8 ADC10 (MSP430G2x33 Only)

The ADC10 module supports fast 10-bit analog-to-digital conversions. The module implements a 10-bit SAR core, sample select control, reference generator, and data transfer controller (DTC) for automatic conversion result handling, allowing ADC samples to be converted and stored without any CPU intervention.

## 6.9.9 Peripheral File Map

Table 6-14 lists the registers that support word access. Table 6-15 that support byte access.

**Table 6-14. Peripherals With Word Access**

| MODULE                   | REGISTER DESCRIPTION            | ACRONYM   | OFFSET |
|--------------------------|---------------------------------|-----------|--------|
| ADC10 (MSP430G2x33 only) | ADC data transfer start address | ADC10SA   | 1BCh   |
|                          | ADC memory                      | ADC10MEM  | 1B4h   |
|                          | ADC control register 1          | ADC10CTL1 | 1B2h   |
|                          | ADC control register 0          | ADC10CTL0 | 1B0h   |
| Timer1_A3                | Capture/compare register        | TA1CCR2   | 0196h  |
|                          | Capture/compare register        | TA1CCR1   | 0194h  |
|                          | Capture/compare register        | TA1CCR0   | 0192h  |
|                          | Timer_A register                | TA1R      | 0190h  |
|                          | Capture/compare control         | TA1CCTL2  | 0186h  |
|                          | Capture/compare control         | TA1CCTL1  | 0184h  |
|                          | Capture/compare control         | TA1CCTL0  | 0182h  |
|                          | Timer_A control                 | TA1CTL    | 0180h  |
|                          | Timer_A interrupt vector        | TA1IV     | 011Eh  |
| Timer0_A3                | Capture/compare register        | TA0CCR2   | 0176h  |
|                          | Capture/compare register        | TA0CCR1   | 0174h  |
|                          | Capture/compare register        | TA0CCR0   | 0172h  |
|                          | Timer_A register                | TA0R      | 0170h  |
|                          | Capture/compare control         | TA0CCTL2  | 0166h  |
|                          | Capture/compare control         | TA0CCTL1  | 0164h  |
|                          | Capture/compare control         | TA0CCTL0  | 0162h  |
|                          | Timer_A control                 | TA0CTL    | 0160h  |
|                          | Timer_A interrupt vector        | TA0IV     | 012Eh  |
| Flash Memory             | Flash control 3                 | FCTL3     | 012Ch  |
|                          | Flash control 2                 | FCTL2     | 012Ah  |
|                          | Flash control 1                 | FCTL1     | 0128h  |
| Watchdog Timer+          | Watchdog timer control          | WDTCTL    | 0120h  |

**Table 6-15. Peripherals With Byte Access**

| MODULE  | REGISTER DESCRIPTION                      | ACRONYM   | OFFSET |
|---------|-------------------------------------------|-----------|--------|
| USCI_B0 | USCI_B0 transmit buffer                   | UCB0TXBUF | 06Fh   |
|         | USCI_B0 receive buffer                    | UCB0RXBUF | 06Eh   |
|         | USCI_B0 status                            | UCB0STAT  | 06Dh   |
|         | USCI_B0 I <sup>2</sup> C Interrupt enable | UCB0CIE   | 06Ch   |
|         | USCI_B0 bit rate control 1                | UCB0BR1   | 06Bh   |
|         | USCI_B0 bit rate control 0                | UCB0BR0   | 06Ah   |
|         | USCI_B0 control 1                         | UCB0CTL1  | 069h   |
|         | USCI_B0 control 0                         | UCB0CTL0  | 068h   |
|         | USCI_B0 I <sup>2</sup> C slave address    | UCB0SA    | 011Ah  |
|         | USCI_B0 I <sup>2</sup> C own address      | UCB0OA    | 0118h  |
|         |                                           |           |        |

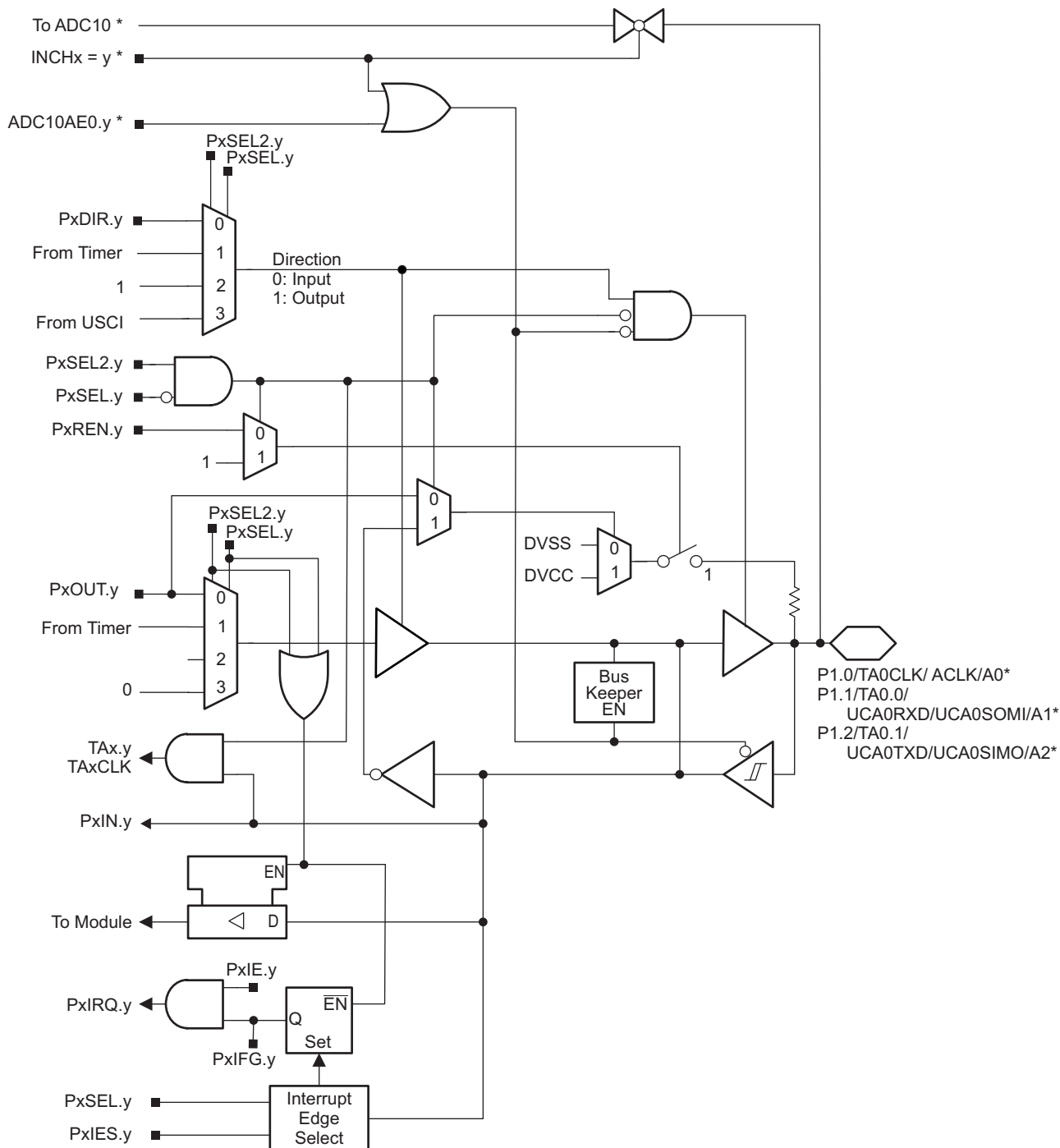
**Table 6-15. Peripherals With Byte Access (continued)**

| MODULE                                     | REGISTER DESCRIPTION                 | ACRONYM    | OFFSET |
|--------------------------------------------|--------------------------------------|------------|--------|
| USCI_A0                                    | USCI_A0 transmit buffer              | UCA0TXBUF  | 067h   |
|                                            | USCI_A0 receive buffer               | UCA0RXBUF  | 066h   |
|                                            | USCI_A0 status                       | UCA0STAT   | 065h   |
|                                            | USCI_A0 modulation control           | UCA0MCTL   | 064h   |
|                                            | USCI_A0 baud rate control 1          | UCA0BR1    | 063h   |
|                                            | USCI_A0 baud rate control 0          | UCA0BR0    | 062h   |
|                                            | USCI_A0 control 1                    | UCA0CTL1   | 061h   |
|                                            | USCI_A0 control 0                    | UCA0CTL0   | 060h   |
|                                            | USCI_A0 IrDA receive control         | UCA0IRRCTL | 05Fh   |
|                                            | USCI_A0 IrDA transmit control        | UCA0IRTCTL | 05Eh   |
|                                            | USCI_A0 auto baud rate control       | UCA0ABCTL  | 05Dh   |
| ADC10 (MSP430G2x33 only)                   | ADC analog enable 0                  | ADC10AE0   | 04Ah   |
|                                            | ADC analog enable 1                  | ADC10AE1   | 04Bh   |
|                                            | ADC data transfer control register 1 | ADC10DTC1  | 049h   |
|                                            | ADC data transfer control register 0 | ADC10DTC0  | 048h   |
| Basic Clock System+                        | Basic clock system control 3         | BCSCTL3    | 053h   |
|                                            | Basic clock system control 2         | BCSCTL2    | 058h   |
|                                            | Basic clock system control 1         | BCSCTL1    | 057h   |
|                                            | DCO clock frequency control          | DCOCTL     | 056h   |
| Port P3<br>(28-pin PW and 32-pin RHB only) | Port P3 selection 2. pin             | P3SEL2     | 043h   |
|                                            | Port P3 resistor enable              | P3REN      | 010h   |
|                                            | Port P3 selection                    | P3SEL      | 01Bh   |
|                                            | Port P3 direction                    | P3DIR      | 01Ah   |
|                                            | Port P3 output                       | P3OUT      | 019h   |
|                                            | Port P3 input                        | P3IN       | 018h   |
| Port P2                                    | Port P2 selection 2                  | P2SEL2     | 042h   |
|                                            | Port P2 resistor enable              | P2REN      | 02Fh   |
|                                            | Port P2 selection                    | P2SEL      | 02Eh   |
|                                            | Port P2 interrupt enable             | P2IE       | 02Dh   |
|                                            | Port P2 interrupt edge select        | P2IES      | 02Ch   |
|                                            | Port P2 interrupt flag               | P2IFG      | 02Bh   |
|                                            | Port P2 direction                    | P2DIR      | 02Ah   |
|                                            | Port P2 output                       | P2OUT      | 029h   |
|                                            | Port P2 input                        | P2IN       | 028h   |
| Port P1                                    | Port P1 selection 2                  | P1SEL2     | 041h   |
|                                            | Port P1 resistor enable              | P1REN      | 027h   |
|                                            | Port P1 selection                    | P1SEL      | 026h   |
|                                            | Port P1 interrupt enable             | P1IE       | 025h   |
|                                            | Port P1 interrupt edge select        | P1IES      | 024h   |
|                                            | Port P1 interrupt flag               | P1IFG      | 023h   |
|                                            | Port P1 direction                    | P1DIR      | 022h   |
|                                            | Port P1 output                       | P1OUT      | 021h   |
|                                            | Port P1 input                        | P1IN       | 020h   |
| Special Function                           | SFR interrupt flag 2                 | IFG2       | 003h   |
|                                            | SFR interrupt flag 1                 | IFG1       | 002h   |
|                                            | SFR interrupt enable 2               | IE2        | 001h   |
|                                            | SFR interrupt enable 1               | IE1        | 000h   |

## 6.10 I/O Port Diagrams

### 6.10.1 Port P1 Pin Diagram: P1.0 to P1.2, Input/Output With Schmitt Trigger

Figure 6-6 shows the port diagram. Table 6-16 summarizes the selection of the pin functions.



\* Note: MSP430G2x33 devices only. MSP430G2x03 devices have no ADC10.

**Figure 6-6. Port P1 (P1.0 to P1.2) Diagram**



**Table 6-16. Port P1 (P1.0 to P1.2) Pin Functions**

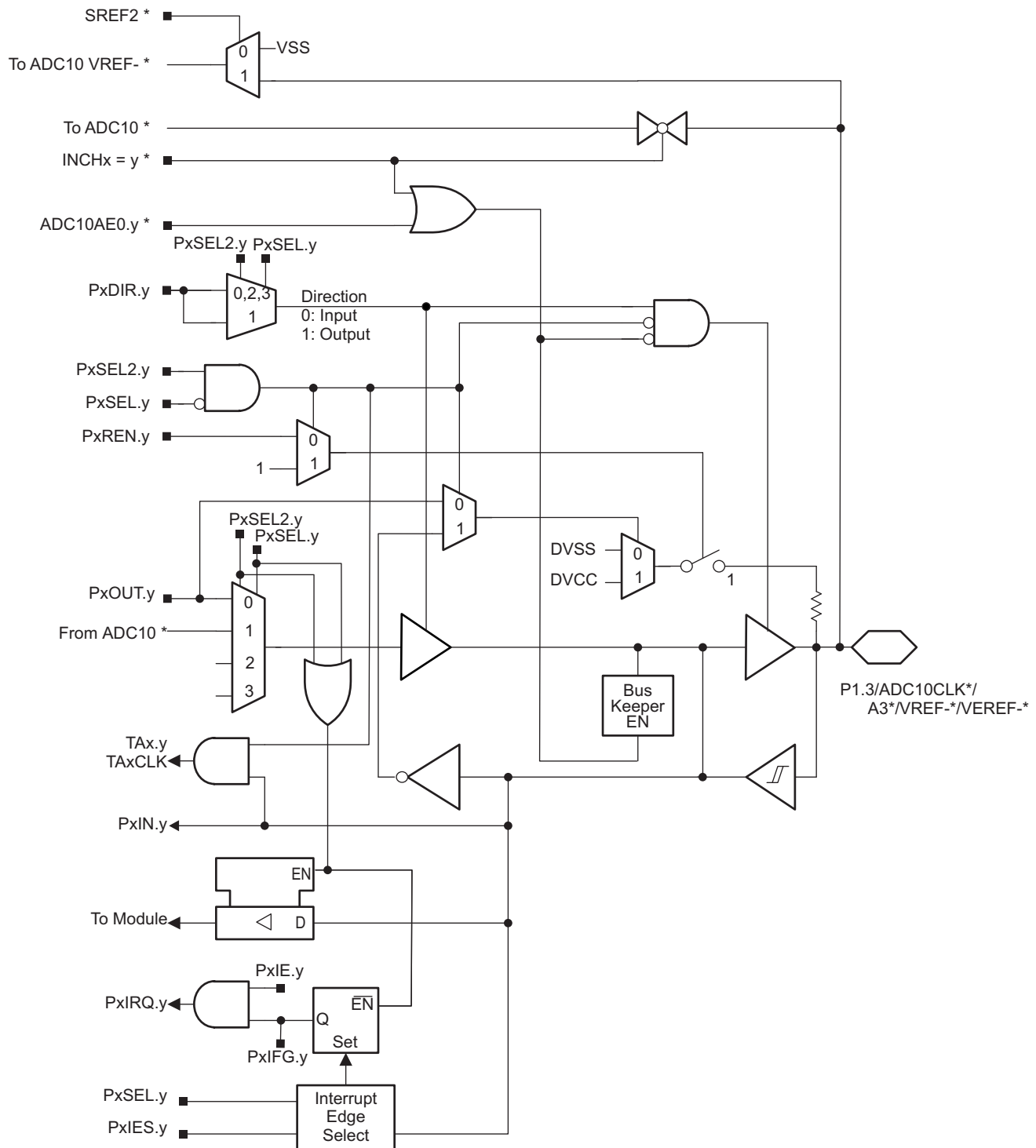
| PIN NAME<br>(P1.x)                                                             | x | FUNCTION           | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |          |                                          |
|--------------------------------------------------------------------------------|---|--------------------|----------------------------------------|---------|----------|------------------------------------------|
|                                                                                |   |                    | P1DIR.x                                | P1SEL.x | P1SEL2.x | ADC10AE.x<br>(INCH.y = 1) <sup>(2)</sup> |
| P1.0/<br>TA0CLK/<br>ACLK/<br>A0 <sup>(2)</sup> /<br>Pin Osc                    | 0 | P1.x (I/O)         | I: 0; O: 1                             | 0       | 0        | 0                                        |
|                                                                                |   | TA0.TACLK          | 0                                      | 1       | 0        | 0                                        |
|                                                                                |   | ACLK               | 1                                      | 1       | 0        | 0                                        |
|                                                                                |   | A0                 | X                                      | X       | X        | 1 (y = 0)                                |
|                                                                                |   | Capacitive sensing | X                                      | 0       | 1        | 0                                        |
| P1.1/<br>TA0.0/<br><br>UCA0RXD/<br>UCA0SOMI/<br>A1 <sup>(2)</sup> /<br>Pin Osc | 1 | P1.x (I/O)         | I: 0; O: 1                             | 0       | 0        | 0                                        |
|                                                                                |   | TA0.0              | 1                                      | 1       | 0        | 0                                        |
|                                                                                |   | TA0.CCI0A          | 0                                      | 1       | 0        | 0                                        |
|                                                                                |   | UCA0RXD            | from USCI                              | 1       | 1        | 0                                        |
|                                                                                |   | UCA0SOMI           | from USCI                              | 1       | 1        | 0                                        |
|                                                                                |   | A1                 | X                                      | X       | X        | 1 (y = 1)                                |
|                                                                                |   | Capacitive sensing | X                                      | 0       | 1        | 0                                        |
| P1.2/<br>TA0.1/<br><br>UCA0TXD/<br>UCA0SIMO/<br>A2 <sup>(2)</sup> /<br>Pin Osc | 2 | P1.x (I/O)         | I: 0; O: 1                             | 0       | 0        | 0                                        |
|                                                                                |   | TA0.1              | 1                                      | 1       | 0        | 0                                        |
|                                                                                |   | TA0.CCI1A          | 0                                      | 1       | 0        | 0                                        |
|                                                                                |   | UCA0TXD            | from USCI                              | 1       | 1        | 0                                        |
|                                                                                |   | UCA0SIMO           | from USCI                              | 1       | 1        | 0                                        |
|                                                                                |   | A2                 | X                                      | X       | X        | 1 (y = 2)                                |
|                                                                                |   | Capacitive sensing | X                                      | 0       | 1        | 0                                        |

(1) X = don't care

(2) MSP430G2x33 devices only

## 6.10.2 Port P1 Pin Diagram: P1.3, Input/Output With Schmitt Trigger

Figure 6-7 shows the port diagram. Table 6-17 summarizes the selection of the pin functions.



\* Note: MSP430G2x33 devices only. MSP430G2x03 devices have no ADC10.

**Figure 6-7. Port P1 (P1.3) Diagram**

**Table 6-17. Port P1 (P1.3) Pin Functions**

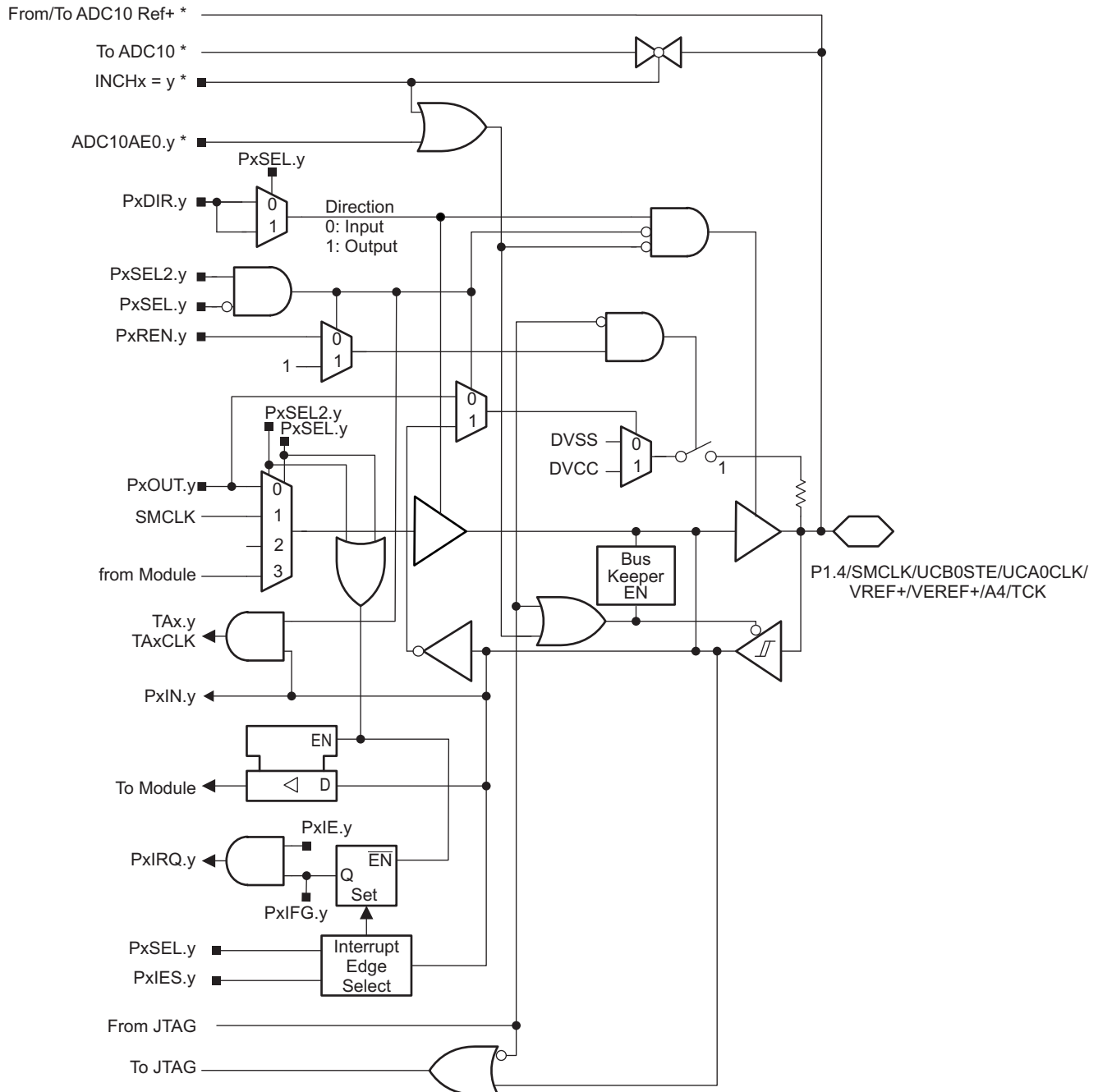
| PIN NAME<br>(P1.x)                                                                                                        | x | FUNCTION           | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |          |                                          |
|---------------------------------------------------------------------------------------------------------------------------|---|--------------------|----------------------------------------|---------|----------|------------------------------------------|
|                                                                                                                           |   |                    | P1DIR.x                                | P1SEL.x | P1SEL2.x | ADC10AE.x<br>(INCH.y = 1) <sup>(2)</sup> |
| P1.3/<br>ADC10CLK <sup>(2)</sup> /<br>A3 <sup>(2)</sup> /<br>VREF- <sup>(2)</sup> /<br>VEREF- <sup>(2)</sup> /<br>Pin Osc | 3 | P1.x (I/O)         | I: 0; O: 1                             | 0       | 0        | 0                                        |
|                                                                                                                           |   | ADC10CLK           | 1                                      | 1       | 0        | 0                                        |
|                                                                                                                           |   | A3                 | X                                      | X       | X        | 1 (y = 3)                                |
|                                                                                                                           |   | VREF-              | X                                      | X       | X        | 1                                        |
|                                                                                                                           |   | VEREF-             | X                                      | X       | X        | 1                                        |
|                                                                                                                           |   | Capacitive sensing | X                                      | 0       | 1        | 0                                        |

(1) X = don't care

(2) MSP430G2x33 devices only

### 6.10.3 Port P1 Pin Diagram: P1.4, Input/Output With Schmitt Trigger

Figure 6-8 shows the port diagram. Table 6-18 summarizes the selection of the pin functions.



\* Note: MSP430G2x33 devices only. MSP430G2x03 devices have no ADC10.

Figure 6-8. Port P1 (P1.4) Diagram

**Table 6-18. Port P1 (P1.4) Pin Functions**

| PIN NAME<br>(P1.x)                                                                                                                     | x | FUNCTION                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |          |                                          |           |
|----------------------------------------------------------------------------------------------------------------------------------------|---|---------------------------|----------------------------------------|---------|----------|------------------------------------------|-----------|
|                                                                                                                                        |   |                           | P1DIR.x                                | P1SEL.x | P1SEL2.x | ADC10AE.x<br>(INCH.y = 1) <sup>(2)</sup> | JTAG Mode |
| P1.4/<br>SMCLK/<br>UCB0STE/<br>UCA0CLK/<br>VREF+ <sup>(2)</sup> /<br>VEREF+ <sup>(2)</sup> /<br>A4 <sup>(2)</sup> /<br>TCK/<br>Pin Osc | 4 | P1.x (I/O)                | I: 0; O: 1                             | 0       | 0        | 0                                        | 0         |
|                                                                                                                                        |   | SMCLK                     | 1                                      | 1       | 0        | 0                                        | 0         |
|                                                                                                                                        |   | UCB0STE <sup>(3)(4)</sup> | from USCI                              | 1       | 1        | 0                                        | 0         |
|                                                                                                                                        |   | UCA0CLK <sup>(3)(4)</sup> | from USCI                              | 1       | 1        | 0                                        | 0         |
|                                                                                                                                        |   | VREF+                     | X                                      | X       | X        | 1                                        | 0         |
|                                                                                                                                        |   | VEREF+                    | X                                      | X       | X        | 1                                        | 0         |
|                                                                                                                                        |   | A4                        | X                                      | X       | X        | 1 (y = 4)                                | 0         |
|                                                                                                                                        |   | TCK                       | X                                      | X       | X        | 0                                        | 1         |
|                                                                                                                                        |   | Capacitive sensing        | X                                      | 0       | 1        | 0                                        | 0         |

(1) X = don't care

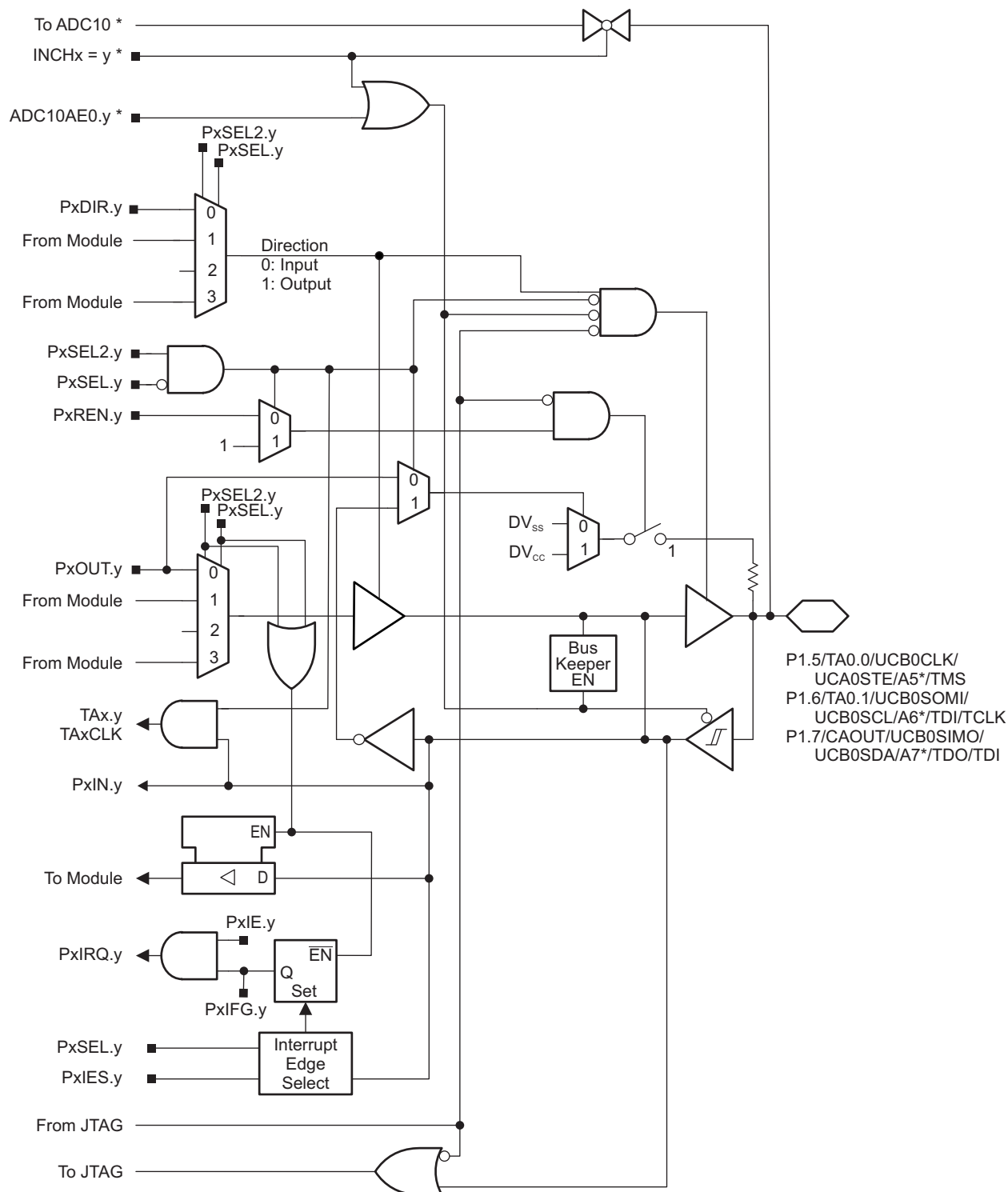
(2) MSP430G2x33 devices only

(3) The pin direction is controlled by the USCI module.

(4) UCA0CLK function takes precedence over UCB0STE function. If the pin is required as UCA0CLK input or output, USCI\_B0 is forced to 3-wire SPI mode if 4-wire SPI mode is selected.

#### 6.10.4 Port P1 Pin Diagram: P1.5 to P1.7, Input/Output With Schmitt Trigger

Figure 6-9 shows the port diagram. Table 6-19 summarizes the selection of the pin functions.



\* Note: MSP430G2x33 devices only. MSP430G2x03 devices have no ADC10.

**Figure 6-9. Port P1 (P1.5 to P1.7) Diagram**

**Table 6-19. Port P1 (P1.5 to P1.7) Pin Functions**

| PIN NAME<br>(P1.x)                                                                      | x | FUNCTION                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |          |                                          |           |
|-----------------------------------------------------------------------------------------|---|---------------------------|----------------------------------------|---------|----------|------------------------------------------|-----------|
|                                                                                         |   |                           | P1DIR.x                                | P1SEL.x | P1SEL2.x | ADC10AE.x<br>(INCH.y = 1) <sup>(2)</sup> | JTAG Mode |
| P1.5/<br>TA0.0/<br>UCB0CLK/<br>UCA0STE/<br>A5 <sup>(2)</sup> /<br>TMS<br>Pin Osc        | 5 | P1.x (I/O)                | I: 0; O: 1                             | 0       | 0        | 0                                        | 0         |
|                                                                                         |   | TA0.0                     | 1                                      | 1       | 0        | 0                                        | 0         |
|                                                                                         |   | UCB0CLK <sup>(3)(4)</sup> | from USCI                              | 1       | 1        | 0                                        | 0         |
|                                                                                         |   | UCA0STE <sup>(3)(4)</sup> | from USCI                              | 1       | 1        | 0                                        | 0         |
|                                                                                         |   | A5                        | X                                      | X       | X        | 1 (y = 5)                                | 0         |
|                                                                                         |   | TMS                       | X                                      | X       | X        | 0                                        | 1         |
|                                                                                         |   | Capacitive sensing        | X                                      | 0       | 1        | 0                                        | 0         |
| P1.6/<br>TA0.1/<br>UCB0SOMI/<br>UCB0SCL/<br>A6 <sup>(2)</sup> /<br>TDI/TCLK/<br>Pin Osc | 6 | P1.x (I/O)                | I: 0; O: 1                             | 0       | 0        | 0                                        | 0         |
|                                                                                         |   | TA0.1                     | 1                                      | 1       | 0        | 0                                        | 0         |
|                                                                                         |   | UCB0SOMI                  | from USCI                              | 1       | 1        | 0                                        | 0         |
|                                                                                         |   | UCB0SCL                   | from USCI                              | 1       | 1        | 0                                        | 0         |
|                                                                                         |   | A6                        | X                                      | X       | X        | 1 (y = 6)                                | 0         |
|                                                                                         |   | TDI/TCLK                  | X                                      | X       | X        | 0                                        | 1         |
|                                                                                         |   | Capacitive sensing        | X                                      | 0       | 1        | 0                                        | 0         |
| P1.7/<br>UCB0SIMO/<br>UCB0SDA/<br>A7 <sup>(2)</sup> /<br>TDO/TDI/<br>Pin Osc            | 7 | P1.x (I/O)                | I: 0; O: 1                             | 0       | 0        | 0                                        | 0         |
|                                                                                         |   | UCB0SIMO                  | from USCI                              | 1       | 1        | 0                                        | 0         |
|                                                                                         |   | UCB0SDA                   | from USCI                              | 1       | 1        | 0                                        | 0         |
|                                                                                         |   | A7                        | X                                      | X       | X        | 1 (y = 7)                                | 0         |
|                                                                                         |   | TDO/TDI                   | X                                      | X       | X        | 0                                        | 1         |
|                                                                                         |   | Capacitive sensing        | X                                      | 0       | 1        | 0                                        | 0         |

(1) X = don't care

(2) MSP430G2x33 devices only

(3) The pin direction is controlled by the USCI module.

(4) UCB0CLK function takes precedence over UCA0STE function. If the pin is required as UCB0CLK input or output, USCI\_A0 is forced to 3-wire SPI mode if 4-wire SPI mode is selected.

### 6.10.5 Port P2 Pin Diagram: P2.0 to P2.5, Input/Output With Schmitt Trigger

Figure 6-10 shows the port diagram. Table 6-20 summarizes the selection of the pin functions.

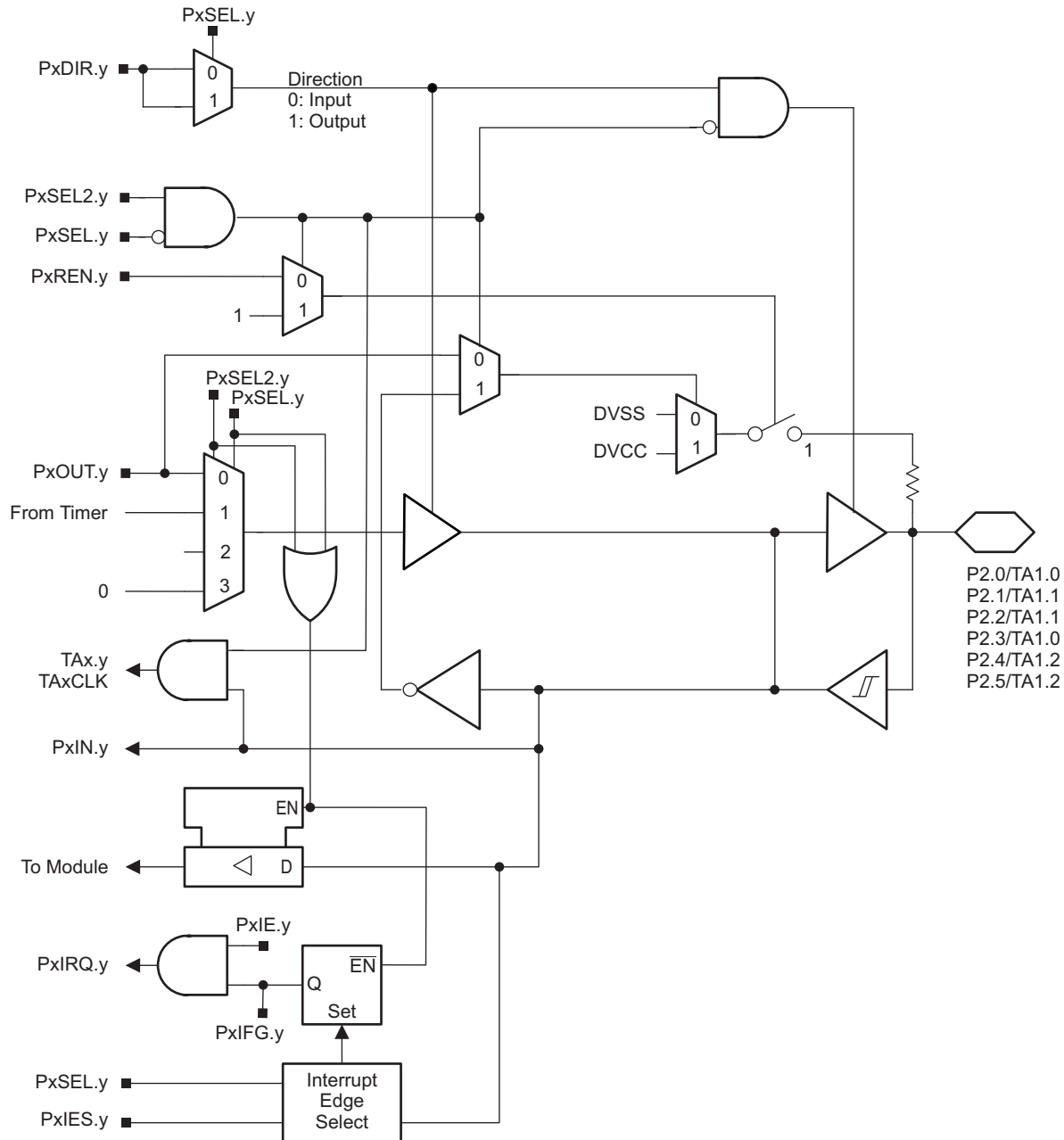


Figure 6-10. Port P2 (P2.0 to P2.5) Diagram



**Table 6-20. Port P2 (P2.0 to P2.5) Pin Functions**

| PIN NAME<br>(P2.x)             | x | FUNCTION           | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |          |
|--------------------------------|---|--------------------|----------------------------------------|---------|----------|
|                                |   |                    | P2DIR.x                                | P2SEL.x | P2SEL2.x |
| P2.0/<br>TA1.0/<br><br>Pin Osc | 0 | P2.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                                |   | Timer1_A3.CCI0A    | 0                                      | 1       | 0        |
|                                |   | Timer1_A3.TA0      | 1                                      | 1       | 0        |
|                                |   | Capacitive sensing | X                                      | 0       | 1        |
| P2.1/<br>TA1.1/<br><br>Pin Osc | 1 | P2.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                                |   | Timer1_A3.CCI1A    | 0                                      | 1       | 0        |
|                                |   | Timer1_A3.TA1      | 1                                      | 1       | 0        |
|                                |   | Capacitive sensing | X                                      | 0       | 1        |
| P2.2/<br>TA1.1/<br><br>Pin Osc | 2 | P2.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                                |   | Timer1_A3.CCI1B    | 0                                      | 1       | 0        |
|                                |   | Timer1_A3.TA1      | 1                                      | 1       | 0        |
|                                |   | Capacitive sensing | X                                      | 0       | 1        |
| P2.3/<br>TA1.0/<br><br>Pin Osc | 3 | P2.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                                |   | Timer1_A3.CCI0B    | 0                                      | 1       | 0        |
|                                |   | Timer1_A3.TA0      | 1                                      | 1       | 0        |
|                                |   | Capacitive sensing | X                                      | 0       | 1        |
| P2.4/<br>TA1.2/<br><br>Pin Osc | 4 | P2.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                                |   | Timer1_A3.CCI2A    | 0                                      | 1       | 0        |
|                                |   | Timer1_A3.TA2      | 1                                      | 1       | 0        |
|                                |   | Capacitive sensing | X                                      | 0       | 1        |
| P2.5/<br>TA1.2/<br><br>Pin Osc | 5 | P2.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                                |   | Timer1_A3.CCI2B    | 0                                      | 1       | 0        |
|                                |   | Timer1_A3.TA2      | 1                                      | 1       | 0        |
|                                |   | Capacitive sensing | X                                      | 0       | 1        |

(1) X = don't care

### 6.10.6 Port P2 Pin Diagram: P2.6, Input/Output With Schmitt Trigger

Figure 6-11 shows the port diagram. Table 6-21 summarizes the selection of the pin functions.

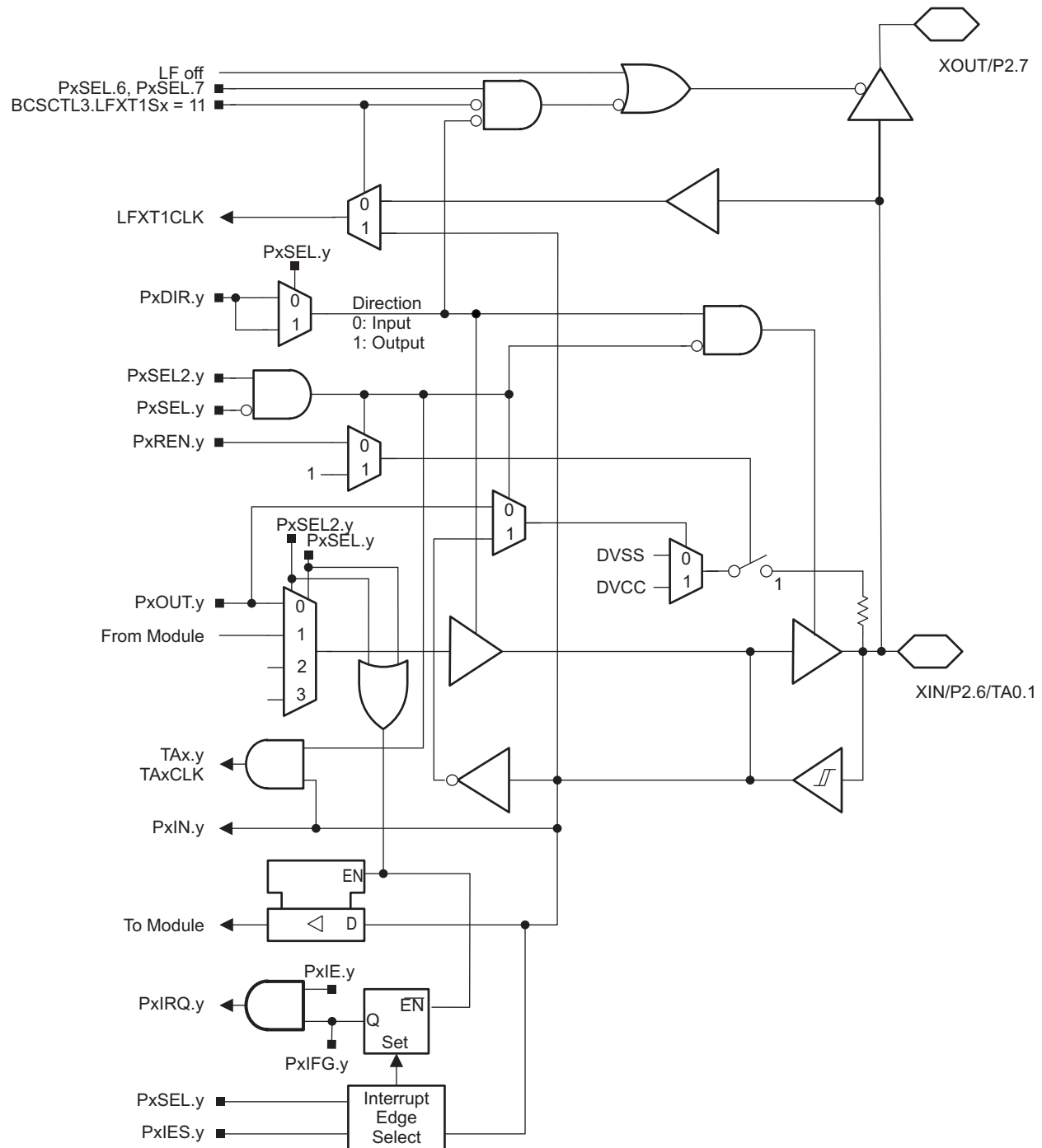


Figure 6-11. Port P2 (P2.6) Diagram

**Table 6-21. Port P2 (P2.6) Pin Functions**

| PIN NAME<br>(P2.x) | x | FUNCTION           | CONTROL BITS OR SIGNALS <sup>(1)</sup> |                    |                      |
|--------------------|---|--------------------|----------------------------------------|--------------------|----------------------|
|                    |   |                    | P2DIR.x                                | P2SEL.6<br>P2SEL.7 | P2SEL2.6<br>P2SEL2.7 |
| XIN                | 6 | XIN                | 0                                      | 1<br>1             | 0<br>0               |
| P2.6               |   | P2.x (I/O)         | I: 0; O: 1                             | 0<br>X             | 0<br>0               |
| TA0.1              |   | Timer0_A3.TA1      | 1                                      | 1<br>0             | 0<br>0               |
| Pin Osc            |   | Capacitive sensing | X                                      | 0<br>X             | 1<br>X               |

(1) X = don't care

### 6.10.7 Port P2 Pin Diagram: P2.7, Input/Output With Schmitt Trigger

Figure 6-12 shows the port diagram. Table 6-22 summarizes the selection of the pin functions.

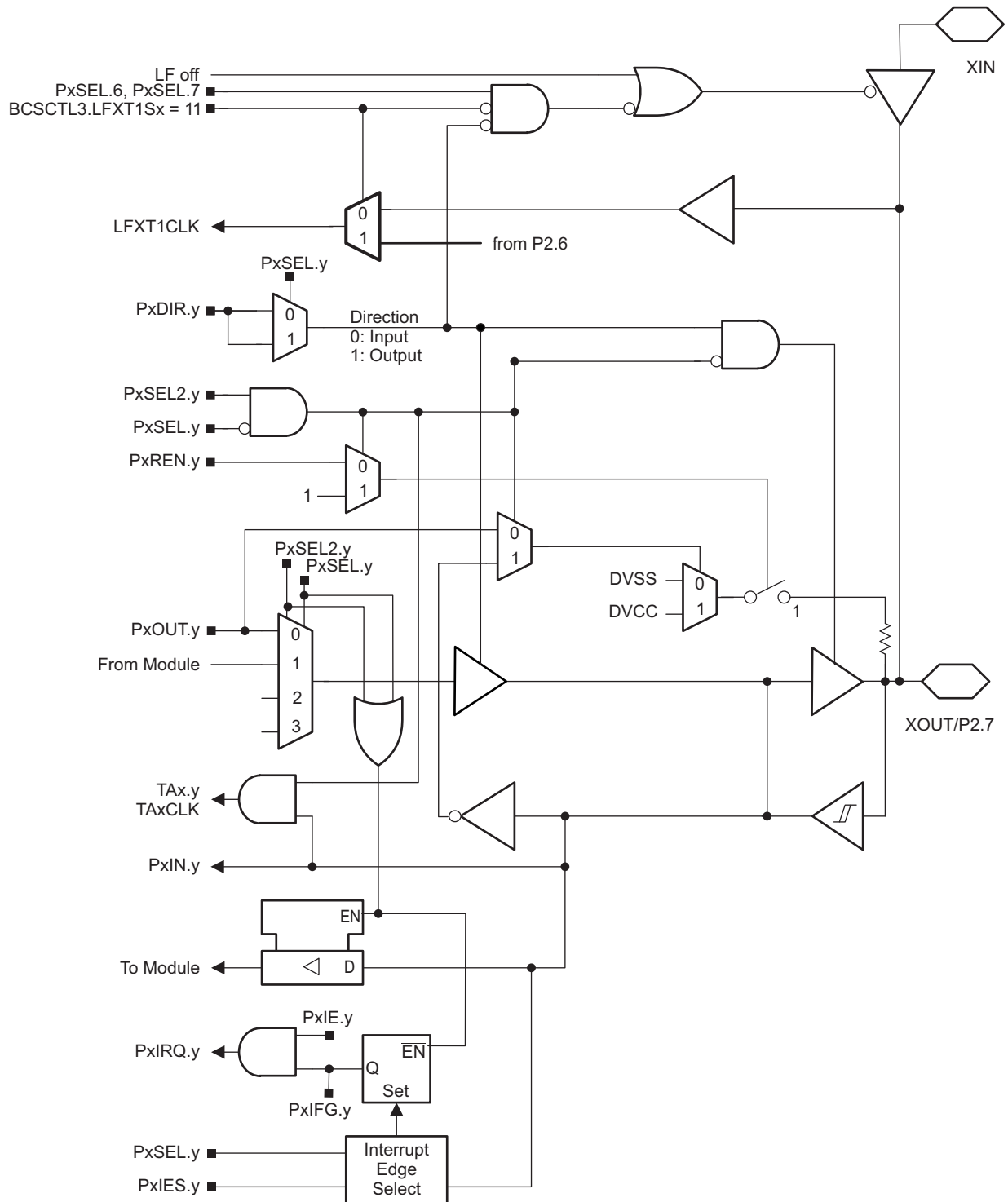


Figure 6-12. Port P2 (P2.7) Diagram

**Table 6-22. Port P2 (P2.7) Pin Functions**

| PIN NAME<br>(P2.x) | x | FUNCTION           | CONTROL BITS OR SIGNALS <sup>(1)</sup> |                    |                      |
|--------------------|---|--------------------|----------------------------------------|--------------------|----------------------|
|                    |   |                    | P2DIR.x                                | P2SEL.6<br>P2SEL.7 | P2SEL2.6<br>P2SEL2.7 |
| XOUT/              | 7 | XOUT               | 1                                      | 1<br>1             | 0<br>0               |
| P2.7/              |   | P2.x (I/O)         | I: 0; O: 1                             | 0<br>X             | 0<br>0               |
| Pin Osc            |   | Capacitive sensing | X                                      | 0<br>X             | 1<br>X               |

(1) X = don't care

### 6.10.8 Port P3 Pin Diagram: P3.0 to P3.7, Input/Output With Schmitt Trigger (RHB and PW28 Package Only)

Figure 6-13 shows the port diagram. Table 6-23 summarizes the selection of the pin functions.

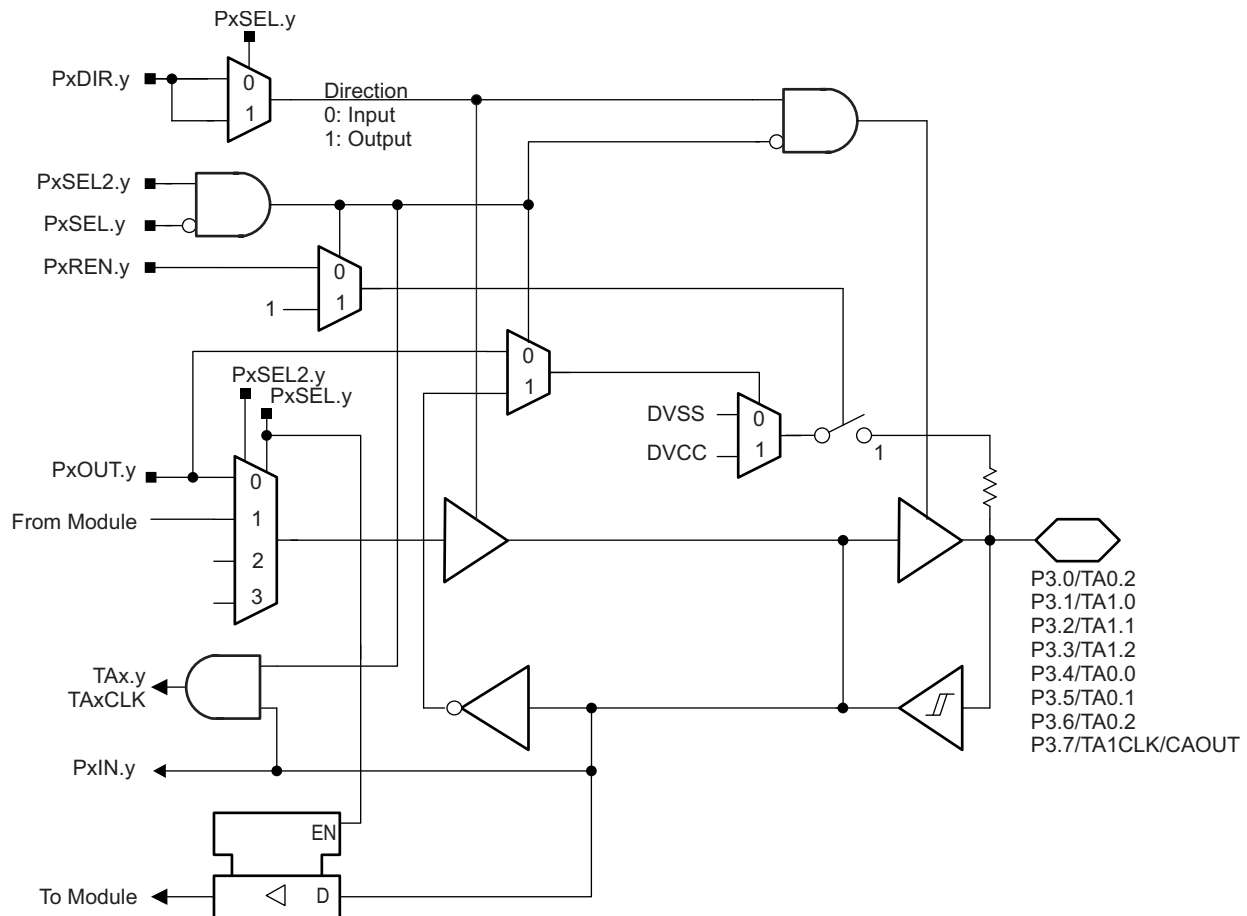


Figure 6-13. Port P3 (P3.0 to P3.7) Diagram (RHB and PW28 Package Only)

**Table 6-23. Port P3 (P3.0 to P3.7) Pin Functions (RHB and PW28 Package Only)**

| PIN NAME<br>(P3.x)          | x | FUNCTION           | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |          |
|-----------------------------|---|--------------------|----------------------------------------|---------|----------|
|                             |   |                    | P3DIR.x                                | P3SEL.x | P3SEL2.x |
| P3.0/<br>TA0.2/<br>Pin Osc  | 0 | P3.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                             |   | Timer0_A3.CCI2A    | 0                                      | 1       | 0        |
|                             |   | Timer0_A3.TA2      | 1                                      | 1       | 0        |
|                             |   | Capacitive sensing | X                                      | 0       | 1        |
| P3.1/<br>TA1.0/<br>Pin Osc  | 1 | P3.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                             |   | Timer1_A3.TA0      | 1                                      | 1       | 0        |
|                             |   | Capacitive sensing | X                                      | 0       | 1        |
| P3.2/<br>TA1.1/<br>Pin Osc  | 2 | P3.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                             |   | Timer1_A3.TA1      | 1                                      | 1       | 0        |
|                             |   | Capacitive sensing | X                                      | 0       | 1        |
| P3.3/<br>TA1.2/<br>Pin Osc  | 3 | P3.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                             |   | Timer1_A3.TA2      | 1                                      | 1       | 0        |
|                             |   | Capacitive sensing | X                                      | 0       | 1        |
| P3.4/<br>TA0.0/<br>Pin Osc  | 4 | P3.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                             |   | Timer0_A3.TA0      | 1                                      | 1       | 0        |
|                             |   | Capacitive sensing | X                                      | 0       | 1        |
| P3.5/<br>TA0.1/<br>Pin Osc  | 5 | P3.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                             |   | Timer0_A3.TA1      | 1                                      | 1       | 0        |
|                             |   | Capacitive sensing | X                                      | 0       | 1        |
| P3.6/<br>TA0.2/<br>Pin Osc  | 6 | P3.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                             |   | Timer0_A3.TA2      | 1                                      | 1       | 0        |
|                             |   | Capacitive sensing | X                                      | 0       | 1        |
| P3.7/<br>TA1CLK/<br>Pin Osc | 7 | P3.x (I/O)         | I: 0; O: 1                             | 0       | 0        |
|                             |   | Timer1_A3.TACLK    | 0                                      | 1       | 0        |
|                             |   | Capacitive sensing | X                                      | 0       | 1        |

(1) X = don't care

## 7 Device and Documentation Support

### 7.1 Getting Started and Next Steps

For more information on the MSP430™ family of devices and the tools and libraries that are available to help with your development, visit the [Getting Started](#) page.

### 7.2 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP430 MCU devices and support tools. Each MSP430 MCU commercial family member has one of three prefixes: MSP, PMS, or XMS (for example, MSP430F5438A). TI recommends two of three possible prefix designators for its support tools: MSP and MSPX. These prefixes represent evolutionary stages of product development from engineering prototypes (with XMS for devices and MSPX for tools) through fully qualified production devices and tools (with MSP for devices and MSP for tools).

Device development evolutionary flow:

**XMS** – Experimental device that is not necessarily representative of the electrical specifications for the final device

**PMS** – Final silicon die that conforms to the electrical specifications for the device but has not completed quality and reliability verification

**MSP** – Fully qualified production device

Support tool development evolutionary flow:

**MSPX** – Development-support product that has not yet completed TI's internal qualification testing.

**MSP** – Fully-qualified development-support product

XMS and PMS devices and MSPX development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices and MSP development-support tools have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (XMS and PMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the package type (for example, PZP) and temperature range (for example, T). [Figure 7-1](#) provides a legend for reading the complete device name for any family member.



|                                      |                                                                                                                                |                                                                                                                                                                                                                                         |
|--------------------------------------|--------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>MSP 430 F 5 438 A I ZQW T -EP</b> |                                                                                                                                |                                                                                                                                                                                                                                         |
| Processor Family                     | MCU Platform                                                                                                                   | Optional: Additional Features                                                                                                                                                                                                           |
|                                      | Device Type                                                                                                                    | Optional: Tape and Reel                                                                                                                                                                                                                 |
|                                      | Series                                                                                                                         | Packaging                                                                                                                                                                                                                               |
|                                      | Feature Set                                                                                                                    | Optional: Temperature Range                                                                                                                                                                                                             |
|                                      |                                                                                                                                | Optional: A = Revision                                                                                                                                                                                                                  |
| <b>Processor Family</b>              | CC = Embedded RF Radio<br>MSP = Mixed-Signal Processor<br>XMS = Experimental Silicon<br>PMS = Prototype Device                 |                                                                                                                                                                                                                                         |
| <b>MCU Platform</b>                  | 430 = MSP430 low-power microcontroller platform                                                                                |                                                                                                                                                                                                                                         |
| <b>Device Type</b>                   | <b>Memory Type</b><br>C = ROM<br>F = Flash<br>FR = FRAM<br>G = Flash or FRAM (Value Line)<br>L = No Nonvolatile Memory         | <b>Specialized Application</b><br>AFE = Analog Front End<br>BT = Preprogrammed with <i>Bluetooth</i><br>BQ = Contactless Power<br>CG = ROM Medical<br>FE = Flash Energy Meter<br>FG = Flash Medical<br>FW = Flash Electronic Flow Meter |
| <b>Series</b>                        | 1 Series = Up to 8 MHz<br>2 Series = Up to 16 MHz<br>3 Series = Legacy<br>4 Series = Up to 16 MHz with LCD                     | 5 Series = Up to 25 MHz<br>6 Series = Up to 25 MHz with LCD<br>0 = Low-Voltage Series                                                                                                                                                   |
| <b>Feature Set</b>                   | Various Levels of Integration Within a Series                                                                                  |                                                                                                                                                                                                                                         |
| <b>Optional: A = Revision</b>        | N/A                                                                                                                            |                                                                                                                                                                                                                                         |
| <b>Optional: Temperature Range</b>   | S = 0°C to 50°C<br>C = 0°C to 70°C<br>I = –40°C to 85°C<br>T = –40°C to 105°C                                                  |                                                                                                                                                                                                                                         |
| <b>Packaging</b>                     | <a href="http://www.ti.com/packaging">http://www.ti.com/packaging</a>                                                          |                                                                                                                                                                                                                                         |
| <b>Optional: Tape and Reel</b>       | T = Small Reel<br>R = Large Reel<br>No Markings = Tube or Tray                                                                 |                                                                                                                                                                                                                                         |
| <b>Optional: Additional Features</b> | -EP = Enhanced Product (–40°C to 105°C)<br>-HT = Extreme Temperature Parts (–55°C to 150°C)<br>-Q1 = Automotive Q100 Qualified |                                                                                                                                                                                                                                         |

**Figure 7-1. Device Nomenclature**

## 7.3 Tools and Software

All MSP microcontrollers are supported by a wide variety of software and hardware development tools. Tools are available from TI and various third parties. See them all at [MSP Tools](#).

[Table 7-1](#) lists the debug features of these devices. See the *Code Composer Studio for MSP430 User's Guide* (SLAU157) for details on the available features.

**Table 7-1. Hardware Features**

| MSP430<br>ARCHITECTURE | 4-WIRE<br>JTAG | 2-WIRE<br>JTAG | BREAK-<br>POINTS<br>(N) | RANGE<br>BREAK-<br>POINTS | CLOCK<br>CONTROL | STATE<br>SEQUENCER | TRACE<br>BUFFER | LPMx.5<br>DEBUGGING<br>SUPPORT |
|------------------------|----------------|----------------|-------------------------|---------------------------|------------------|--------------------|-----------------|--------------------------------|
| MSP430                 | Yes            | Yes            | 2                       | No                        | Yes              | No                 | No              | No                             |

### Design Kits and Evaluation Modules

**28-Pin Target Development Board and MSP-FET USB Programmer Bundle for MSP430F2x and MSP430G2x MCUs** The MSP-FET430U28A kit includes all of the hardware and software required to quickly begin application development on the MSP430 MCU. This kit includes a ZIF socket target board (MSP-TS430PW28A) that accepts some MSP430 devices in 20- or 28-pin TSSOP packages (TI Package Code: PW). It is also bundled with a USB flash emulation tool (MSP-FET) that interfaces the target board to a PC, allowing developers to program and debug their MSP430 devices through in-system emulation through the JTAG interface or the pin-saving Spy Bi-Wire (2-wire JTAG) protocol.

**MSP430 LaunchPad™ Value Line Development Kit** The MSP-EXP430G2 LaunchPad Development Kit is an easy-to-use microcontroller development board for the low-power and low-cost MSP430G2x MCUs. It has on-board emulation for programming and debugging and features a 14- or 20-pin DIP socket, on-board buttons and LEDs and BoosterPack Plug-in Module pinouts that support a wide range of modules for added functionality such as wireless, displays, and more.

**MSP430 Capacitive Touch BoosterPack™ Plug-in Module** The Capacitive Touch BoosterPack (430BOOST-SENSE1) is a plug-in module for MCU LaunchPad Development Kits. This BoosterPack also includes a preprogrammed MSP430G2452IN20 Value Line device for the MSP-EXP430G2 LaunchPad. Developers can use this BoosterPack as a solution for adding capacitive touch differentiation in many applications such as consumer electronics, point of sales machines, and other devices with a physical button.

### Software

**MSP430G2x53, MSP430G2x33, MSP430G2x13, MSP430G2x03 Code Examples** C Code examples are available for every MSP device that configures each of the integrated peripherals for various application needs.

**MSPWare™ Software** MSPWare software is a collection of code examples, data sheets, and other design resources for all MSP devices delivered in a convenient package. In addition to providing a complete collection of existing MSP design resources, MSPWare software also includes a high-level API called MSP Driver Library. This library makes it easy to program MSP hardware. MSPWare software is available as a component of CCS or as a stand-alone package.

**MSP Driver Library** Driver Library's abstracted API keeps you above the bits and bytes of the MSP430 hardware by providing easy-to-use function calls. Thorough documentation is delivered through a helpful API Guide, which includes details on each function call and the recognized parameters. Developers can use Driver Library functions to write complete projects with minimal overhead.

**Capacitive Touch Software Library** Free C libraries for enabling capacitive touch capabilities on MSP430 MCUs and MSP432 MCUs. The MSP430 MCU version of the library features several capacitive touch implementations including the RO and RC method.

**MSP EnergyTrace™ Technology** EnergyTrace technology for MSP430 microcontrollers is an energy-based code analysis tool that measures and displays the application's energy profile and helps to optimize it for ultra-low-power consumption.

**ULP (Ultra-Low Power) Advisor** ULP Advisor™ software is a tool for guiding developers to write more efficient code to fully utilize the unique ultra-low power features of MSP and MSP432 microcontrollers. Aimed at both experienced and new microcontroller developers, ULP Advisor checks your code against a thorough ULP checklist to squeeze every last nano amp out of your application. At build time, ULP Advisor will provide notifications and remarks to highlight areas of your code that can be further optimized for lower power.

**IEC60730 Software Package** The IEC60730 MSP430 software package was developed to be useful in assisting customers in complying with IEC 60730-1:2010 (Automatic Electrical Controls for Household and Similar Use – Part 1: General Requirements) for up to Class B products, which includes home appliances, arc detectors, power converters, power tools, e-bikes, and many others. The IEC60730 MSP430 software package can be embedded in customer applications running on MSP430s to help simplify the customer's certification efforts of functional safety-compliant consumer devices to IEC 60730-1:2010 Class B.

**Fixed-Point Math Library for MSP** The MSP IQmath and Qmath Libraries are a collection of highly optimized and high-precision mathematical functions for C programmers to seamlessly port a floating-point algorithm into fixed-point code on MSP430 and MSP432 devices. These routines are typically used in computationally intensive real-time applications where optimal execution speed, high accuracy, and ultra-low energy are critical. By using the IQmath and Qmath libraries, it is possible to achieve execution speeds considerably faster and energy consumption considerably lower than equivalent code written using floating-point math.

## Development Tools

**Code Composer Studio™ Integrated Development Environment for MSP Microcontrollers** Code Composer Studio is an integrated development environment (IDE) that supports all MSP microcontroller devices. Code Composer Studio comprises a suite of embedded software utilities used to develop and debug embedded applications. It includes an optimizing C/C++ compiler, source code editor, project build environment, debugger, profiler, and many other features. The intuitive IDE provides a single user interface taking you through each step of the application development flow. Familiar utilities and interfaces allow users to get started faster than ever before. Code Composer Studio combines the advantages of the Eclipse software framework with advanced embedded debug capabilities from TI resulting in a compelling feature-rich development environment for embedded developers. When using CCS with an MSP MCU, a unique and powerful set of plugins and embedded software utilities are made available to fully leverage the MSP microcontroller.

**Grace – Graphical Peripheral Configuration Tool** Enable and configure ADCs, DACs, timers, clocks, serial communication interfaces, and more, by interacting with buttons, drop-down menus, and text fields. Navigate through the MSP430 MCUs highly integrated peripheral set with ease.

**MSP Flasher - Command Line Programmer** MSP Flasher is an open-source shell-based interface for programming MSP microcontrollers through a FET programmer or eZ430 using JTAG or Spy-Bi-Wire (SBW) communication. MSP Flasher can download binary files (.txt or .hex) files directly to the MSP microcontroller without an IDE.

**MSP MCU Programmer and Debugger** The MSP-FET is a powerful emulation development tool – often called a debug probe – which allows users to quickly begin application development on MSP low-power microcontrollers (MCU). Creating MCU software usually requires downloading the resulting binary program to the MSP device for validation and debugging. The MSP-FET provides a debug communication pathway between a host computer and the target MSP. Furthermore, the MSP-FET also provides a Backchannel UART connection between the computer's USB interface and the MSP UART. This affords the MSP programmer a convenient method for communicating serially between the MSP and a terminal running on the computer. It also supports loading programs (often called firmware) to the MSP target using the BSL (bootloader) through the UART and I<sup>2</sup>C communication protocols.

**MSP-GANG Production Programmer** The MSP Gang Programmer is an MSP430 or MSP432 device programmer that can program up to eight identical MSP430 or MSP432 Flash or FRAM devices at the same time. The MSP Gang Programmer connects to a host PC using a standard RS-232 or USB connection and provides flexible programming options that allow the user to fully customize the process. The MSP Gang Programmer is provided with an expansion board, called the Gang Splitter, that implements the interconnections between the MSP Gang Programmer and multiple target devices. Eight cables are provided that connect the expansion board to eight target devices (through JTAG or Spy-Bi-Wire connectors). The programming can be done with a PC or as a stand-alone device. A PC-side graphical user interface is also available and is DLL-based.

## 7.4 Documentation Support

The following documents describe the MSP430G2x33 and MSP430G2x03 devices. Copies of these documents are available on the Internet at [www.ti.com](http://www.ti.com).

### Receiving Notification of Document Updates

To receive notification of documentation updates—including silicon errata—go to the product folder for your device on [ti.com](http://ti.com) (for example, [MSP430G2533](http://ti.com)). In the upper right corner, click the "Alert me" button. This registers you to receive a weekly digest of product information that has changed (if any). For change details, check the revision history of any revised document.

### Errata

**MSP430G2533 Device Erratasheet** Describes the known exceptions to the functional specifications for the MSP430G2533 device.

**MSP430G2433 Device Erratasheet** Describes the known exceptions to the functional specifications for the MSP430G2433 device.

**MSP430G2333 Device Erratasheet** Describes the known exceptions to the functional specifications for the MSP430G2333 device.

**MSP430G2233 Device Erratasheet** Describes the known exceptions to the functional specifications for the MSP430G2233 device.

**MSP430G2403 Device Erratasheet** Describes the known exceptions to the functional specifications for the MSP430G2403 device.

**MSP430G2303 Device Erratasheet** Describes the known exceptions to the functional specifications for the MSP430G2303 device.

**MSP430G2203 Device Erratasheet** Describes the known exceptions to the functional specifications for the MSP430G2203 device.

## User's Guides

**MSP430x2xx Family User's Guide** Detailed information on the modules and peripherals available in this device family.

**Code Composer Studio v6.1 for MSP430 User's Guide** This manual describes the use of TI Code Composer Studio IDE v6.1 (CCS v6.1) with the MSP430 ultra-low-power microcontrollers. This document applies only for the Windows version of the Code Composer Studio IDE. The Linux version is similar and, therefore, is not described separately.

**IAR Embedded Workbench Version 3+ for MSP430 User's Guide** This manual describes the use of IAR Embedded Workbench (EW430) with the MSP430 ultra-low-power microcontrollers.

**MSP430 Programming With the Bootloader (BSL)** The MSP430 bootloader (BSL, formerly known as the bootstrap loader) allows users to communicate with embedded memory in the MSP430 microcontroller during the prototyping phase, final production, and in service. Both the programmable memory (flash memory) and the data memory (RAM) can be modified as required. Do not confuse the bootloader with the bootstrap loader programs found in some digital signal processors (DSPs) that automatically load program code (and data) from external memory to the internal memory of the DSP.

**MSP430 Programming Via the JTAG Interface** This document describes the functions that are required to erase, program, and verify the memory module of the MSP430 flash-based and FRAM-based microcontroller families using the JTAG communication port. In addition, it describes how to program the JTAG access security fuse that is available on all MSP430 devices. This document describes device access using both the standard 4-wire JTAG interface and the 2-wire JTAG interface, which is also referred to as Spy-Bi-Wire (SBW).

**MSP430 Hardware Tools User's Guide** This manual describes the hardware of the TI MSP-FET430 Flash Emulation Tool (FET). The FET is the program development tool for the MSP430 ultra-low-power microcontroller. Both available interface types, the parallel port interface and the USB interface, are described.

## Application Reports

**MSP430 32-kHz Crystal Oscillators** Selection of the right crystal, correct load circuit, and proper board layout are important for a stable crystal oscillator. This application report summarizes crystal oscillator function and explains the parameters to select the correct crystal for MSP430 ultra-low-power operation. In addition, hints and examples for correct board layout are given. The document also contains detailed information on the possible oscillator tests to ensure stable oscillator operation in mass production.

**MSP430 System-Level ESD Considerations** System-Level ESD has become increasingly demanding with silicon technology scaling towards lower voltages and the need for designing cost-effective and ultra-low-power components. This application report addresses three different ESD topics to help board designers and OEMs understand and design robust system-level designs: (1) Component-level ESD testing and system-level ESD testing, their differences and why component-level ESD rating does not ensure system-level robustness. (2) General design guidelines for system-level ESD protection at different levels including enclosures, cables, PCB layout, and on-board ESD protection devices. (3) Introduction to System Efficient ESD Design (SEED), a co-design methodology of on-board and on-chip ESD protection to achieve system-level ESD robustness, with example simulations and test results. A few real-world system-level ESD protection design examples and their results are also discussed.

**General Oversampling of MSP ADCs for Higher Resolution** Multiple MSP ultra-low-power microcontrollers offer analog-to-digital converters (ADCs) to convert physical quantities into digital numbers, a function that is widely used across numerous applications. There are times, however, when a customer design demands a higher resolution than the ADC of the selected MSP can offer. This application report, which is based on the previously-published Oversampling the ADC12 for Higher Resolution (SLAA323), therefore describes how an oversampling method can be incorporated to increase ADC resolution past the currently available number of bits.

**Capacitive Touch Hardware Design Guide** Capacitive touch detection is sometimes considered more art than science. This often results in multiple design iterations before the optimum performance is achieved. There are, however, good design practices for circuit layout and principles of materials that need to be understood to keep the number of iterations to a minimum. This design guide describes a process for creating and designing capacitive touch solutions, starting with the schematic, working through the mechanicals, and finally designing the electrodes for the application.

**Capacitive Touch Sensing, MSP430 Slider and Wheel Tuning Guide** This application report provides guidelines on how to tune capacitive touch sliders and wheels running on the MSP430™ microcontrollers. It identifies the hardware and software parameters as well as explains the steps used in tuning sliders and wheels. The slider and wheel tuning is based on the APIs defined in the Capacitive Touch Sense Library (CAPSENSELIBRARY).

**Capacitive Touch Sensing, MSP430 Button Gate Time Optimization and Tuning Guide** MSP430™ microcontroller based capacitive touch buttons can offer increased performance when properly optimized and tuned for their specific application. Performance benefits that result from button optimization can include, but are not limited to, decreased power consumption, improved response time, and the ability to grow a design to include more buttons. This application report provides the reader with a starting point for button design at the system and software level.

## 7.5 Related Links

**Table 7-2** lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 7-2. Related Links**

| PARTS       | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|-------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| MSP430G2533 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430G2433 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430G2333 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430G2233 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430G2403 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430G2303 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430G2203 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |



## 7.6 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### [TI E2E™ Community](#)

TI's *Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas, and help solve problems with fellow engineers.

### [TI Embedded Processors Wiki](#)

*Texas Instruments Embedded Processors Wiki*. Established to help developers get started with embedded processors from Texas Instruments and to foster innovation and growth of general knowledge about the hardware and software surrounding these devices.

## 7.7 Trademarks

MSP430, LaunchPad, BoosterPack, MSPWare, EnergyTrace, ULP Advisor, Code Composer Studio, E2E are trademarks of Texas Instruments.

All other trademarks are the property of their respective owners.

## 7.8 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## 7.9 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 8 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



**PACKAGING INFORMATION**

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| M430G2533IPW20RG4                  | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| M430G2533IPW20RG4.A                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| M430G2533IPW20RG4.B                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| <a href="#">MSP430G2203IN20</a>    | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2203           |
| MSP430G2203IN20.A                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2203           |
| MSP430G2203IN20.B                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2203           |
| <a href="#">MSP430G2203IPW20</a>   | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| MSP430G2203IPW20.A                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| MSP430G2203IPW20.B                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| <a href="#">MSP430G2203IPW20R</a>  | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| MSP430G2203IPW20R.A                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| MSP430G2203IPW20R.B                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| <a href="#">MSP430G2203IPW28</a>   | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| MSP430G2203IPW28.A                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| MSP430G2203IPW28.B                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| <a href="#">MSP430G2203IPW28R</a>  | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| MSP430G2203IPW28R.A                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| MSP430G2203IPW28R.B                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2203            |
| <a href="#">MSP430G2203IRHB32R</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2203     |
| MSP430G2203IRHB32R.A               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2203     |
| MSP430G2203IRHB32R.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2203     |
| MSP430G2203IRHB32T                 | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2203     |
| MSP430G2203IRHB32T.A               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2203     |
| MSP430G2203IRHB32T.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2203     |
| <a href="#">MSP430G2233IN20</a>    | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2233           |

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| MSP430G2233IN20.A                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2233           |
| MSP430G2233IN20.B                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2233           |
| <a href="#">MSP430G2233IPW20</a>   | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| MSP430G2233IPW20.A                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| MSP430G2233IPW20.B                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| <a href="#">MSP430G2233IPW20R</a>  | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| MSP430G2233IPW20R.A                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| MSP430G2233IPW20R.B                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| <a href="#">MSP430G2233IPW28</a>   | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| MSP430G2233IPW28.A                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| MSP430G2233IPW28.B                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| <a href="#">MSP430G2233IPW28R</a>  | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| MSP430G2233IPW28R.A                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| MSP430G2233IPW28R.B                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2233            |
| <a href="#">MSP430G2233IRHB32R</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2233     |
| MSP430G2233IRHB32R.A               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2233     |
| MSP430G2233IRHB32R.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2233     |
| <a href="#">MSP430G2233IRHB32T</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2233     |
| MSP430G2233IRHB32T.A               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2233     |
| MSP430G2233IRHB32T.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2233     |
| <a href="#">MSP430G2303IPW20</a>   | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| MSP430G2303IPW20.A                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| MSP430G2303IPW20.B                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| <a href="#">MSP430G2303IPW20R</a>  | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| MSP430G2303IPW20R.A                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| MSP430G2303IPW20R.B                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">MSP430G2303IPW28</a>   | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| MSP430G2303IPW28.A                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| MSP430G2303IPW28.B                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| <a href="#">MSP430G2303IPW28R</a>  | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| MSP430G2303IPW28R.A                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| MSP430G2303IPW28R.B                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2303            |
| <a href="#">MSP430G2303IRHB32R</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2303     |
| MSP430G2303IRHB32R.A               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2303     |
| MSP430G2303IRHB32R.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2303     |
| <a href="#">MSP430G2303IRHB32T</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2303     |
| MSP430G2303IRHB32T.A               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2303     |
| MSP430G2303IRHB32T.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2303     |
| <a href="#">MSP430G2333IN20</a>    | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2333           |
| MSP430G2333IN20.A                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2333           |
| MSP430G2333IN20.B                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2333           |
| <a href="#">MSP430G2333IPW20</a>   | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| MSP430G2333IPW20.A                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| MSP430G2333IPW20.B                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| <a href="#">MSP430G2333IPW20R</a>  | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| MSP430G2333IPW20R.A                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| MSP430G2333IPW20R.B                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| <a href="#">MSP430G2333IPW28</a>   | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| MSP430G2333IPW28.A                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| MSP430G2333IPW28.B                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| <a href="#">MSP430G2333IPW28R</a>  | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| MSP430G2333IPW28R.A                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| MSP430G2333IPW28R.B                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2333            |
| <a href="#">MSP430G2333IRHB32R</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2333     |
| MSP430G2333IRHB32R.A               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2333     |
| MSP430G2333IRHB32R.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2333     |
| <a href="#">MSP430G2333IRHB32T</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2333     |
| MSP430G2333IRHB32T.A               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2333     |
| MSP430G2333IRHB32T.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2333     |
| <a href="#">MSP430G2403IN20</a>    | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2403           |
| MSP430G2403IN20.A                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2403           |
| MSP430G2403IN20.B                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2403           |
| <a href="#">MSP430G2403IPW20</a>   | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| MSP430G2403IPW20.A                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| MSP430G2403IPW20.B                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| <a href="#">MSP430G2403IPW20R</a>  | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| MSP430G2403IPW20R.A                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| MSP430G2403IPW20R.B                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| <a href="#">MSP430G2403IPW28</a>   | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| MSP430G2403IPW28.A                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| MSP430G2403IPW28.B                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| <a href="#">MSP430G2403IPW28R</a>  | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| MSP430G2403IPW28R.A                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| MSP430G2403IPW28R.B                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2403            |
| <a href="#">MSP430G2403IRHB32R</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2403     |
| MSP430G2403IRHB32R.A               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2403     |

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| MSP430G2403IRHB32R.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2403     |
| <a href="#">MSP430G2403IRHB32T</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2403     |
| MSP430G2403IRHB32T.A               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2403     |
| MSP430G2403IRHB32T.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2403     |
| <a href="#">MSP430G2433IN20</a>    | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2433           |
| MSP430G2433IN20.A                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2433           |
| MSP430G2433IN20.B                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2433           |
| <a href="#">MSP430G2433IPW20</a>   | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| MSP430G2433IPW20.A                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| MSP430G2433IPW20.B                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| <a href="#">MSP430G2433IPW20R</a>  | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| MSP430G2433IPW20R.A                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| MSP430G2433IPW20R.B                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| <a href="#">MSP430G2433IPW28</a>   | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| MSP430G2433IPW28.A                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| MSP430G2433IPW28.B                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| <a href="#">MSP430G2433IPW28R</a>  | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| MSP430G2433IPW28R.A                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| MSP430G2433IPW28R.B                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2433            |
| <a href="#">MSP430G2433IRHB32R</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2433     |
| MSP430G2433IRHB32R.A               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2433     |
| MSP430G2433IRHB32R.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2433     |
| <a href="#">MSP430G2433IRHB32T</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2433     |
| MSP430G2433IRHB32T.A               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2433     |

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| MSP430G2433IRHB32T.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2433     |
| <a href="#">MSP430G2533IN20</a>    | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2533           |
| MSP430G2533IN20.A                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2533           |
| MSP430G2533IN20.B                  | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | M430G2533           |
| <a href="#">MSP430G2533IPW20</a>   | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| MSP430G2533IPW20.A                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| MSP430G2533IPW20.B                 | Active        | Production           | TSSOP (PW)   20 | 70   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| <a href="#">MSP430G2533IPW20R</a>  | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| MSP430G2533IPW20R.A                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| MSP430G2533IPW20R.B                | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| <a href="#">MSP430G2533IPW28</a>   | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| MSP430G2533IPW28.A                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| MSP430G2533IPW28.B                 | Active        | Production           | TSSOP (PW)   28 | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| <a href="#">MSP430G2533IPW28R</a>  | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| MSP430G2533IPW28R.A                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| MSP430G2533IPW28R.B                | Active        | Production           | TSSOP (PW)   28 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 430G2533            |
| <a href="#">MSP430G2533IRHB32R</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2533     |
| MSP430G2533IRHB32R.A               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2533     |
| MSP430G2533IRHB32R.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2533     |
| <a href="#">MSP430G2533IRHB32T</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2533     |
| MSP430G2533IRHB32T.A               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2533     |
| MSP430G2533IRHB32T.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | MSP430<br>G2533     |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).



<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

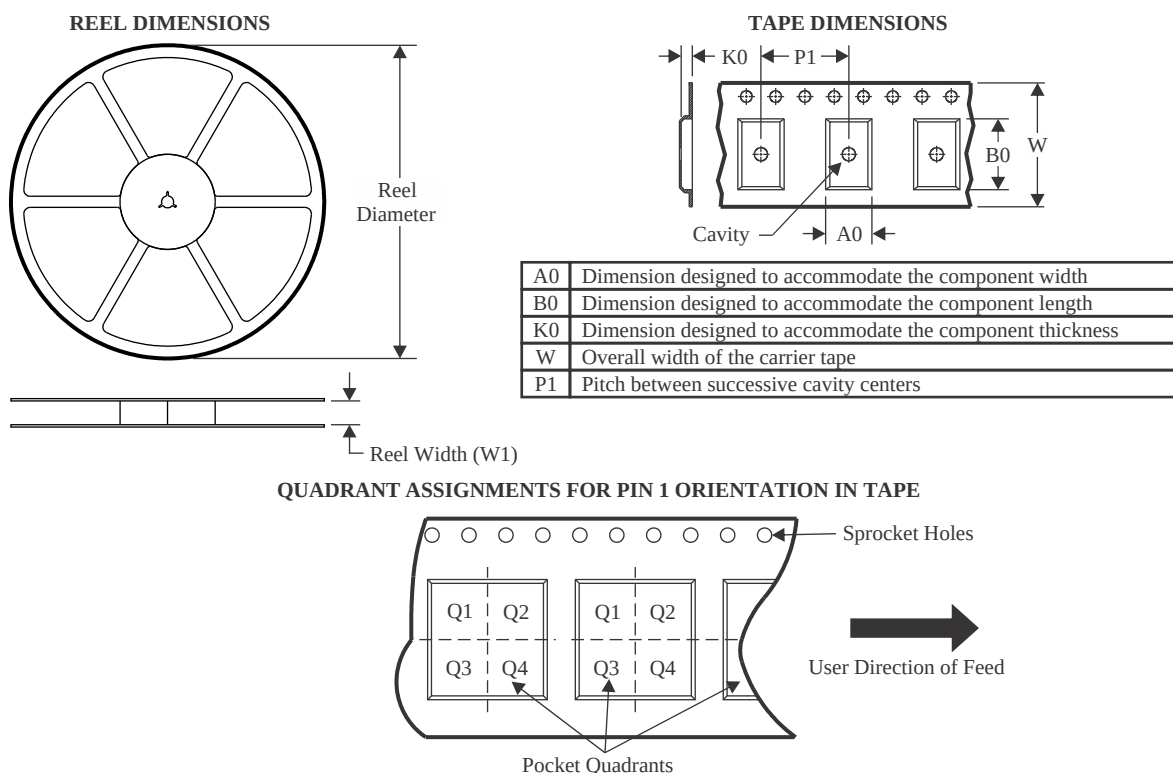
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION



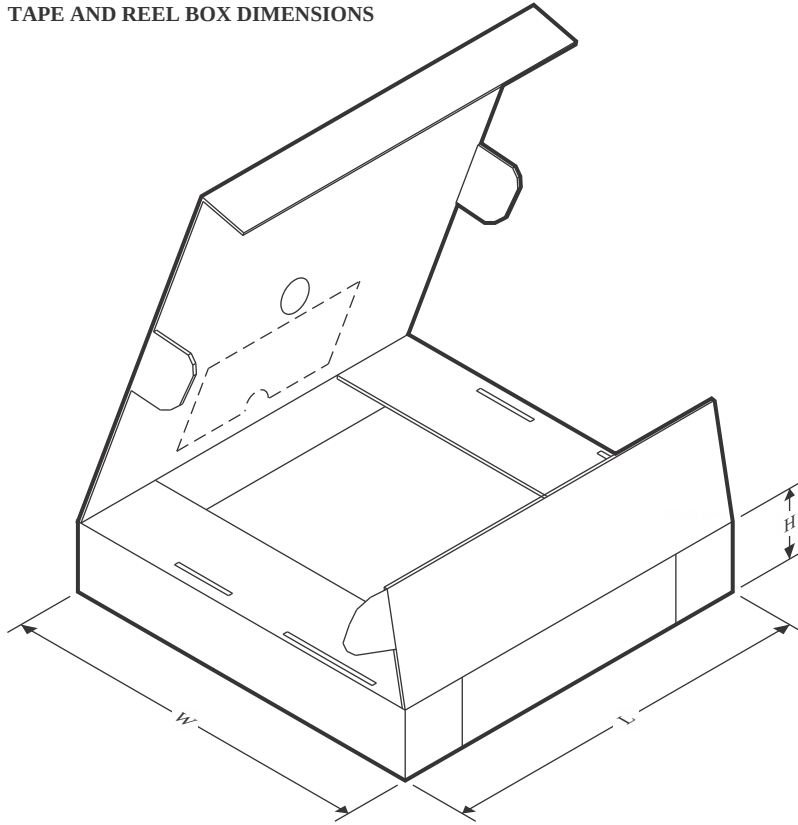
\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| M430G2533IPW20RG4  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| MSP430G2203IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| MSP430G2203IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| MSP430G2203IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.75    | 10.1    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2203IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.9     | 10.2    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2203IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2203IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2203IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2203IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2233IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| MSP430G2233IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| MSP430G2233IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.9     | 10.2    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2233IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.75    | 10.1    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2233IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2233IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2233IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |



| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| MSP430G2233IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2303IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| MSP430G2303IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| MSP430G2303IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.75    | 10.1    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2303IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.9     | 10.2    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2303IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2303IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2303IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2303IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2333IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| MSP430G2333IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| MSP430G2333IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.75    | 10.1    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2333IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.9     | 10.2    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2333IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2333IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2333IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2333IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2403IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| MSP430G2403IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| MSP430G2403IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.75    | 10.1    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2403IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.9     | 10.2    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2403IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2403IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2403IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2403IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2433IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| MSP430G2433IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| MSP430G2433IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.75    | 10.1    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2433IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.9     | 10.2    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2433IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2433IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2433IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2433IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2533IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| MSP430G2533IPW20R  | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.1     | 1.6     | 8.0     | 16.0   | Q1            |
| MSP430G2533IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.9     | 10.2    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2533IPW28R  | TSSOP        | PW              | 28   | 2000 | 330.0              | 16.4               | 6.75    | 10.1    | 1.8     | 12.0    | 16.0   | Q1            |
| MSP430G2533IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2533IRHB32R | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2533IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430G2533IRHB32T | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |

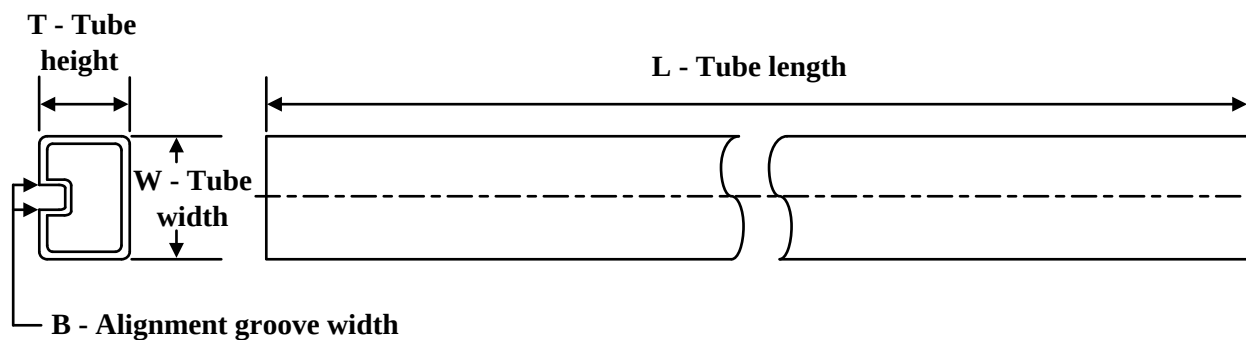
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| M430G2533IPW20RG4  | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2203IPW20R  | TSSOP        | PW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2203IPW20R  | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2203IPW28R  | TSSOP        | PW              | 28   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2203IPW28R  | TSSOP        | PW              | 28   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2203IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2203IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2203IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2203IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2233IPW20R  | TSSOP        | PW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2233IPW20R  | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2233IPW28R  | TSSOP        | PW              | 28   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2233IPW28R  | TSSOP        | PW              | 28   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2233IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2233IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2233IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2233IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2303IPW20R  | TSSOP        | PW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MSP430G2303IPW20R  | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2303IPW28R  | TSSOP        | PW              | 28   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2303IPW28R  | TSSOP        | PW              | 28   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2303IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2303IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2303IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2303IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2333IPW20R  | TSSOP        | PW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2333IPW20R  | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2333IPW28R  | TSSOP        | PW              | 28   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2333IPW28R  | TSSOP        | PW              | 28   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2333IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2333IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2333IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2333IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2403IPW20R  | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2403IPW20R  | TSSOP        | PW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2403IPW28R  | TSSOP        | PW              | 28   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2403IPW28R  | TSSOP        | PW              | 28   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2403IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2403IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2403IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2403IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2433IPW20R  | TSSOP        | PW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2433IPW20R  | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2433IPW28R  | TSSOP        | PW              | 28   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2433IPW28R  | TSSOP        | PW              | 28   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2433IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2433IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2433IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2433IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2533IPW20R  | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2533IPW20R  | TSSOP        | PW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2533IPW28R  | TSSOP        | PW              | 28   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430G2533IPW28R  | TSSOP        | PW              | 28   | 2000 | 353.0       | 353.0      | 32.0        |
| MSP430G2533IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2533IRHB32R | VQFN         | RHB             | 32   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430G2533IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430G2533IRHB32T | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |

**TUBE**


\*All dimensions are nominal

| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| MSP430G2203IN20    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2203IN20.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2203IN20.B  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2203IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2203IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IN20    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2233IN20.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2233IN20.B  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2233IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2233IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |

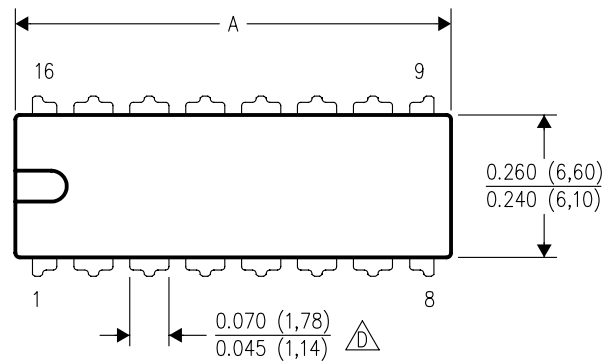
| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| MSP430G2233IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2303IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IN20    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2333IN20.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2333IN20.B  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2333IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2333IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IN20    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2403IN20.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2403IN20.B  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2403IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2403IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |

| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| MSP430G2433IN20    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2433IN20.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2433IN20.B  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2433IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2433IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IN20    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2533IN20.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2533IN20.B  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| MSP430G2533IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW20   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW20.A | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW20.B | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW28   | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW28.A | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |
| MSP430G2533IPW28.B | PW           | TSSOP        | 28   | 50  | 530    | 10.2   | 3600   | 3.5    |

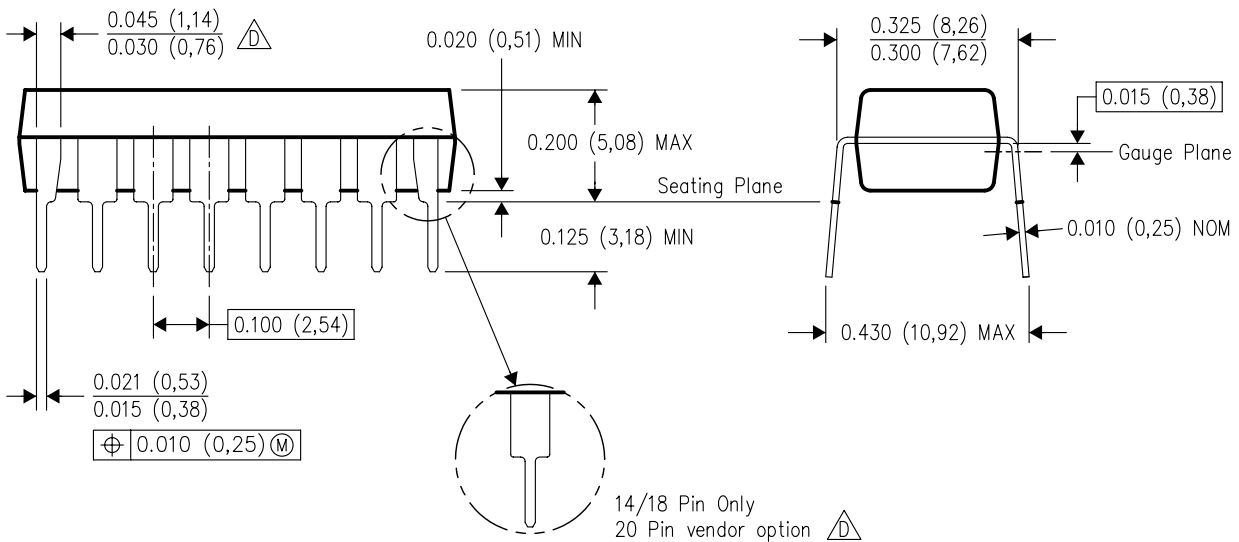
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



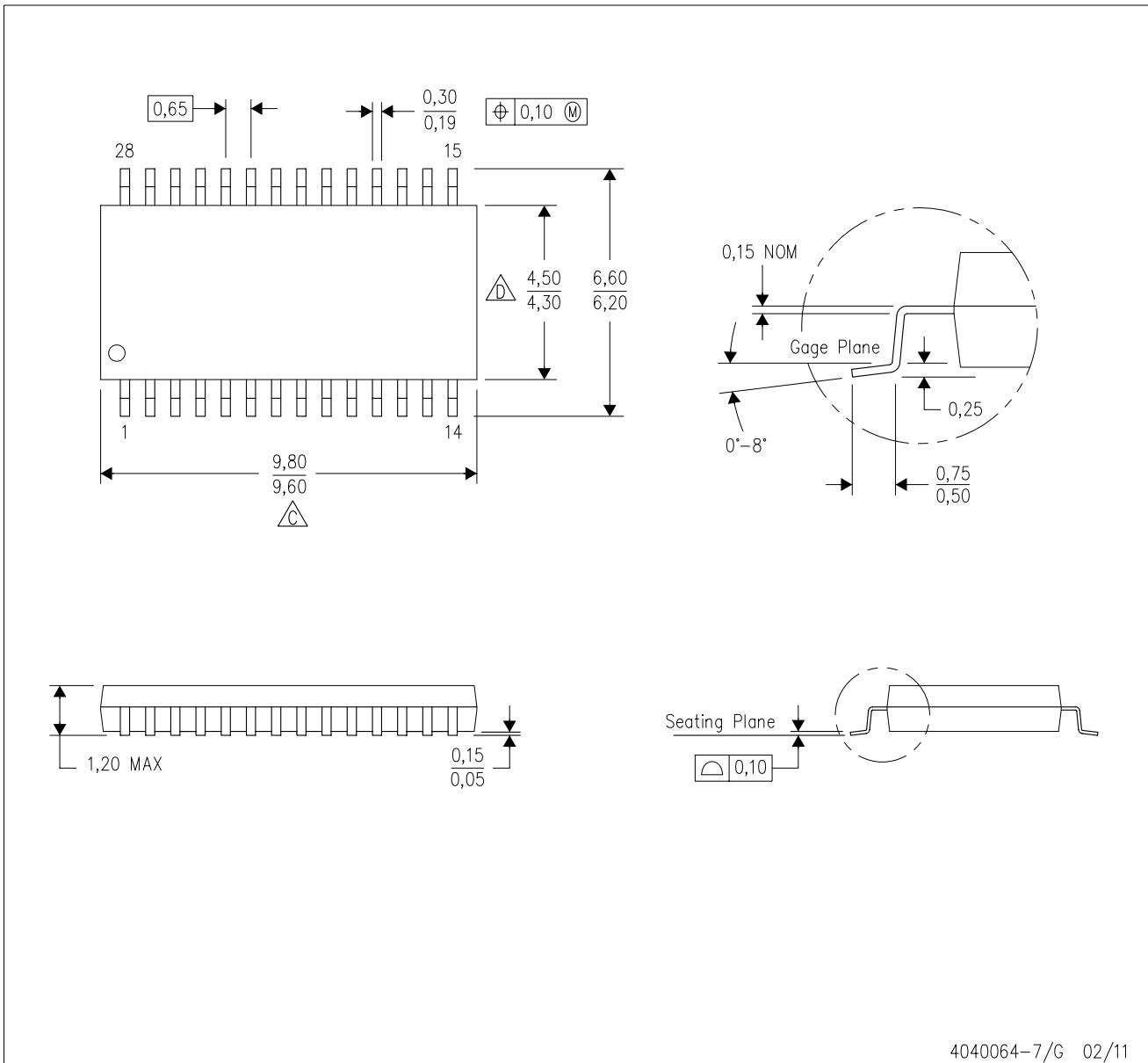
14/18 Pin Only  
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

PW (R-PDSO-G28)

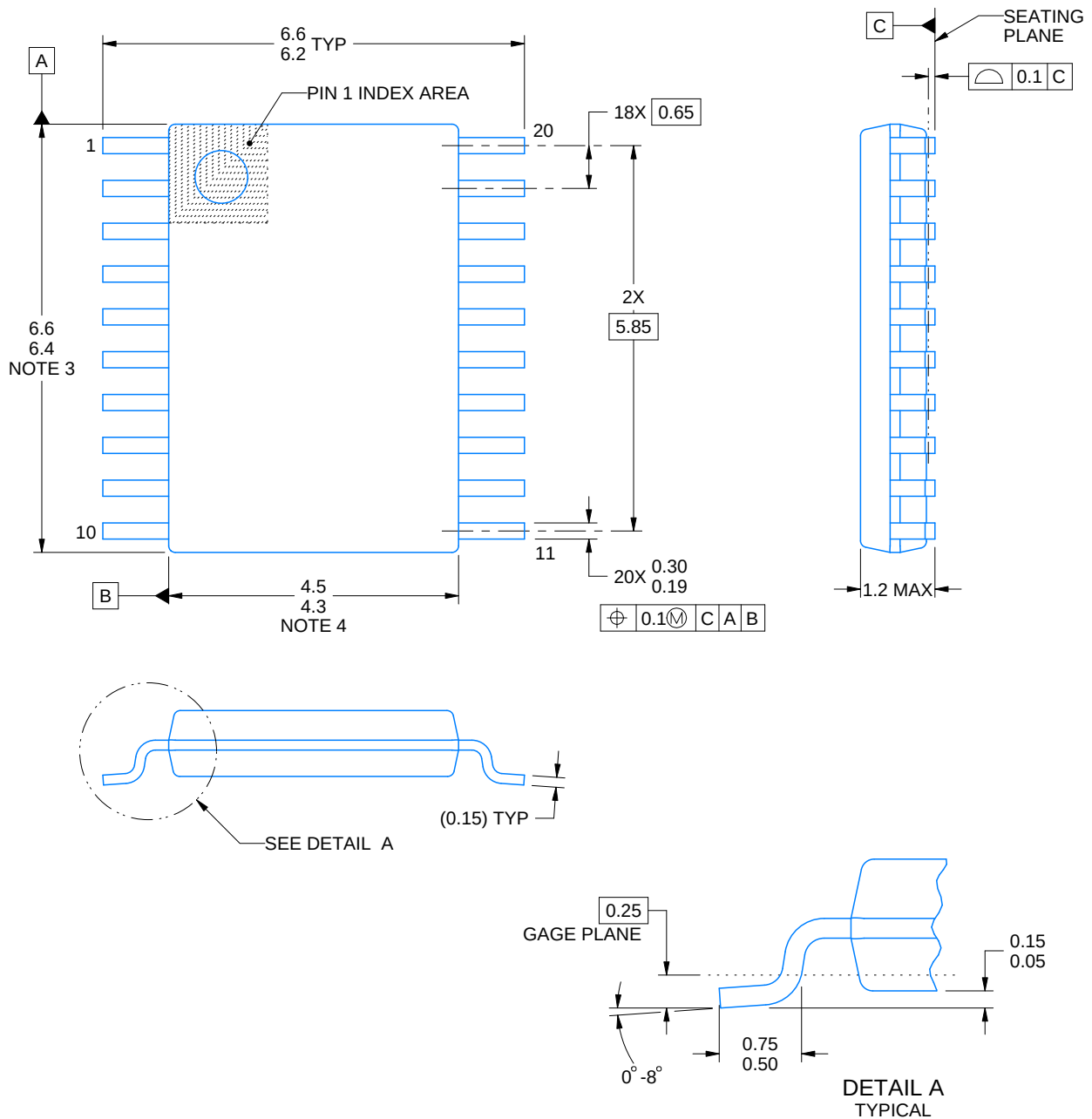
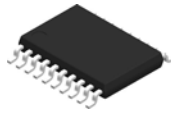
PLASTIC SMALL OUTLINE



4040064-7/G 02/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153





4220206/A 02/2017

## NOTES:

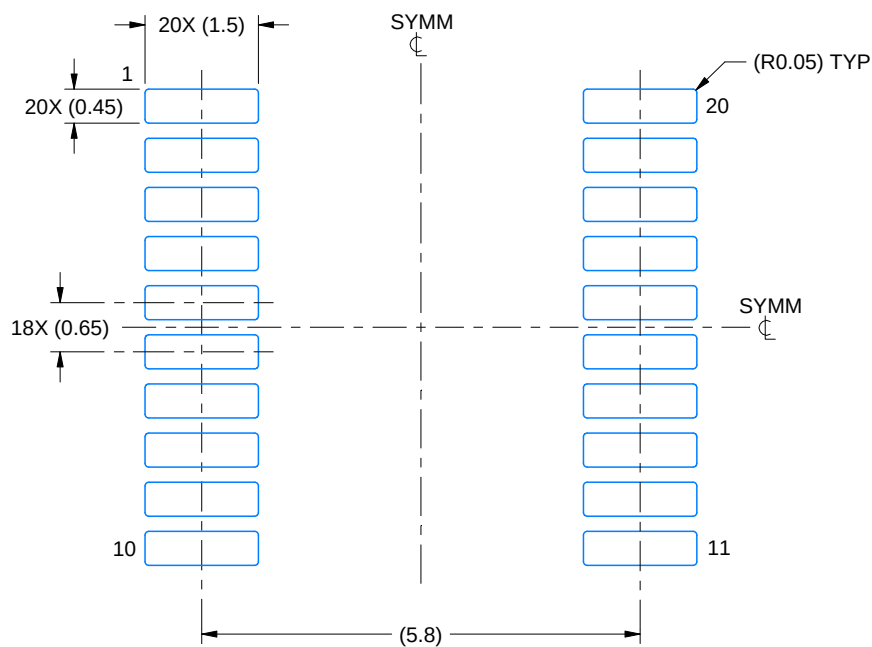
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

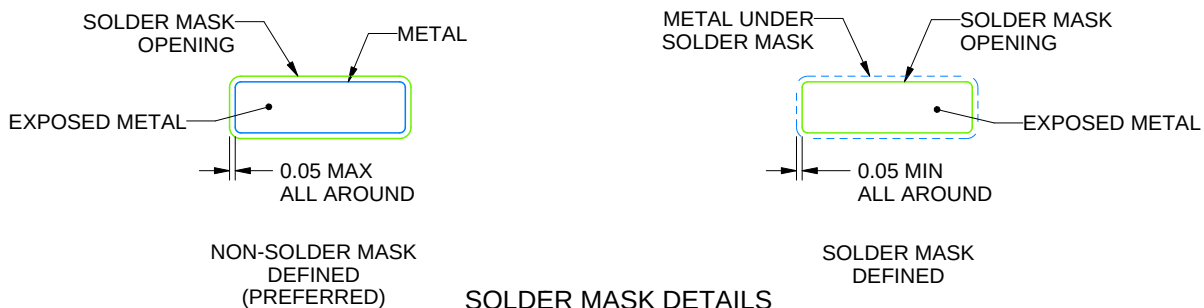
PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220206/A 02/2017

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

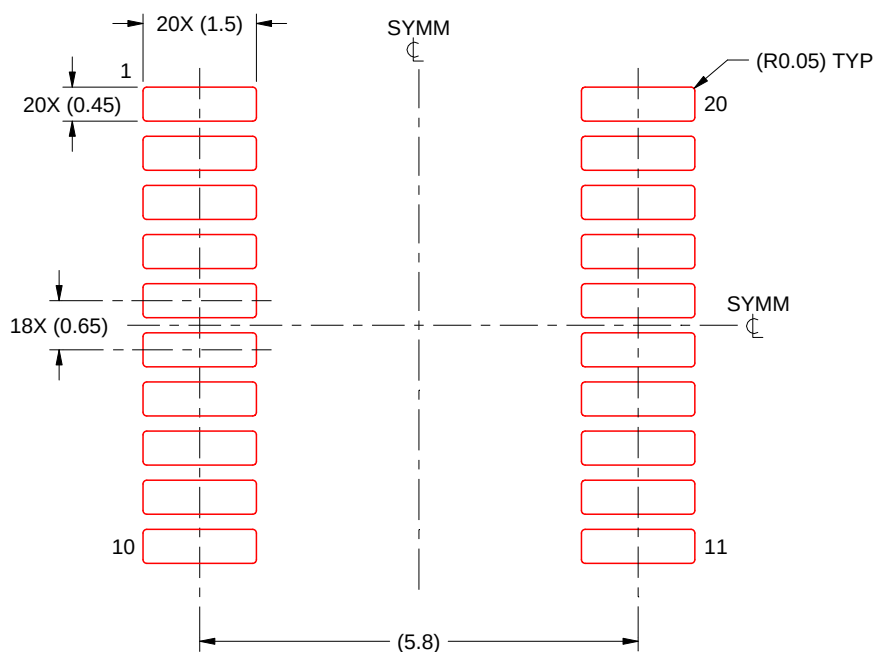
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220206/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

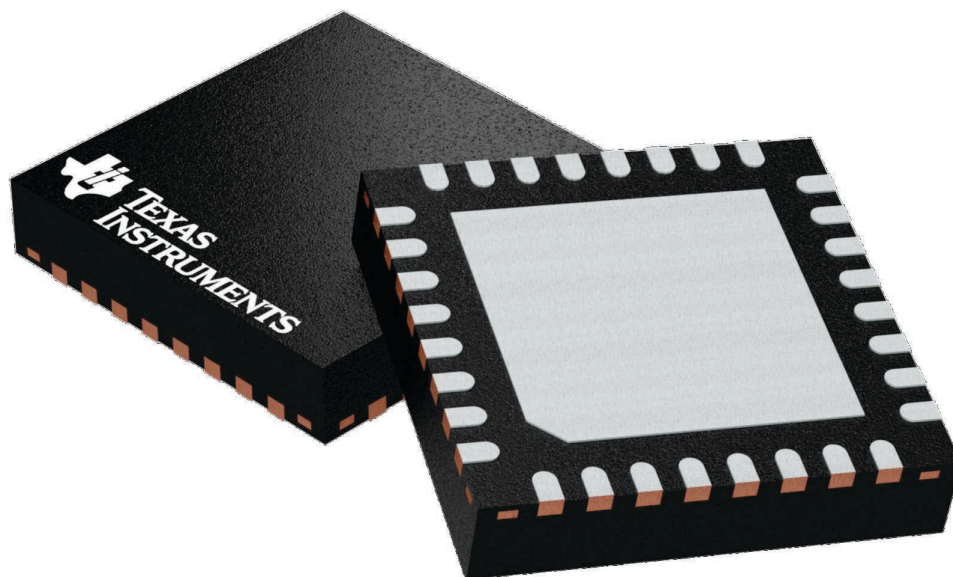
## GENERIC PACKAGE VIEW

**RHB 32**

**VQFN - 1 mm max height**

5 x 5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

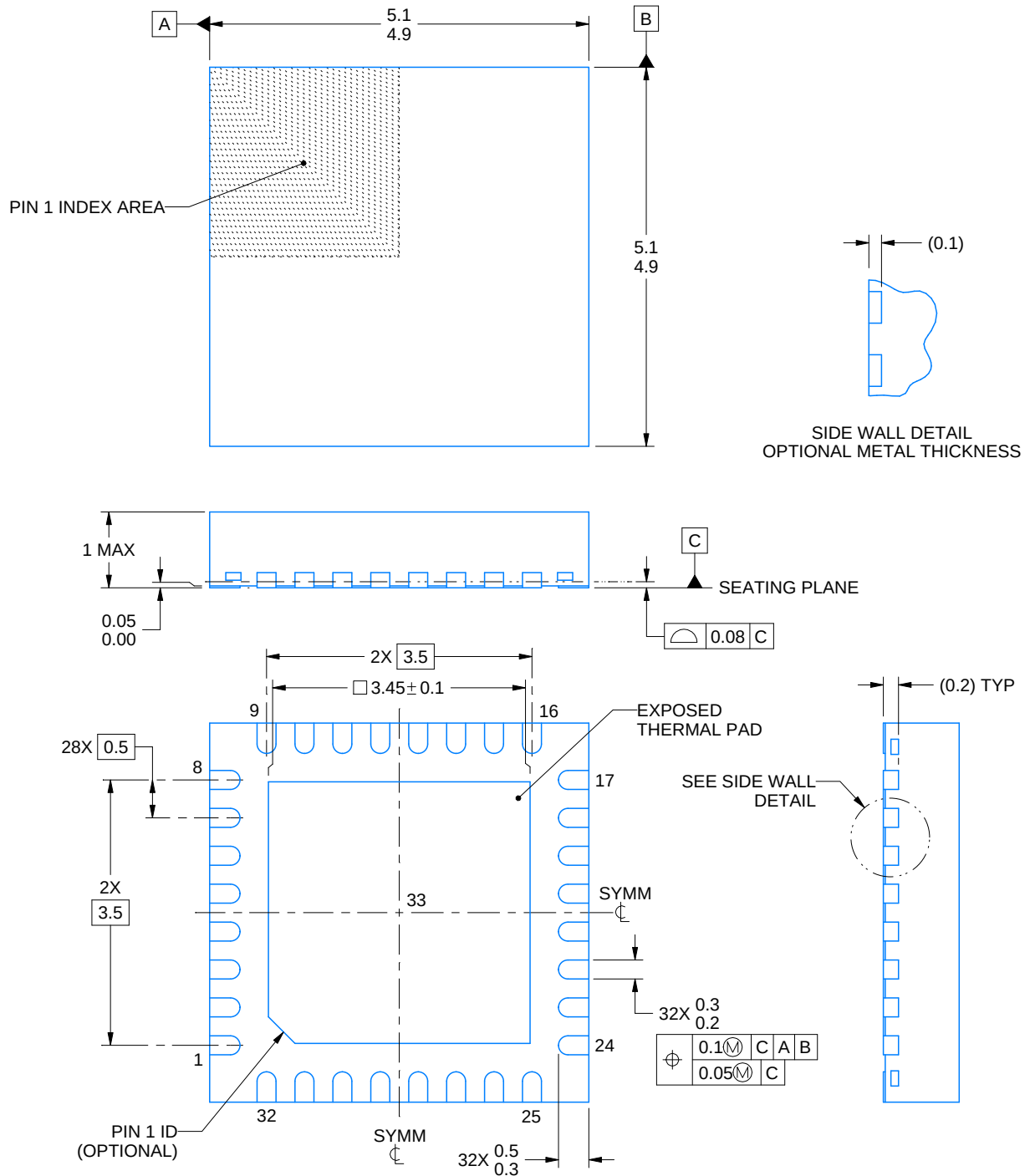
4224745/A

**RHB0032E**

## PACKAGE OUTLINE

### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4223442/B 08/2019

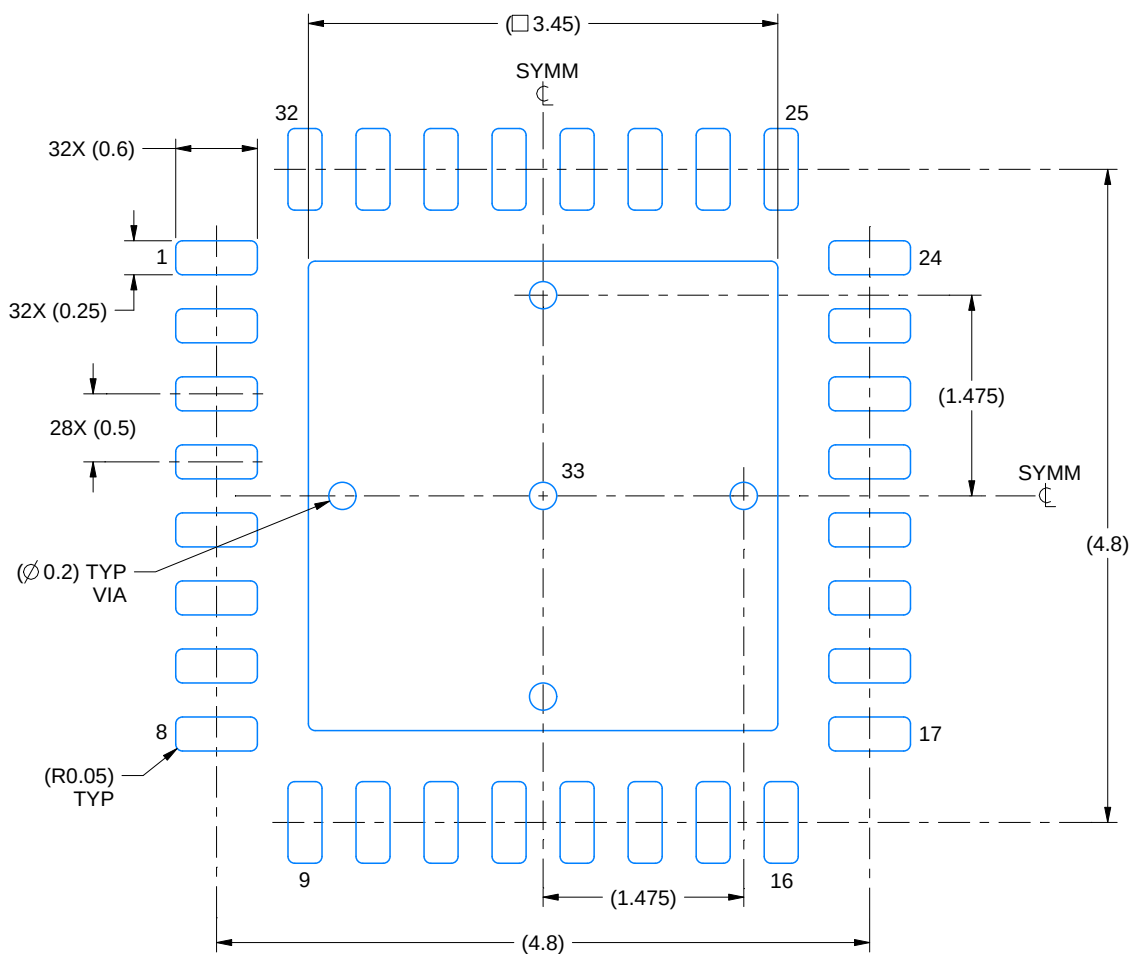
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

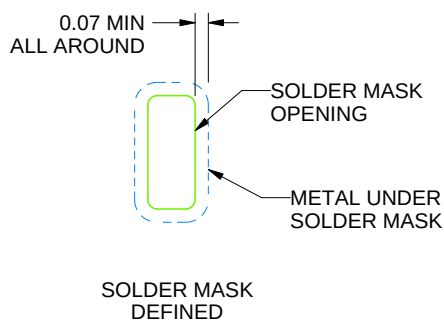
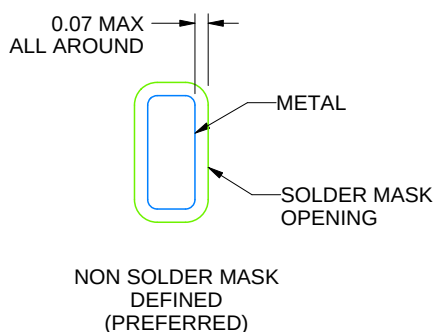
**RHB0032E**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:18X



## SOLDER MASK DETAILS

4223442/B 08/2019

NOTES: (continued)

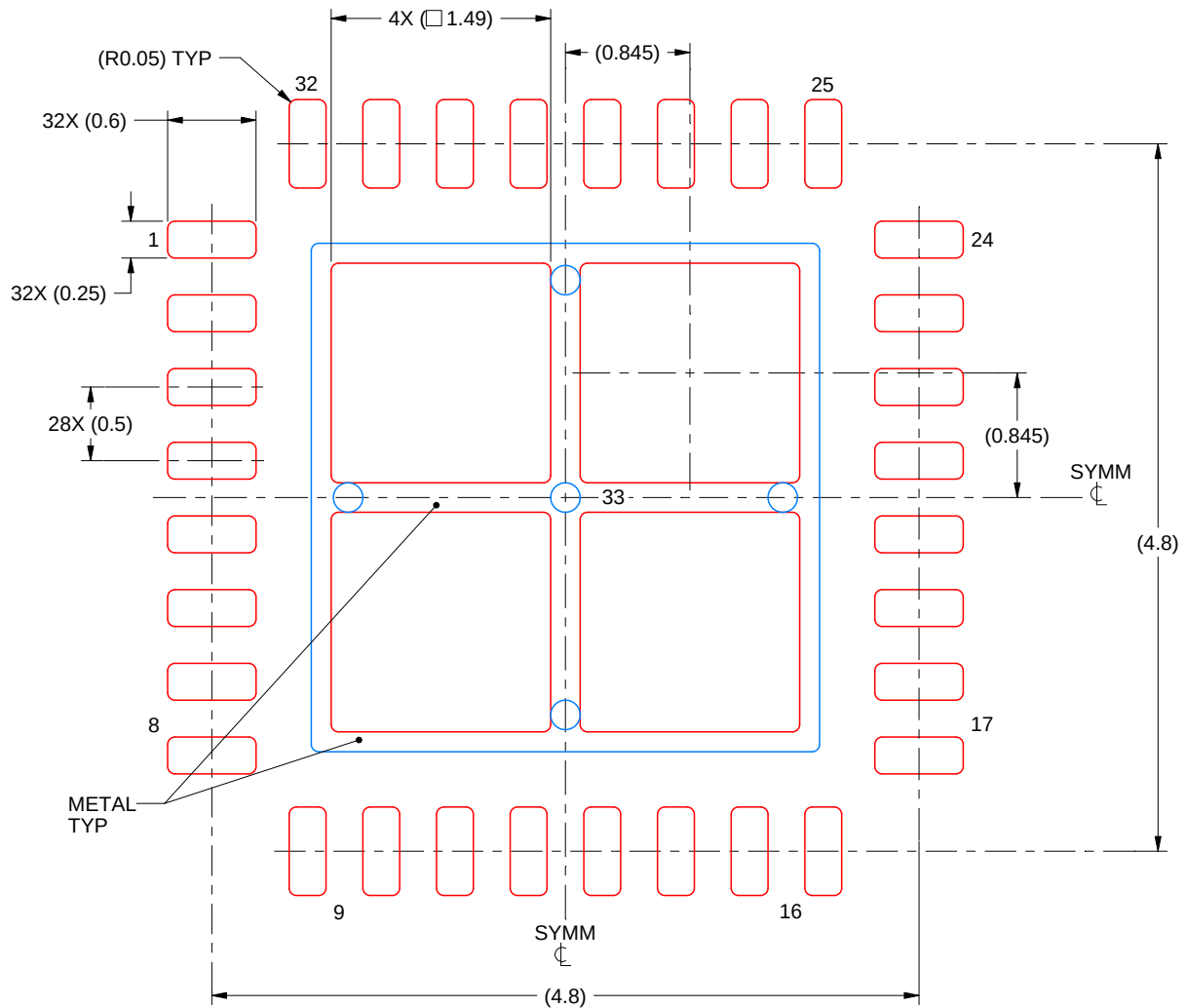
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RHB0032E

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 33:  
75% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

4223442/B 08/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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